NEHRU COLLEGE OF ENGINEERING AND RESEARCH CENTRE

(NAAC Accredited)

(Approved by AICTE, Affiliated to KTU University, Kerala)

ELECTRONICS AND COMMUNICATION ENGINEERING DEPARTMENT

Course Material

S5:EC365- Biomedical Engineering (Elective Paper)

About the Department:

Department of ECE established in 2002 with an intake of 60 students to undergraduate (B.Tech) programme and enhanced to an intake of 120 students from 2006. The department offers two Postgraduates(M.Tech) programmes in “Electronics”. “Applied Electronics & Communication System” from 2011 with an intake of 18 students and “ VLSI Design” from 2012 with an intake of 18.Highly qualified, experienced and dedicated staff members are the backbone of the Department. The Department always strive hard to satisfy the knowledge thirst of both students and faculties by organizing workshops / technical talks / conferences etc. The faculty members are actively involved in research work and regularly present/ publish their work in various national and international conferences / journals. The ECE Department is proud to host state-of- the art Laboratories in the area of VLSI, Embedded Systems, Microprocessor and Microcontrollers, Circuits, Analog and Digital Communication and Microwave and Optical communication.The ECE department formally inaugurated the ECHOS (The ECE Association) in 2009 and under this banner many extra-academic activities have been conducted such as paper presentation, quiz competition, workshops and seminars. Also the department has two magazines that have been developed on the basis of the creative skills of our imaginative students. There is an Embedded Club that meets on monthly basis to discuss innovative projects and publication based activities. Department is closely associated with INSTITUTE OF ELECTRONICS & TELECOMMUNICATION ENGINEERS (IETE) Palakkad Centre to organize technical events like guest lecture, seminars and conferences.

Vision of the Institution:

To mould true citizens who are millennium leaders and catalysts of change through excellence in education.

Missio of the Institution:

To build a strong Centre of Excellence in Learning and Research in Engineering and Frontier Technology, to facilitate students to learn and imbibe discipline, culture and spirituality, besides encouraging them to assimilate the latest technological knowhow and to render a helping hand to the under privileged, thereby acquiring happiness and imparting the same to others without any reservation whatsoever and to facilitate the College to emerge into a magnificent and mighty launching pad to turn out technological giants, dedicated research scientists and intellectual leaders of the society who could prepare the country for a quantum jump in all fields of Science and Technology.

Vision of the Department:

Providing Universal Communicative Electronics Engineers with corporate and social relevance towards sustainable developments through quality education.

Mission of the Department:

- Imparting Quality education by providing excellent teaching, learning environment.
- Transforming and adopting students in this knowledgeable era, where the electronic gadgets (things) are getting obsolete in short span.
- To initiate multi-disciplinary activities to students at earliest and apply in their respective fields of interest later.
- Promoting leading edge Research & Development through collaboration with academia & industry.

Programme Educational Objectives(PEOs):

- To prepare students to excel in postgraduate programmes or to succeed in industry / technical profession through global, rigorous education and prepare the students to practice and innovate recent fields in the specified program/ industry environment.
- To provide students with a solid foundation in mathematical, Scientific and engineering fundamentals required to solve engineering problems and to have strong practical knowledge required to design and test the system.
- To train students with good scientific and engineering breadth so as to comprehend, analyze, design, and create novel products and solutions for the real life problems.
- To provide student with an academic environment aware of excellence, effective communication skills, leadership, multidisciplinary approach, written ethical codes and the life-long learning needed for a successful professional career.

Programming Outcomes (POs):

After the Successful completion of the entire course Graduates are able to do

- **Engineering Knowledge:** Apply the knowledge of mathematics, science, engineering fundamentals, and an engineering specialization to the solution of complex engineering problems.
- **Problem Analysis:** Identify, formulate, research literature, and analyze complex engineering problems reaching substantiated conclusions using first principles of mathematics, natural sciences, and engineering sciences.
- **Design/development of Solutions:** Design solutions for complex engineering problems and design system components or processes that meet the specified needs with appropriate consideration for the public health and safety, and the cultural, societal, and environmental considerations.
- **Conduct Investigations of Complex Problems:** Use research-based knowledge and research methods including design of experiments, analysis and interpretation of data, and synthesis of the information to provide valid conclusions.
- **Modern Tool usage:** Create, select, and apply appropriate techniques, resources, and modern engineering and IT tools including prediction and modeling to complex engineering activities with an understanding of the limitations.

- **The Engineer and Society:** Apply reasoning informed by the contextual knowledge to assess societal, health, safety, legal, and cultural issues and the consequent responsibilities relevant to the professional engineering practice.
- **Environment and Sustainability:** Understand the impact of the professional engineering solutions in societal and environmental contexts, and demonstrate the knowledge of, and need for sustainable development.
- **Ethics:** Apply ethical principles and commit to professional ethics and responsibilities and norms of the engineering practice.
- **Individual and Team Work:** Function effectively as an individual, and as a member or leader in diverse teams, and in multidisciplinary settings.
- **Communication:** Communicate effectively on complex engineering activities with the engineering community and with society at large, such as, being able to comprehend and write effective reports and design documentation, make effective presentations, and give and receive clear instructions.
- **Project Management and Finance:** Demonstrate knowledge and understanding of t h e engineering and management principles and apply these to one's own work, as a member and leader in a team, to manage projects and in multidisciplinary environments.
- **Life-long Learning:** Recognize the need for, and have the preparation and ability to engage in independent and life-long learning in the broadest context of technological change.

Programming Specific Outcomes (PSOs):

1. Facility to apply the concepts of Electronics, Communications, Signal processing, VLSI, Control systems etc., in the design and implementation of engineering systems.
2. Facility to solve complex Electronics and communication Engineering problems, using latest hardware and software tools, either independently or in team.

PEOs Vs POs Mapping:

The Electronics and Communication Engineering Program outcomes leading to the achievement of the objectives can be summarized in the following Table.

PEOs Vs POs											
	Program Outcomes										
	A	B	C	D	E	F	G	H	I	J	K

PEOs	1	X	X	X								X
	2	X	X	X	X		X					X
	3		X	X	X	X					X	
	4				X	X	X	X	X	X	X	X

Course Outcome:

After completion of this course the students will be able to

01. Understand and describe different number systems and their conversions, signed binary number representation and binary arithmetic and solve related numerical.

02. Solve relevant numerical applying Boolean algebra and logic gates.

03. Describe, analyze, formulate and construct combinational & sequential networks

04. Understand and explain memory systems and different kinds of logic families

05. Demonstrate basic analog-to-digital and digital-to-analog circuits.

06. Analsizing and protection of data's through no of password techniques

CO-PO Mapping

CO/PO	PO 1	PO 2	PO 3	PO 4	PO 5	PO 6	PO 7	PO 8	PO 9	PO10	PO11	PO12
CO1	3	2	1									
CO2		3		1	2							
CO3		3	2		1							
CO4	2	3		1								
CO5		3		2	2							
CO6		2	2		3							

Course Topics:

1 . Introduction to the course

2. Introduction to bio-medical instrumentation system, overview of anatomy and physiological systems of the body.

3. Sources of bio-electric potential: Resting and action potential, propagation of action potentials

4. Bio-electric potential (contd.), Bioelectric potentials examples (ECG, EEG, EMG, ERG, EOG, EGG, etc introduction only.)

5. Electrode theory: Nernst relation

6. Bio potential electrodes: Microelectrodes, skin surface electrodes, needle electrodes.

7. Bio potential amplifiers-instrumentation amplifiers, carrier amplifiers

8. Isolation amplifiers, chopper amplifiers

9. Heart and cardiovascular system (brief discussion), electro conduction system of the heart, Electrocardiography

10. ECG machine block diagram, ECG lead configurations

11. ECG recording system, Einthoven triangle, analysis of ECG signals.

12. Measurement of blood pressure: Direct, indirect and relative methods of blood pressure measurement

13. Auscultatory method, oscillometric and ultrasonic non-invasive pressure measurements.

14. Measurement of blood flow: Electromagnetic blood flow meters and ultrasonic blood flow meters.

15. The human nervous system. Neuron, action potential of brain, brain waves, types of electrodes

16. Placement of electrodes,evoked potential, EEG recording, analysis of EEG.

17. Electromyography: Nerve conduction velocity, instrumentation system for EMG.

18. Physiology of respiratory system (brief discussion), Respiratory parameters and spirometer

19. Bodyplethysmographs, gas exchange and distribution.

20. Oxymeters, pH meter,

21. Blood cell counter

22. Flame photometer, spectrophotometer

23. Cardiac pacemakers

24. Cardiac defibrillators

25. Heart–lung machine, dialyzers

26. Surgical diathermy equipment

27. Ventilators

28. X-ray imaging - Properties and production of X-rays,

29. Production of X-rays (contd), X-ray machine, applications of X-rays

in medicine.

30. Computed Tomograpy: Principle, image reconstruction

31. Computed Tomograpy- scanning system and applications

32. Magnetic Resonance Imaging – Basic NMR components

33. Magnetic Resonance Imaging (contd.)--Biological effects and advantages of NMR imaging

34. Biomedical Telemetry system: Components of biotelemetry system,

application of telemetry in medicine

35. Single channel telemetry system for ECG and temperature

36. Patient Safety: Electric shock hazards, leakage current, safety codes for electro medical equipments

QUESTION BANK:

MODULE 1

1. Define:

a. Absolute Refractory period

b. Relative Refractory period

2. What is bioelectric potential? State all or nothing law.

3. What is the need of Gel in Bio potential measurement?

4. What is ERG?

5. What is half-cell potential?

6. Draw and explain the action potential waveform.

7. Explain the theory behind the Electrodes.

8. What is the use of 50Hz notch filter in bio-signal measurement?

9. Explain the characteristics of resting potential with respect to Nernst equation.

10. Discuss the different types of Electrodes used in the measurement of Bio potential.

11. What are the 4 main factors involved in the movement of ions across the cell membrane in Steady state condition.

12. Define half cell potential. What are polarizable and non-polarizable electrodes?

13. With the help of neat circuit diagram, explain the working of a typical instrumentation amplifier.

14. Draw the equivalent circuit for a bio potential electrode in contact with an electrolyte.

15. Compare the unipolar and bipolar mode of bio signal measurement.

16. Draw the diagram of electrode-tissue interface for surface electrodes with electrode jelly. Explain metal -electrolyte and electrolyte- skin interface.

17. What are the various types of electrodes used for ECG signal? Give a brief description of atleast 3 types of electrodes.

18. What are the key advantages of instrumentation amplifiers over differential amplifiers? State its application in biomedical sector.

19. Explain the working of carrier amplifiers and state its applications.

20. What are isolation amplifiers? Explain its different types.

21. Explain the principle of chopper stabilized amplifier. What are its applications?

22. With neat circuit diagram explain the different types of Isolation amplifiers.

23. What is the use of chopper stabilized dc amplifier? Explain the working of a single-ended chopper stabilized operational amplifier.(10)

24. What is the need for an isolation amplifier? Explain the working of optically isolated isolation amplifier.

25. What are the various electrodes used for ECG measurement? Explain any three types in detail.

26. With relevant graph explain the relationship between action potential and muscle contraction.

27. Define EOG and ERG.

28. What are the requirements of a good physiological transducer? Explain the operation of any two types of physiological transducers with relevant sketches.

MODULE 2

1. Write the signal characteristics of ECG.

2. Draw the electrode configuration of aaVr output.

3. Explain with neat sketch anatomy and conducting system of heart. Also discuss cardio vascular circulating system with block diagram.

1. Sketch a typical Lead II Electrocardiogram and label all waves and intervals.

2. Write the principle behind electromagnetic blood flow meter.

3. With neat diagrams, explain the formation of various lead systems used for ECG recording.

4. Define Cardiac output. Find the cardiac output of a person if his heart rate is 72bpm stroke volume of 70 ml.

5. Describe the standard 12 lead configuration used in ECG and also describe the typical ECG waveform.

6. List the various indirect methods used for blood pressure measurement.

7. Explain direct and indirect blood pressure measurement techniques.

8. Explain the blood pressure measurement using following technique

(i) Sphygmomanometer

(ii) Ultrasonic method

9. Explain the principle of electromagnetic blood flow measurement.

10. Explain with relevant equations, the working and measurement procedure of Body plethysmographs.

11. Explain in detail with neat diagram the auscultatory method of blood pressure measurement.

12. What are the automated indirect methods for blood pressure measurement?

13. With the help of block diagram explain the working of a typical ECG machine.

MODULE 3

1. Explain the 10-20 Electrode system.

2. What is EMG? Draw the block diagram of EMG measurement and explain the need for each block.

3. With neat schematic diagram explain the principle of following

(i) pH measurement

(ii) Flame Photometer

4. Draw the block diagram of coulter counter and explain its working.

5. Explain the technique for measuring blood PO2.

6. Why is it necessary to maintain acid-base balance in the human body? Indicate the normal pH value for arterial and venous blood.

7. State 3 reasons why abstract models are important in respiratory physiology, pulmonary function testing and patient monitoring.

8. Explain in detail central and peripheral nervous system.

9. With a functional diagram, explain the working of a spirometer.

10. Explain with neat diagram, the working of EMG.

11. Discuss pulse oximetry.

12. Explain biotelemetry system with a neat block diagram.

13. Explain how respiration rate can be measured? Give its normal values.

14. Define the term latency in EMG.

MODULE 4

1. What is the use of biphasic DC defibrillator?

2. What is the principle of bubble oxygenator?

3. Draw the block diagram of a synchronized DC defibrillator and explain its working.

4. What is fulguration?

5. Draw the block diagram of short wave diathermy unit and explain its working.

6. Discuss the different modes of operation of cardiac pacemakers.

7. What are the classifications of defibrillators?

8. Draw and explain heart lung machine model.

9. What are the different types of oxygenators used in heart lung machine?

10. Mention the importance of defibrillator protection circuit in ECG recorder.

11. Draw and explain the schematic of evoked response audiometer and explain.

12. Write a short note on dialyzers.

13. What is the principle of surgical diathermy.

14. Explain the working of a fixed rate pacemaker.

15. Draw the typical discharge pulse of a Dc defibrillator

16. Can pain be relieved through electrical stimulation? What is the instrument for it?

MODULE 5

1. Distinguish radiographic and fluoroscopic techniques.

2. Draw the block diagram of a CT scanner and explain its operation with emphasis on

image reconstruction.

3. What are the advantages of MRI scan?

4. What do you mean by CT? Give the mathematical details of obtaining x ray images in CT.

5. Briefly explain the different modes of ultrasound scanning with suitable diagrams.

6. What are the limitations of CT scan?

7. Explain the function of diagnostic X ray equipment with neat block diagram.

8. Give the hazardous effect of ionising radiation.

9. Describe in detail the construction and working of X-ray machine.

10. What are various ways by which macro shocks can be induced?

11. Explain hoe electrical safety and protection needs to be followed in handling of medical equipment's.

MODULE 6

1. What is power line interference?

2. What is leakage current?

3. Define Let-Go current of human body.

4. List the applications of bio telemetry.

5. Explain the principle of operation of MRI with suitable illustrations.

6. Explain how electrical hazards protection can be provided in biomedical instrumentation Systems.

7. Explain the working of a biotelemetry system with sub-carrier and list its advantages.

8. What is meant by single channel telemetry?

9. Elaborate on medical equipment maintenance and safety parameters in handling it.

10. Define micro and macro shocks.

11. What are the essential requirements of FM telemetry receiver?

12. Mention the situations which account for hazards from electric shock.

Biomedical Engineering
COURSE CODE -EC365

(Module 1 & 2)

A – A good student is liked by teacher

G – Greets everyone with smile
O – Obedient
O – On time for college
D – Dresses neatly

S – Studies with interest
T – Treats everyone with smile
U – Understands everything
D – Does daily home work
E – Eager to know new things
N – Never misbehaves
T – Talks little in class

References

1. Joseph J Carr, "*Introduction to Biomedical Equipment Technology* ": Pearson Education 4th e/d.
2. K S Khandpur, "*Hand book of Biomedical instrumentation* ", Tata McGraw Hill 2nd e/d.
3. Leslie Cromwell,"Biomedical Instrumentation and Measurements", Pearson Education.
4. John G Webster, "*Medical Instrumentation application and design*", John Wiley 3rd e/d.
5. Richard Aston, "*Principle of Biomedical Instrumentation and Measurement*".

INTRODUCTION

- Bio means its related to life. There are many inter disciplines also. E.g. Biochemistry, Biophysics, Biomechanics,Bioelectronics, Bioinstrumentations etc…
- Bioengineering- defined as application of the knowledge gained by a cross fertilization (fusion) of engineering and the biological sciences so that both will be more fully utilized for the benefit of man, also called *biomedical engineering*.
- Bio-medical instrumentation is a subdivision of biomedical engineering. It emphasizes the measurement of all the variables in the body for the use of diagnosis.
- Association for the Advancement of Medical Instrumentation (AAMI).
- Biomedical equipment technician (BMET).
- Anatomy- the branch of science concerned with the structure and location of organs.

- Physiology is the science which deals with the functions of the living organism and its organs, and of the physical and chemical factors and processes involved.

- Bioelectric-potential-

  They are actually ionic voltages produced as a result of the electrochemical activity of certain special type of cells. And these ionic voltages can be converted to electrical voltages,so that they can be measured and displayed and can be used for diagnosis and treatment of diseases.

- **ECG-** An **electrocardiogram** is a test that checks for problems with the electrical activity of your heart.
- **EEG-** An **electroencephalogram** is a test that detects electrical activity in your brain using small, flat metal discs (electrodes) attached to your scalp.
- **EMG- Electromyography** is a diagnostic procedure to assess the health of muscles and the nerve cells that control them (motor neurons).
- **EOG-Electrooculography** is a technique for measuring the corneo-retinal standing potential that exists between the front and the back of the human eye.

BIOMETRICS

- The branch of science that includes the measurement of physiological variables and parameters is known as **biometrics**.
- Sensors and Transducers are useful for making of measuring instruments related to body.
- For designing of medical instrumentation systems, few factors are to be considered.
- (1) Range, (2) Sensitivity, (3) Linearity, (4) Hysteresis,
  (5) Frequency Response, (6) Accuracy, (7) Signal to Nosie Ratio, (8) Stability, (9) Isolation, (10) Simplicity.

- **RANGE** : " All the levels of input operated and the reading provided by that instruments which is smallest to largest(maximum) values is called a range of the instruments."
- **SENSITIVITY**: "The sensitivity of an instrument determines how small a variation of a variable of parameter can be reliably measured. "
- **LINEARITY**: The degree to which variations in the output of an instrument follow input variations is referred to as the linearity of the device.
- **HYSTERESIS**: " Hysteresis is a characteristic of some instruments where by a given value of the measured variable results in a different reading when reached in ascending direction from that obtained when it is reached in a descending direction."

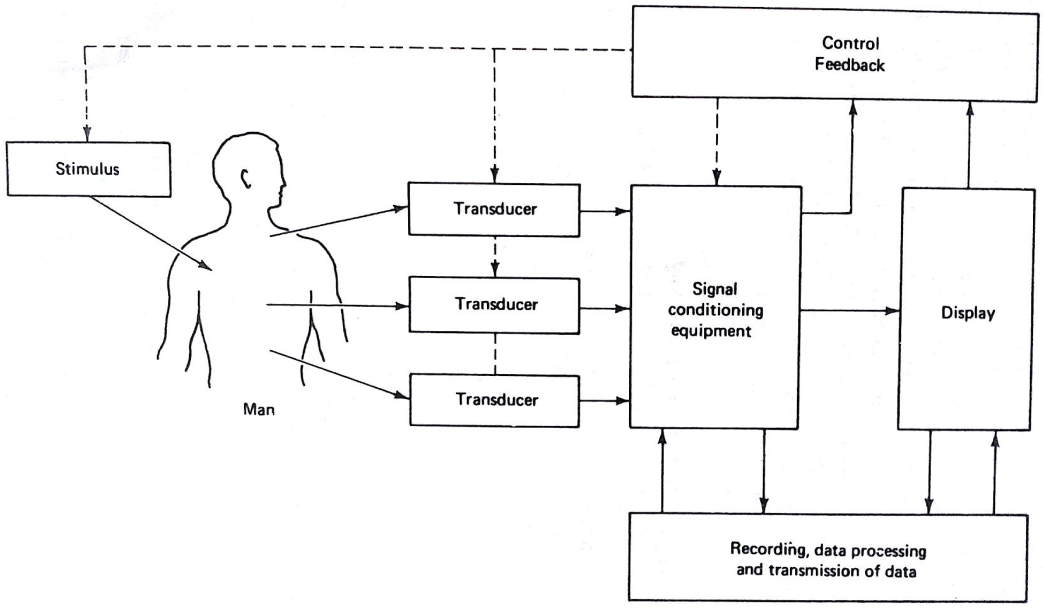
- **FREQUENCY RESPONSE**: “ The frequency response of an instrument is its variation in sensitivity over the frequency range of the measurement.”
- **ACCURACY**: “ Accuracy is a measure of systemic error. (Error due to tolerance of electronic component,mechanical error due to meter movement,error due to poor frequency response)
- **SIGNAL TO NOISE RATIO**: “ It’s a ratio of signal power to noise power and it should be as high as possible. In hospital generally power line noise act an interference.
- **STABILITY**: In control engineering, stability is the ability of a system to resume a steady state condition following a disturbance at the input rather than be driven into uncontrollable oscillation.
- **SIMPLICITY**: “All systems and instruments should be as simple as possible to eliminate the chance of component or human error.

Man-Instrument System

Introduction

- The system which includes both the human organism and the instrumentation required for measurement of the human is called the man-instrument system.
- The basic objectives of any instrumentation system generally falls in anyone of the following major categories:
  1. Information gathering
  2. Diagnosis
  3. Evaluation
  4. Monitoring
  5. Control
- Clinical Instrumentation and research instrumentation.
- Two types of measurements.. (1) Vivo(inside the body) (2) Vitro(Out side the Body)

Components Of The Man Instrument System



Bioelectric Potentials (Ionic Potentials)

Bioelectric potentials are ionic voltages produced as a result of the electrochemical activity of cells.

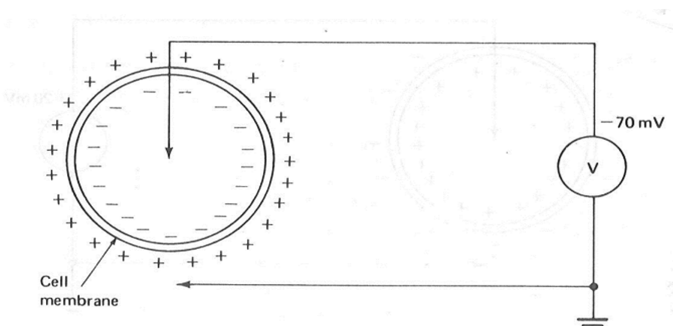
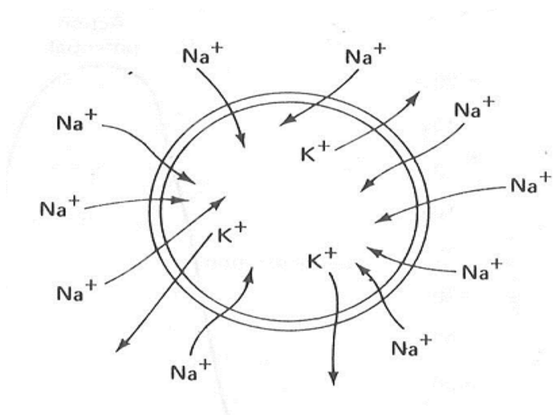


Fig.:A polarized cell with its resting potential

The ionic movements associated with depolarisation:



The cross section of a depolarized cell

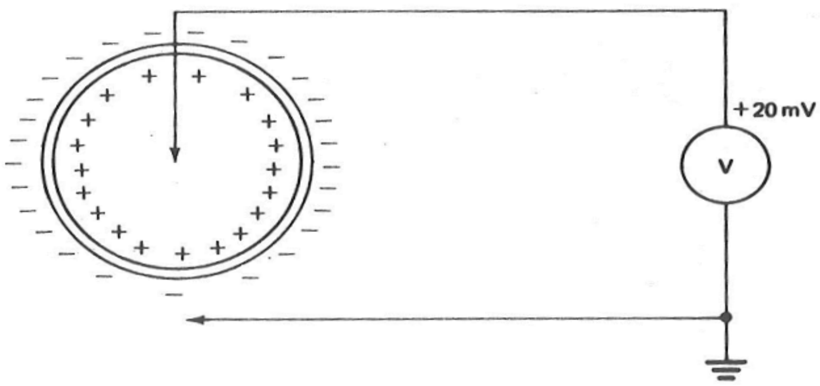
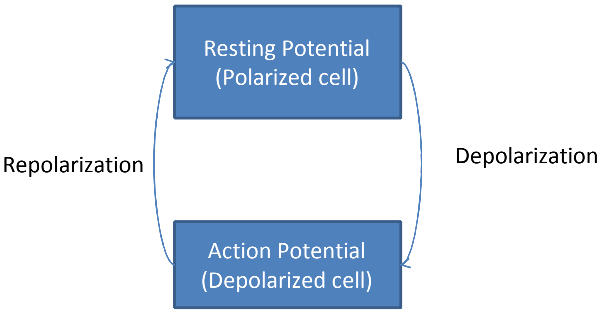
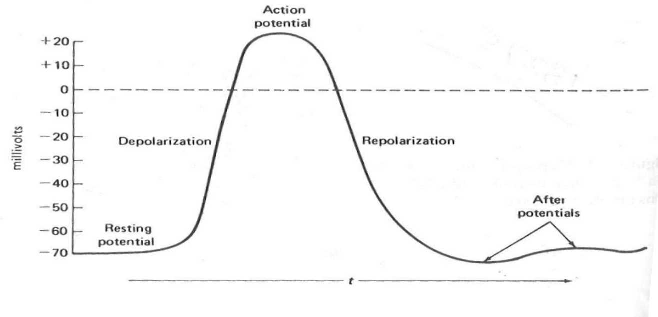


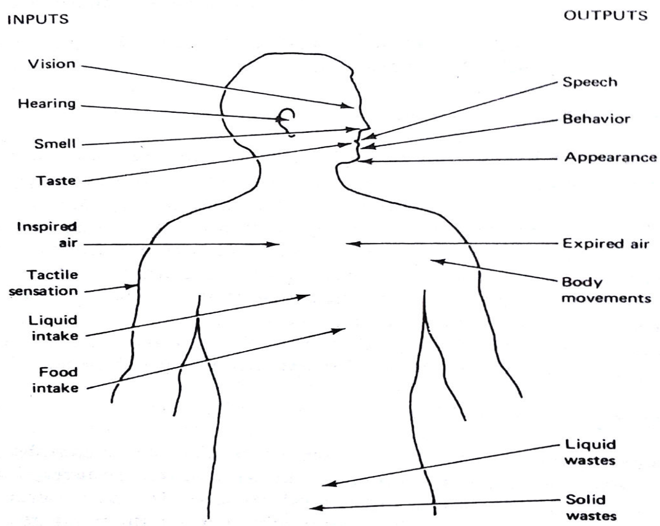
Fig:Depolarized cell during an action potential



Action Potential Waveform

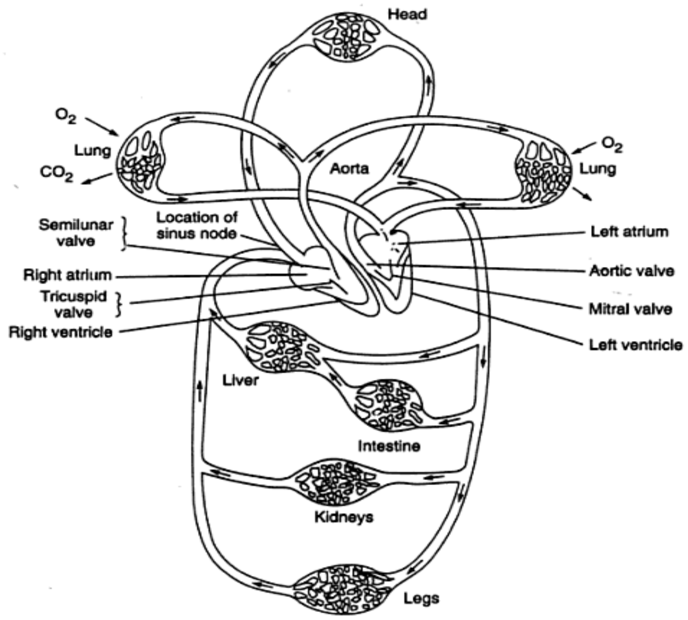


Physiological Systems Of The Body



Communication of Man with his environment

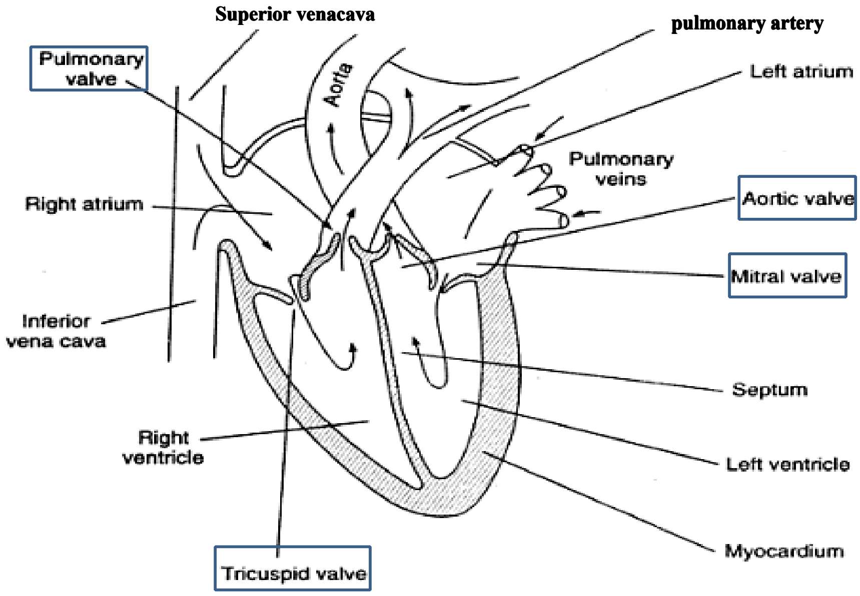
CIRCULATORY SYSTEM



The Circulatory system

- The circulatory system carries nourishment and oxygen to, and waste and carbon dioxide from, the tissues and organs of the body
- In human_circulatory system, the heart serves as a pump to move blood through vessels called arteries and veins.

Physiology of cardiac system



Structure of the heart

- The heart is a dual pump, consisting of a two chambered pump on both the left and the right sides.
- The **upper chambers** are inputs to the pumps and are called ***atria(atrium)***.
- The **lower chamber** of the heart are called ***ventricles*** and are the pumps output.

The heart has four valves

✓The **tricuspid** valve or right atrio-ventricular valve
✓**Bicuspid** Mitral or left atrio-ventricular valve
✓**Pulmonary** valve
✓**Aortic** valve

- The deoxygenated blood is returned to the right side of the heart via the **venous** system.
- Blood from the head and the arms, as well as rest of the upper part of the body, returns to the heart through the **superior vena cava** ; blood from the lower portion of the body returns through the **inferior vena cava**.
- The inferior is placed lower in the body than superior.

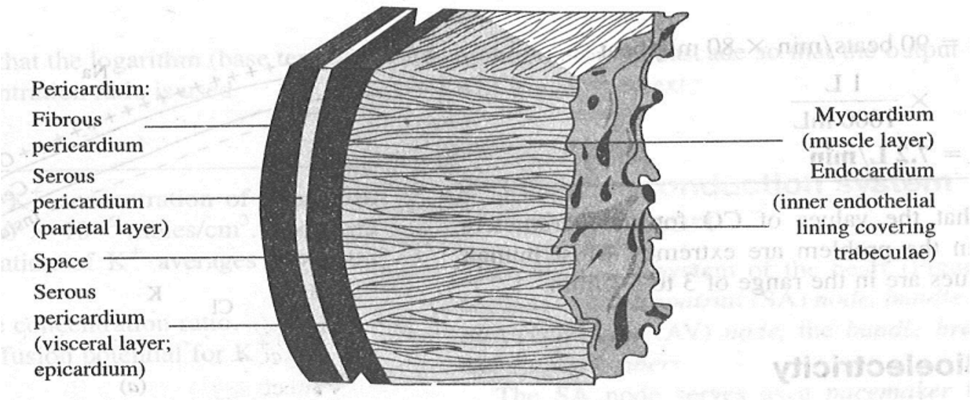
• Blood leaves the right atrium through the tricuspid valve to enter right ventricle.
• From right ventricle it passes through the pulmonary semi lunar valve to pulmonary artery.
• This vessel carries blood to the lungs, where CO2 is given out and O2 is taken in.

- Blood returning from lungs via pulmonary vein re-enters the heart through left atrium.
- It then passes through the mitral valve to the left ventricle and then back into the main stream of circulatory system via the aortic valve.
- The heart serves as a pump because of its ability to contract under electrical stimulus. When an electrical triggering signal is received, the heart will contract, starting in the atrium. A fraction of second later the ventricles also begin to contract.
- The ventricular contraction is known as ***systole***. The ventricular relaxation is known as ***diastole***.

- The great artery attached to the left ventricle is called the aorta.
- Blood then circulates through the body to again return to the right side of heart via superior and inferior vena cava.
- The heart in a resting adult pumps approximately 3 to 5 litres of blood per minute. This is called cardiac output (co) and is defined as the product of heart rate in beats per minute and the volume of blood ejected from the ventricle during systole.

  CO=heart rate (beats/min) x stroke volume (L/beat)
- The heart wall consists of three layers
  - The Pericardium or Epicardium
  - The Myocardium
  - The Endocardium

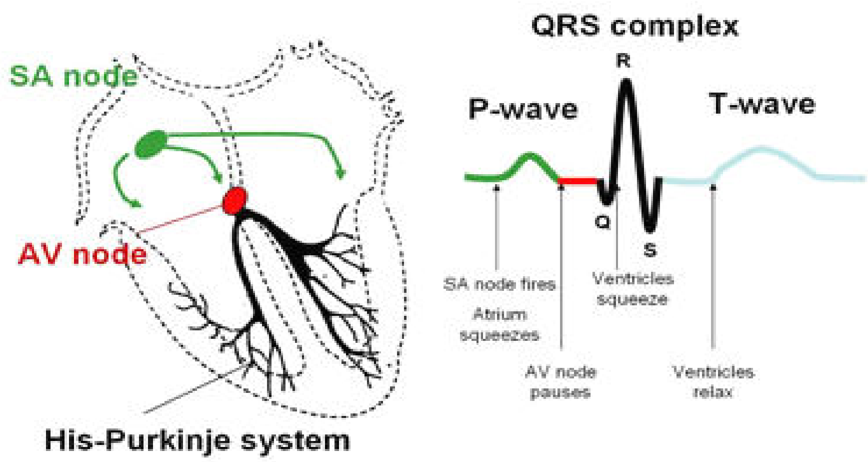
Layers of heart



Propagation of action potential

- When a cell is excited and generates action potential, ionic currents begins to flow.
- This cell excites the neighboring cells or adjacent areas of the same cell.
- The rate at which an action potential propagated from cell to cell is called the propagation rate.
- Propagation rate or conduction velocity varies from cell to cell, depending on the type and diameter of the cell.

Electroconduction system of the heart



- The conduction system of the heart consists of the sinoatrial (SA) node, atrioventricular (AV) node, bundle of His, the bundle branches, and Purkinje fibers.
- The SA node serves as a pacemaker for the heart and it provides the trigger signal (electrical impulses) to control heart beat.
- The SA node fires electrical impulses through the bioelectric mechanisms of depolarization and repolarization.
- When the SA node discharges a pulse, then electrical current spreads across the atria causing them to contract. Blood in the atria is forced by the contraction through the valves to the ventricles.

- The velocity of propagation for the SA node action potential is about 30 cm/s in atrial tissue.
- There is a band of specialized tissue between the SA node and the AV node where the velocity of propagation is faster than it is in atrial tissue and it is of the order of 45 cm/s.
- the action potential will reach the AV node 30 to 50 ms after the SA node discharges.
- the ventricles will not contract in response to an action potential before the atria are empty of their contents.
- Therefore a delay is provided at the AV node(110 ms).

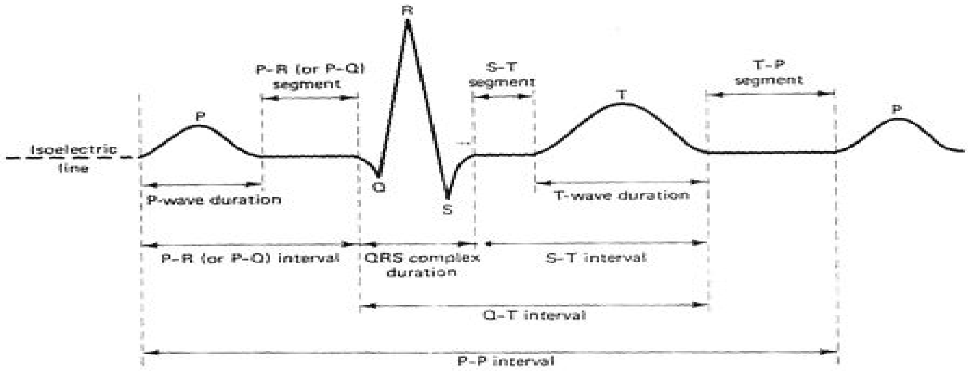
- The AV node, then, operates like a delay line to retard the advance of the action potential along the internal electroconduction system toward the ventricles.

- The muscle cells of the ventricles are actually excited by the Purkinje fibers. The action potential travels along these fibers at a much faster rate, on the order of 2 to 4 m/s.

- The fibers are arranged in two bundles, one branch to the left and one to the right.
- Conduction in the Purkinje fibers is very rapid, consuming only 60 ms to reach the furthest Purkinje fibers.

- The action potential generated in the SA node stimulates the muscle fibers of the myocardium (of ventricles), causing them to contract. When the muscle is in contraction, the volume of the ventricular chamber is less, so blood is squeezed out.
- This electrical discharge can be mechanically plotted as a function of time, and the resultant waveform is called an electrocardiogram (ECG).
- Electrocardiogram is the waveform resulting from the heart's electrical activity.
- The instrument used to measure ECG is called the electrocardiograph.

Electrocardiogram (ECG).



P wave = Atrial depolarization
PR segment = AV nodal delay
QRS complex = Ventricular depolarization (atria repolarizing simultaneously)
ST segment = Time during which ventricles are contracting and emptying
T wave = Ventricular repolarization
TP interval = Time during which ventricles are relaxing and filling

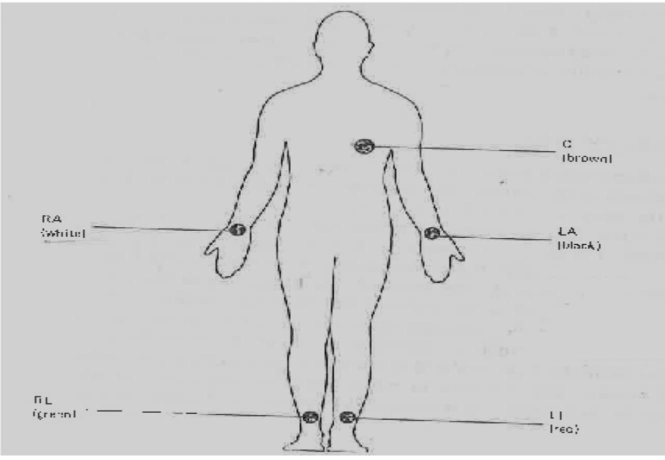
ECG Leads

- The wires, and the electrodes to which they are connected are usually called **leads**.
- The waveform obtained using a particular configuration of electrodes is also called **lead**.
- The ECG waveform is very dependent on the placement of the electrodes.
- ECG is recorded from a number of different leads, usually 12, to ensure that no important detail of the waveform is missed.

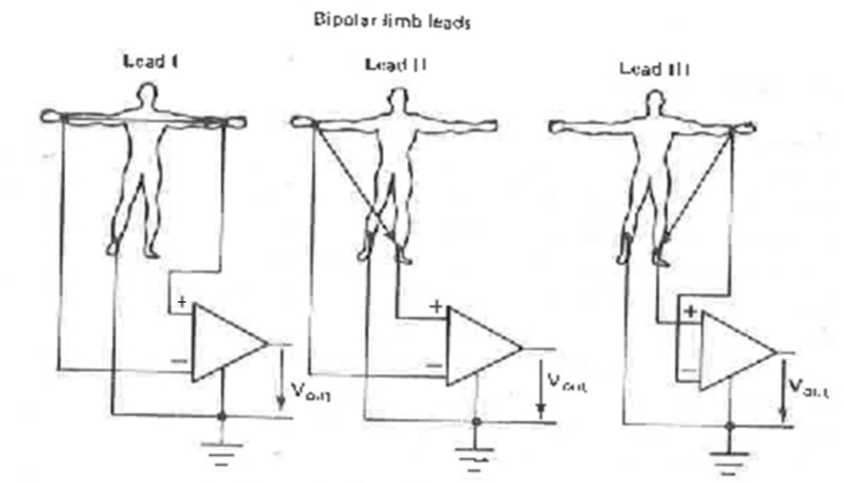
The standard lead system

- In standard ECG recording there are five electrodes (electrode positions) connected to the patient: right arm (RA),left arm (LA), left leg (LL), right leg (RL), and chest (C).
- The electrode on the right leg (RL) is only for ground reference.
- The recording obtained across different pairs of electrodes results in different waveform shapes and amplitudes. These different views are called leads.
- Each lead conveys a certain amount of unique information that is not available in the other leads.

The standard lead system



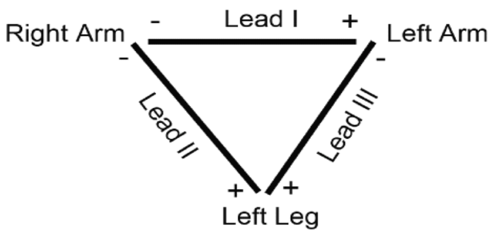
BIPOLAR LEADS



- Bipolar leads are designated as lead I, lead II, and lead III .
- In bipolar leads , the ECG is recorded by using two electrodes such that the final trace corresponds to the difference of electrical potential existing between them. They are called standard leads or Einthoven leads.
- In lead1, the electrodes are placed in the right and left arm.
- In lead II, the electrodes are placed in the right arm and left leg and
- in lead III, they are placed on the left arm and left leg.
- In all lead connections, the difference of potential measured between two electrodes is always with the reference to a third point on the body, the “right leg”.

Einthoven triangle

- Einthoven proposed that the electric field of the heart could be represented diagrammatically as a triangle, with the heart ideally located at the centre. The triangle known as “ Einthoven triangle”.



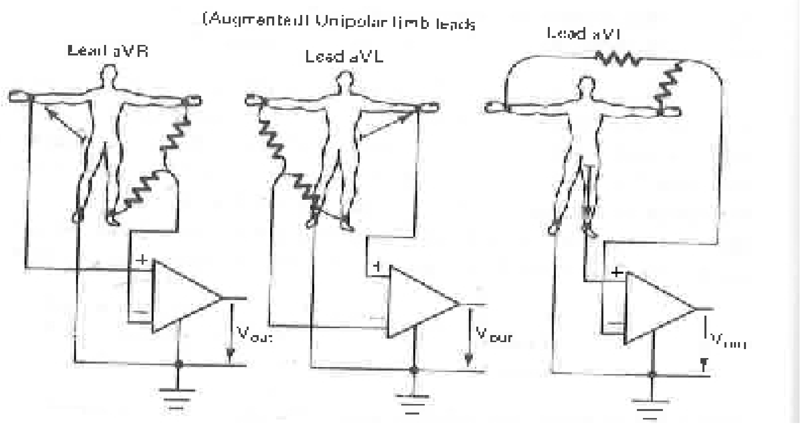
Eithoven’s triangle.

- Lead I: PD between left arm and right arm(LA-RA). LA is connected to the amplifier's non inverting input, while RA is connected to the inverting input.
- Lead II: PD between left leg and right arm(LL-RA). The LL electrode is connected to the amplifier's non inverting input, while the RA is connected to the inverting input (LA is shorted to RL).
- Lead III: PD between left leg and left arm(LL-LA). The LL is connected to the non-inverting input while LA is connected to the inverting input (RA is shorted to RL).

Unipolar leads -Augmented Unipolar limb leads

➢ the limb electrode – is the exploratory electrode (active electrode)

Label	Meaning of label	Position of lead on body
AVr	Augmented vector right	Right wrist
AVL	Augmented vector left	Left wrist
AVf	Augmented vector foot	Left foot

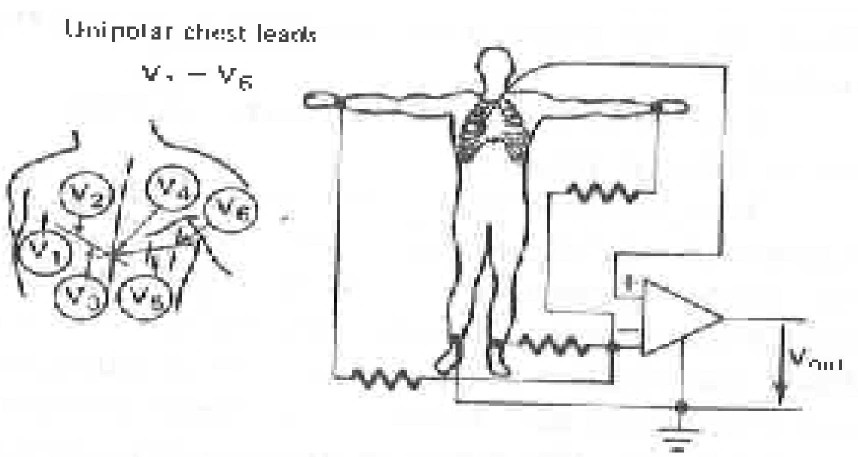


- **Lead AVR :** In this,the right arm is recorded with respect to a reference established by joining the left arm and the left leg electrodes.
- PD between RA(VR) and the average of potential of the LL and LA. RA is connected to the non inverting input, while LL and LA are summed at the inverting input.
- **AVL leads:**In this, the left arm is recorded with respect to the common junction of the right arm and left leg.
- PD between LA(VL) and the average of potential of the LL and RA. LA is connected to the non inverting input, while LL and RA are summed at the inverting input.

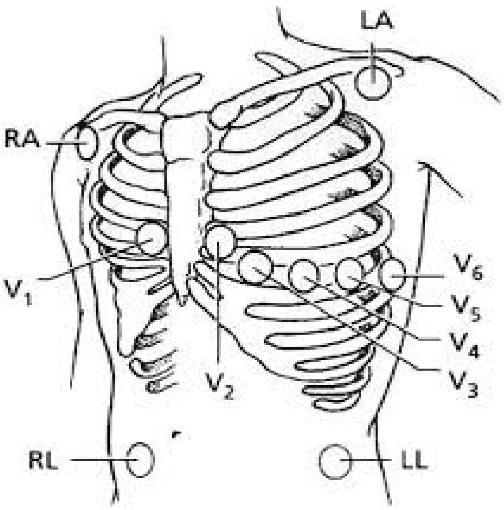
- **AVF lead:** In this, the left leg is recorded with respect to the two arm electrodes tied together.
- PD between LL(VF) and the average of potential of the RA and LA. LL is connected to the non inverting input, while RA and LA are summed at the inverting input.

- In all three augmented leads, the signals from two limbs are summed in a resistor network and then applied to the amplifier's inverting input, while the signal from the remaining limb electrode is applied to the non-inverting input.

Unipolar Chest Leads (Precordial Leads)

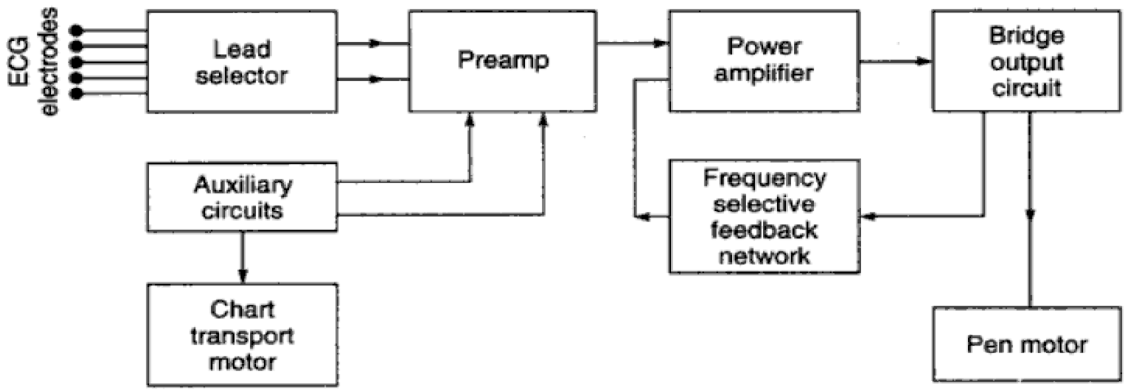


Unipolar Chest Leads



- For the unipolar chest leads, a single chest electrode (exploring electrode) is placed on each of the six predesignated points on the chest (V1 to V6).
- The three limb electrodes are used to obtain the central terminal.
- The exploratory electrode records the potential of the heart action on the chest at six different positions.

ECG Block Diagram



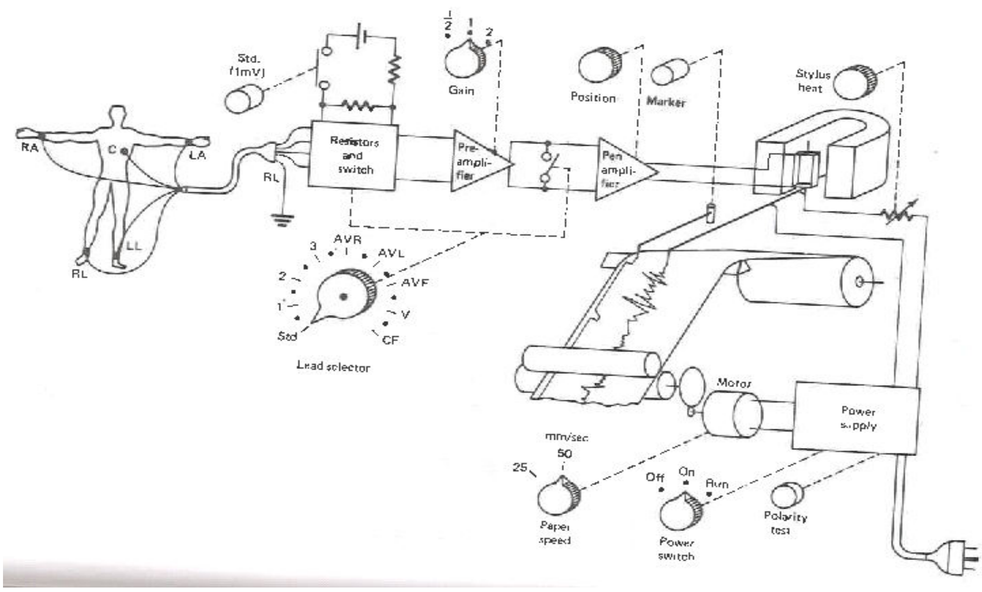
DESCRIPTION

- The potentials picked up by the patient electrodes are taken to the lead selector switch
- Here the electrodes are selected TWO by TWO according to the lead program
- The signal is then given to the preamplifier
- A **preamplifier** (preamp), or **control amplifier**, is an electronic amplifier which prepares an electronic signal for further amplification or processing

- It is usually a 3 or 4 stage differential amplifier
- The amplified O/P is then given to the power amplifier
- The O/P of the power amplifier is fed to the pen motor which deflects the writing arm of the paper
- Frequency selective network is an R-C network, which provides necessary damping of the pen

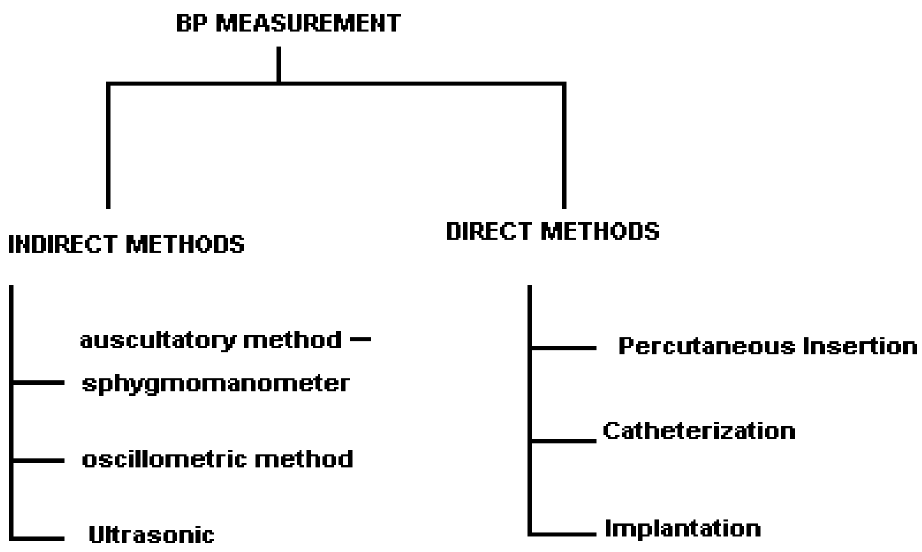
- The auxiliary circuits provide a 1 mV calibration signal and automatic blocking of the amplifier during change in the position of the lead switch
- It also include a speed control circuit for the chart driver motor

Block diagram of ECG Recording



BLOOD PRESSURE

- the pressure exerted by the blood against the vessel walls.
- Systolic blood pressure. The highest pressure in the artery, produced in the heart's contraction (systolic) phase. The normal value for a 20-year-old man is 120 mm Hg.
- Diastolic blood pressure. The lowest pressure in the artery, produced in the heart's relaxation (diastolic) phase. The normal value for a 20-year-old man is 80 mm Hg.
- Pulse pressure. The difference between the systolic and diastolic pressures.The normal value is 40 mm Hg
- Mean blood pressure. Diastolic pressure plus one third of the pulse pressure. This is the average effective pressure forcing blood through the circulatory system. The normal value is 96 to 100 mm Hg.



Indirect Methods: Auscultatory Method

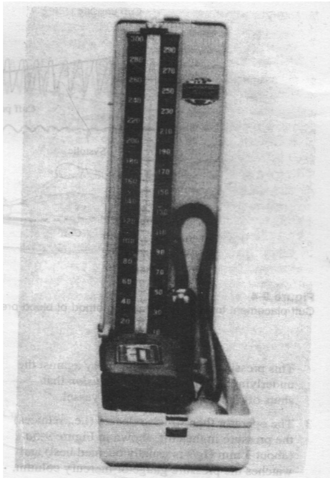


Figure 9-3
Mercury column sphygmomanometer. (Photo courtesy of E. Baum Co., Inc.)

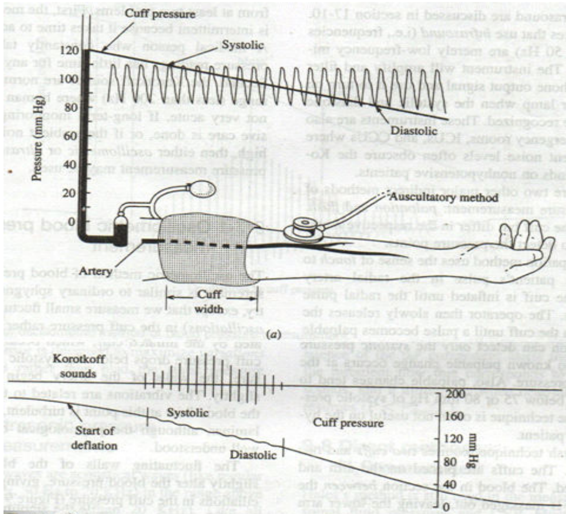


Figure 9-5
Diagram of the auscultatory method of blood pressure measurement. (a) Cuff placement. (b) Korotkoff sounds.

Auscultatory Method ….cntd

- Uses **sphygmomanometer**
- Consists of an inflatable rubber bladder called the cuff, a rubber squeeze-ball pump-and-valve assembly, and a manometer.

Procedure:

- The cuff is wrapped around the patient's upper arm at a point about midway between the elbow and shoulder
- The stethoscope is placed over brachial artery.
- The cuff is inflated so that the pressure inside the inflated bladder is increased to a point greater than the anticipated systolic pressure.

- This pressure compresses the artery against the underlying bone, causing an occlusion that shuts off the flow of blood in the vessel.
- The operator then slowly releases (ie, reduces) the pressure in the cuff, and watches the mercury column.
- the operator begins to hear some pressure, crashing, snapping sounds in the stethoscope that are caused by the first jets of blood pushing through the occlusion. These sounds, called Korotkoff sounds.
- These sounds continue as the cuff pressure diminishes, becoming less loud as the blood flow through the occlusion becomes smoother.

- Korotkoff sounds disappear or become muffled when the cuff pressure drops below the patient's diastolic pressure.
- To read the blood pressure, the operator notes both the gauge pressure at the onset of Korotkoff sounds (systolic) and when the sounds become muffled or disappear (diastolic).
- These pressures are usually recorded in the ratio of systolic over diastolic (ie, 120/80 mm Hg).
- Limitation:Include the hearing acuity (sharpness) of the operator and how accurately the operator is able to read a changing pressure gauge when the Korotkoff sound features are heard.

Indirect Method - The palpation method

- **The palpation method** uses the sense of touch to detect the patient's pulse in the radial artery (wrist).
- The cuff is inflated until the radial pulse disappears. The operator then slowly releases the pressure in the cuff until a pulse becomes palpable in the radial artery. The pressure at which this occurs is the systolic blood pressure.
- Palpation can detect only the systolic pressure because no known palpable change occurs at the diastolic pressure.

Indirect Method:
Oscillometric blood pressure measurement:

- similar to ordinary sphygmomanometer method.
- measure small fluctuations (i.e., oscillations) in the cuff pressure
- When blood breaks through the occlusion created by the inflated cuff the walls of the artery begin to vibrate slightly.
- the blood flow at this point is turbulent (unstable), rather than laminar(stable)

- The onset of the pressure oscillations correlates well with the systolic pressure.
- The peak amplitude of the oscillations corresponds to the Mean Arterial Pressure, which is the time average of blood pressure.
- The diastolic pressure corresponds to the point where the rate of amplitude decrease suddenly changes slope.

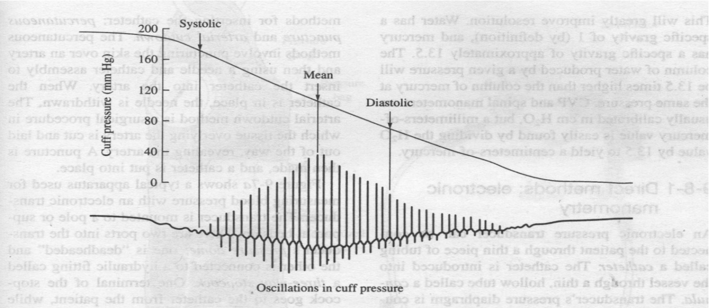


Figure 9-6
Illustration of oscillometric method of blood pressure measurement.

- Oscillometric blood pressure monitors are used extensively when monitoring is needed.
- A typical oscillometric blood pressure monitor is microprocessor controlled and is designed to periodically inflate and slowly deflate the cuff.

Ultrasonic pressure measurements

- Ultrasonic waves are acoustical waves in the range above human hearing (ie, more than 20 KHz).
- Like all acoustical waves, ultrasonic waves are subject to Doppler shift that is a slight alteration of frequency (ΔF) when reflected from a moving object.
- If piezoelectric ultrasound sensors are placed over the artery, under the cuff, then they can perform Doppler detection of the blood flowing in the artery.

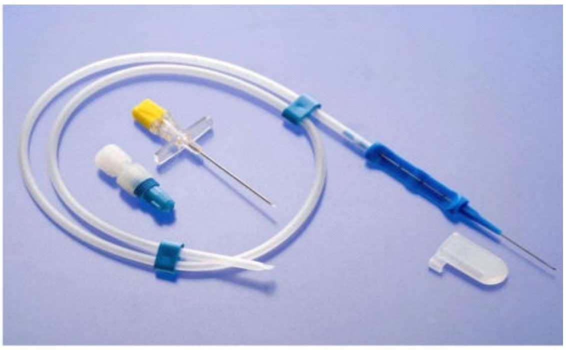
- A **transmit crystal** sends a sine-wave beam into the tissue. When it encounters a fluctuating vessel wall, some of its energy is reflected back ("backscattered") to the **receive crystal**, which is located close to the transmit crystal.
- If ΔF is the Doppler shift, $F \pm \Delta F$ describes the frequency content of the backscattered wave.
- The existence of the ΔF component alerts the circuit to the turbulent flow that corresponds to Korotkoff sounds, and it diminishes when near-laminar flow resumes.

DIRECT METHOD

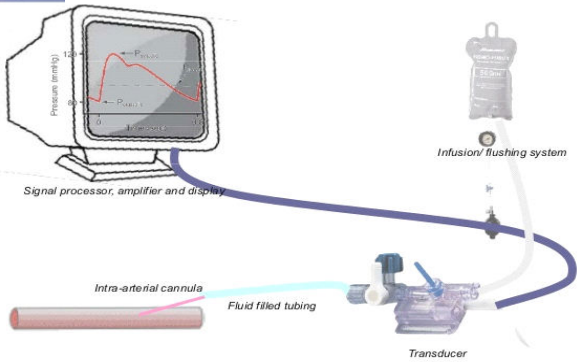
- Direct method of pressure measurement is used when the highest degree of accuracy and continuous monitoring is required.
- Direct measurement of blood pressure is usually obtained by one of the three methods :
  1. **Percutaneous insertion.**
  2. **Catheterization.**
  3. **Implantation of a transducer in a vessel or in the heart**

Percutaneous insertion

- For percutaneous insertion, a local anaesthetic is injected near the site of invasion.
- A hollow needle is inserted at a slight angle towards the vessel. When the needle is in place, a catheter is fed through the hollow needle with some metal guide. When the catheter is securely placed in the vessel, the needle and guide are withdrawn.
- blood pressure is sensed directly by attaching a transducer built into the tip of the catheter.



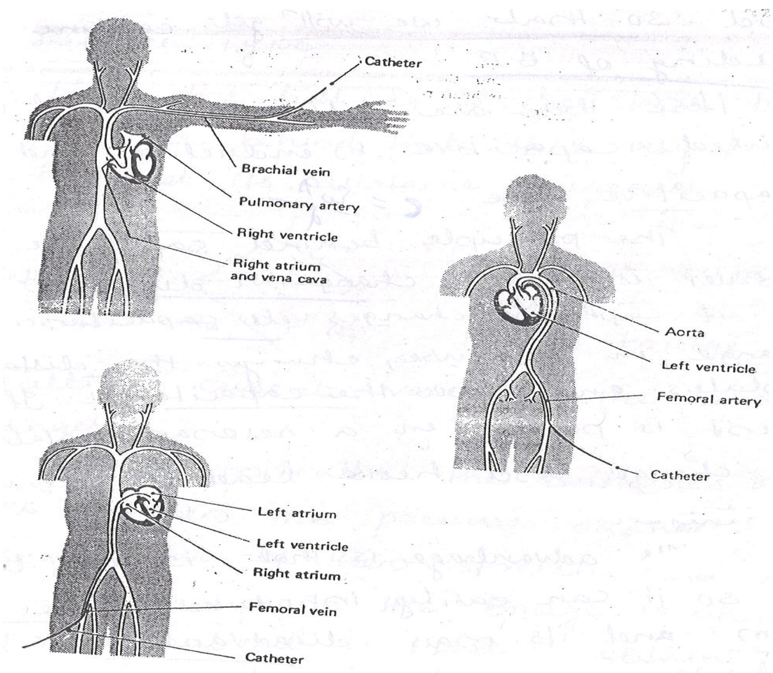
catheter



Catheterization

- A catheter is a long tube that is introduced into the heart or a major vessel by way of a superficial vein or artery
- Measurement of blood pressure with a catheter can be achieved in two ways.
- The first method is to introduce a sterile saline solution into the catheter so that the fluid pressure is transmitted to a transducer outside the body.
- This transducer converts the exerted pressure to electrical signals. The electrical signals can be amplified and displayed or recorded.
- Can use either a resistance strain gauge (unbounded) or a LVDT

- In the second method, pressure measurements are obtained at the source (Measurement at site).
- The device used is a catheter tip blood pressure transducer.
- Here the transducer is introduced into the catheter and pushed to the point at which the pressure is to be measured or the transducer is mounted at the tip of the catheter.
- The pressure exerted on the transducer are converted to the proportional electrical signals.
- Uses either a LVDT or a resistance bonded strain guage.



Implantation of a transducer in a vessel or heart

- a technique in which the transducer is more permanently placed in the blood vessel or the heart by surgical methods.
- transducer fixed in place in the appropriate vessel for long period – so continuous recording of BP can be made.

Blood Flowmeters

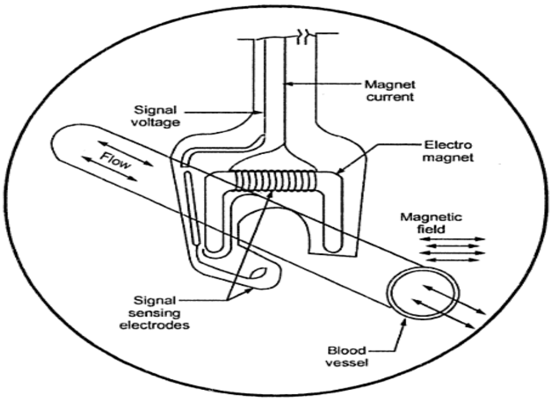
- Blood flow is one of the important physiological parameter and the most difficult to measure accurately.

•For many diagnosing purpose ,the blood flow in individual organs in the body have to be measured.

- Blood flow helps to understand basic physiological processes and e.g. the dissolution of a medicine into the body.
- Blood flow and changes in blood volume, are usually correlated with concentration of nutrients and other substance in the blood.
- Also, Blood Flow measurement reflects the concentration of O_2.

Electromagnetic Blood Flowmeter

- Operating principle is based on Faraday's law of electromagnetic induction.
- The law states that when a conductor is moved at right angles to a magnetic field an emf is induced in the conductor.



Principle of Electromagnetic Blood Flow Meters

- The Induced *emf*

$$\boldsymbol{e} = \int_0^{L_1} \mathrm{u} \times \mathrm{B}.\, d\mathbf{L}$$

- Where
  - **B** = magnetic flux density, T
  - **L** = length between electrodes, m
  - **u** = instantaneous velocity of blood, m/s

Principle of Electromagnetic Blood Flow Meters

- A permanent magnet or electromagnet positioned around the blood vessel generates a magnetic field perpendicular to the direction of the flow of the blood.
- Voltage induced in the moving blood column is measured with stationary electrodes located on opposite sides of the blood vessel and perpendicular to the direction of the magnetic field.

Design of Flow Transducers

- The electromagnetic flow-transducer is a tube of non-magnetic material to ensure that the magnetic flux does not bypass the flowing liquid and go into the walls of the tube.

- The tube is made of a conducting material and generally has an insulating lining to prevent short circuiting of induced emf.

- The induced emf is picked up by point electrodes made from stainless steel or platinum.

Design of electromagnetic flow transducer

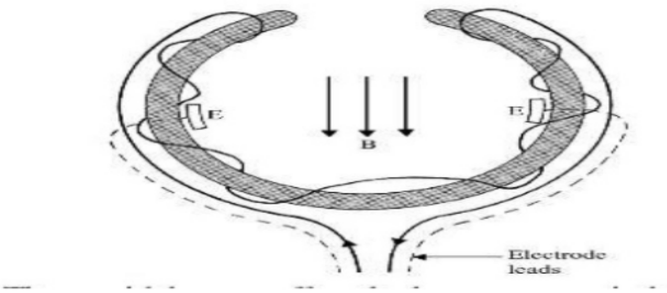


Fig: Typical flow transducer

- The electromagnetic flow-transducer is a tube of non-magnetic material to ensure that the magnetic flux does not bypass the flowing liquid and go into the walls of the tube.

Electromagnetic Blood Flowmeter - Types

- **Sine Wave Electromagnetic Flowmeter**
- **Square Wave Electromagnetic Flowmeter**

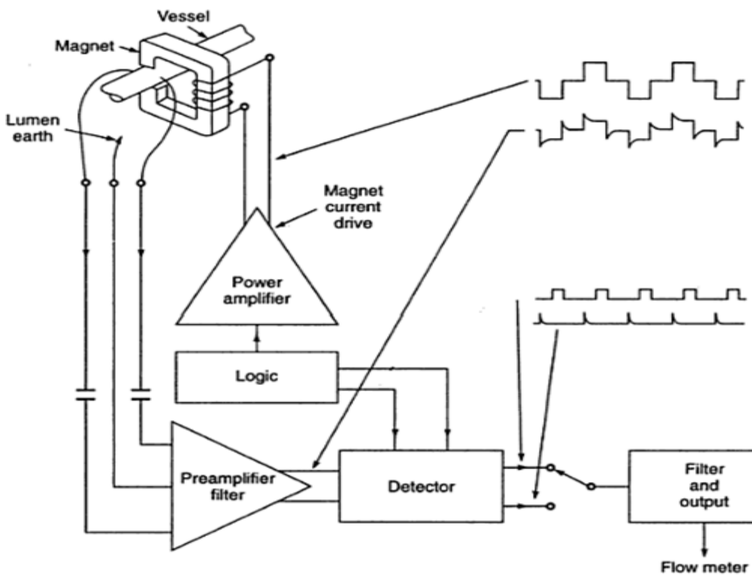
Sine wave Flowmeters

- Probe magnet is energized with a sine wave and the induced voltage will also be sinusoidal.
- Since the flow of blood acts as a secondary terminal of a transformer w.r.t probe magnet, an additional artifact voltage induced is called transformer voltage.
- This voltage is 90^0 out of phase with the original signal corresponding to flow of blood .
- A method for eliminating transformer voltage by using a gated amplifier(amplify signal only during flow induced voltage is maximum).
- This type of instrument is known as 'gated sine wave flowmeter' ,

Square wave flowmeter

- Probe magnet is energized with a square wave and induced voltage is also square wave.
- It is easier to control magnitude and wave shape of energizing current.
- Separation of transformer voltage is easy .
- For the measurement action square wave is amplitude modulated by variation in blood flow.

Square Wave Electromagnetic Flowmeter



Block diagram

❑ Transducer

- consist of an electromagnet, a pair of electrodes.
- Electrodes may be in contact with either flowing blood or outer surface of the blood vessel

❑ Preamplifier

- The induced voltage pick up by the electrodes, is given to a low noise differential amplifier through a capacitive coupling
- Must have a very high CMRR and input impedance

❑ Gating circuit

- It helps to remove spurious voltages generated during magnet current reversal
- The gating action is controlled by the circuit which provides an excitation current to the electromagnet

❑ Band pass filter

- It is an active RC band pass amplifier , which selectively pass through it the amplified square wave signal
- Peak response is kept for 400Hz

❑ Detector

- A phase sensitive detector is used to recover the signal
- It also helps in the rejection of interfering voltages at frequencies below the carrier frequency

❑ Low pass filter and output stage

- Demodulated signal is given to an RC LPF , which provides a uniform frequency response and a linear phase shift
- Followed by an integrator provide output corresponding to the mean flow

❑Magnet current drive

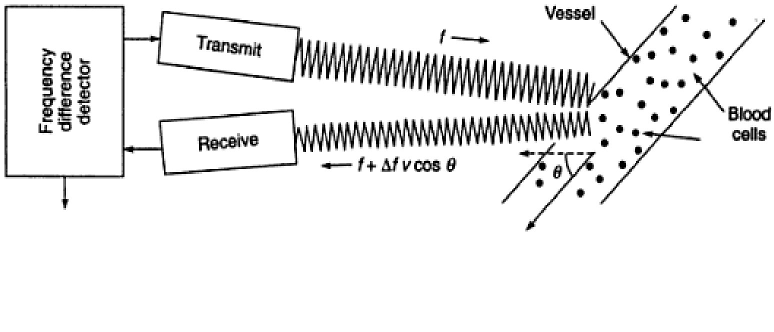
- The square wave input to the power amplifier stage which supplies current to the electromagnet is fed from a free running multivibrator

❑Zero flow reference line

- it establish the signal corresponding to zero-flow before measurement.

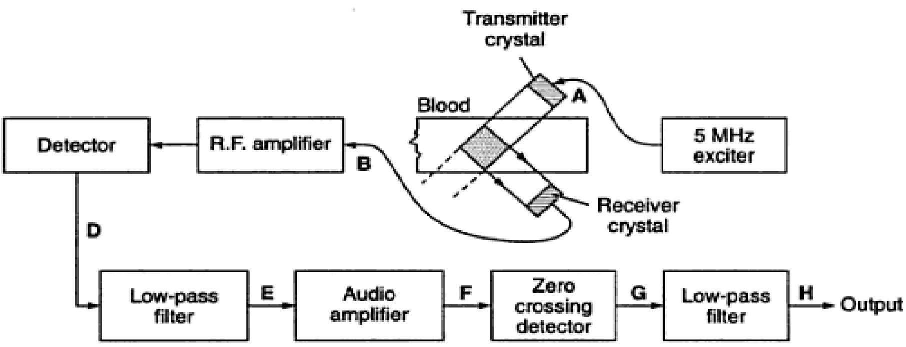
Ultrasonic Blood Flowmeters

Ultrasonic Doppler-shift Flow-velocity Meters



- The incident ultrasound is scattered by the blood cells and the scattered wave is received by the second transducer.
- The frequency shift due to the moving scatterers is proportional to the velocity of the scatterers.
- To measure absolute velocity,the angle of inclination of beam to the direction of flow must be known.
- One of the principle employed is that the Doppler shift signal is zero when the ultrasonic beam is at right angles to the direction of flow.

Block diagram of Doppler shift blood flowmeter



The electrical signal received at B consists of a large amplitude excitation frequency component plus a very small amplitude Doppler-shifted component scattered from the blood cells.
The detector produces a sum and difference frequencies at D.
The LPF selects the difference frequency which is in the audio range and amplified.
Each time the audio wave crosses the zero axis, a pulse appears at G.
The filtered o/p at H will be proportional to the blood velocity.

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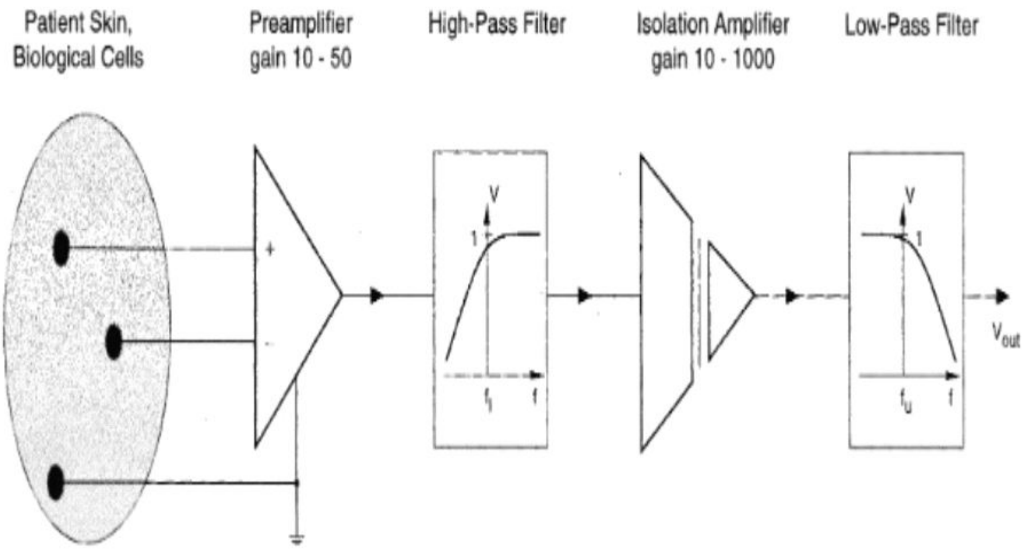
Bio Electric Amplifiers

Amplifiers used to process biopotentials are called bioelectric amplifiers

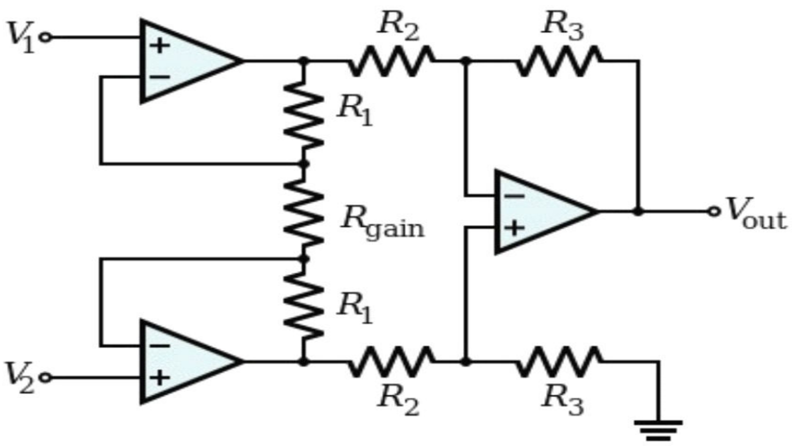


1. Instrumentation Amplifier

- An instrumentation (or instrumentational) amplifier is a type of differential amplifier that has been outfitted **with input buffer amplifiers.**
- The input buffer **eliminate the need for input impedance matching** and thus make the amplifier particularly suitable for use in measurement and test equipment.
- The gain of the circuit is given by

$$\frac{V_{out}}{V_2 - V_1} = \left(1 + \frac{2R_1}{R_{gain}}\right)\frac{R_3}{R_2}$$

Instrumentation Amplifier



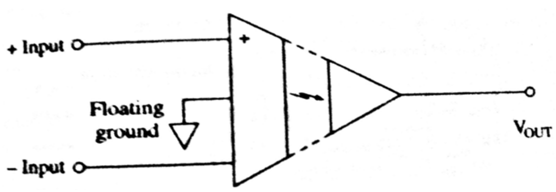
2. Isolation Amplifier

- **Isolation amplifiers** are a **form of differential amplifier** that allow **measurement of small signals** in the presence of a high common mode voltage by **providing electrical isolation** and an electrical safety barrier.
- They **protect data acquisition components from common mode voltages**, which are potential differences between instrument ground and signal ground.
- Isolation amplifiers are used in **medical instruments to ensure isolation of a patient from power supply leakage current.**
- Amplifiers with **internal transformers eliminate external isolated power supply.**

Symbol of Isolation Amplifier

Three types of methods are used to design isolation amplifier

- Transformer isolation
- Optical isolation
- Capacitive isolation



Isolation Amplifier

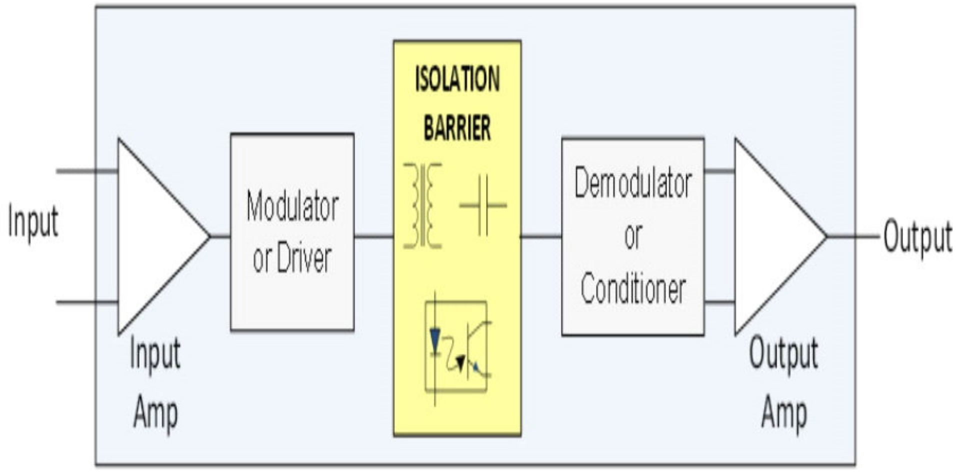
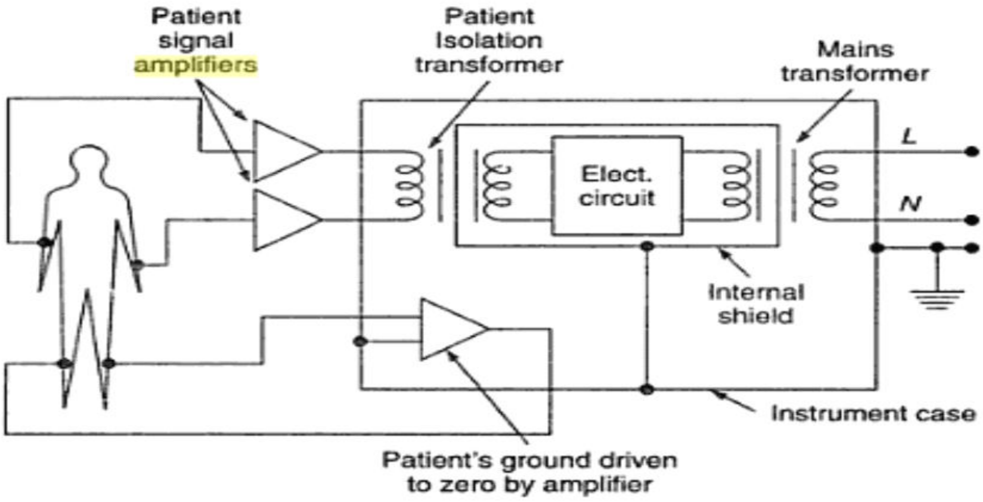


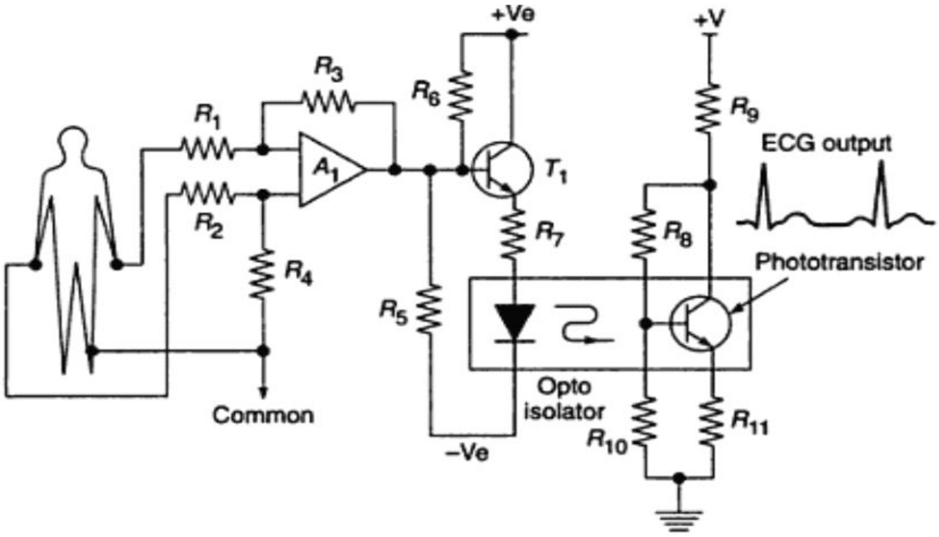
Figure 1. ISOamp Block Diagram

Isolation Amplifier



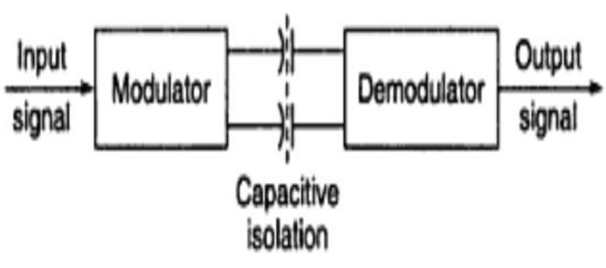
Isolation amplifier (transformer type)

Isolation Amplifier



Optically isolated isolation amplifier

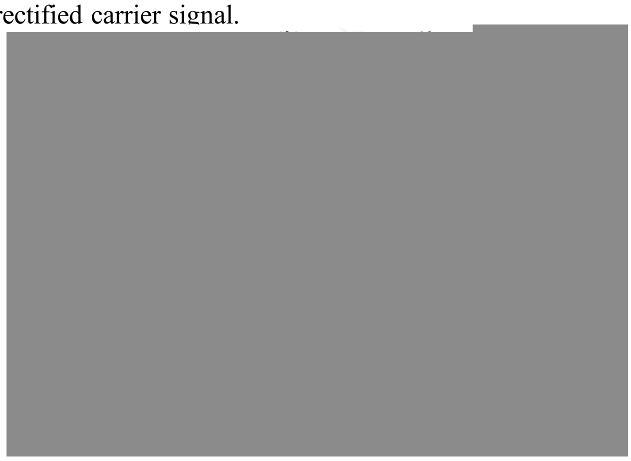
Isolation Amplifier



Capacitively coupled isolation amplifier

3. Carrier Amplifier

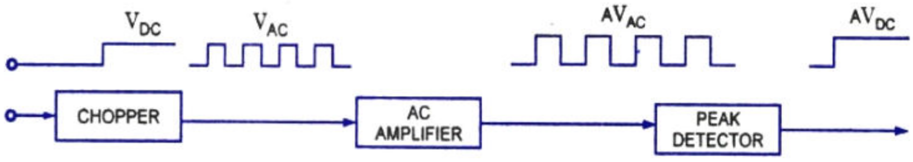
- A **dc** amplifier in which the dc input signal is filtered by a low-pass filter, then used to modulate a carrier so it can be amplified conventionally as an **ac** signal;
  the amplified dc output is obtained by rectifying and filtering the rectified carrier signal.



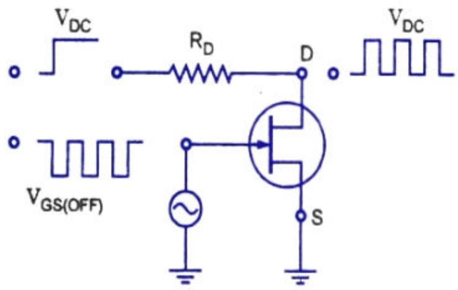
4. Chopper Stabilized amplifiers

- Two problems arise when we tries to record low level bio-potentials.
- Noise
- DC Drift
- These are worse , if we are using high gain amplifiers to amplify the weak bio-potentials.
- Noises produced in amplifier circuit and human body makes the problem worse.
- Drift is the change in gain or dc offset caused by thermal effects on amplifier components.

Chopper Stabilized amplifiers



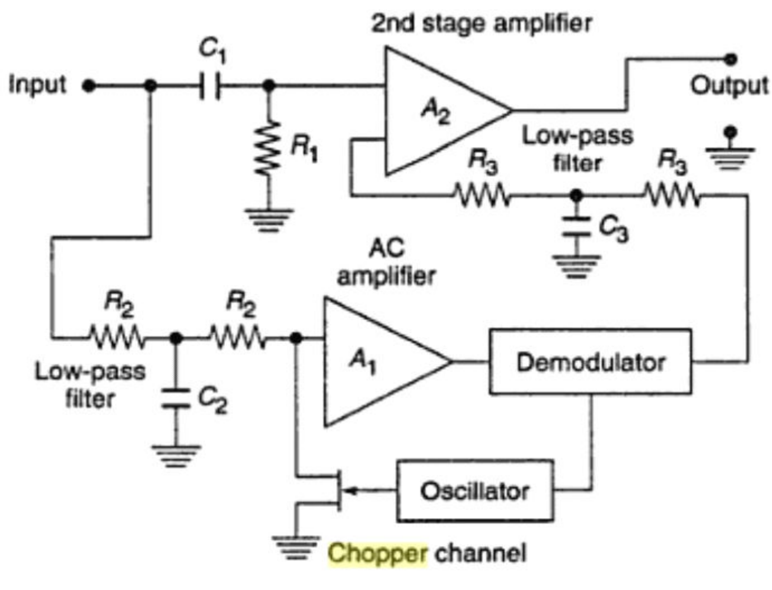
Block Diagram



FET Chopper

Chopper Amplifier

Chopper Stabilized Amplifiers



Electrode Theory

- Electrodes: Devices that convert ionic potentials into electronic potentials are called electrodes.
- The interface of metallic ions in solution with their associated metals results in an electrical potential that is called the electrode potential.
- At the equilibrium, the double layer charge produce with opposite sign.
- The hydrogen is taken as a reference electrode in international agreement. The other potentials are taken by taking hydrogen as a reference electrode. The electrodes potentials for variety of other electrodes are listed in table.

Current flow from electrode to electrolyte :
Oxidation (Loss of e^-)
Current flow from electrolyte to electrode :
Reduction (Gain of e^-)

Electrode Theory

- When the ionic movement occurs and the new potential developed at the membrane, the value of that potential can be found out by Nernst Equation.

$$E = -\frac{RT}{nF}\ln\frac{C_1 f_1}{C_2 f_2}$$

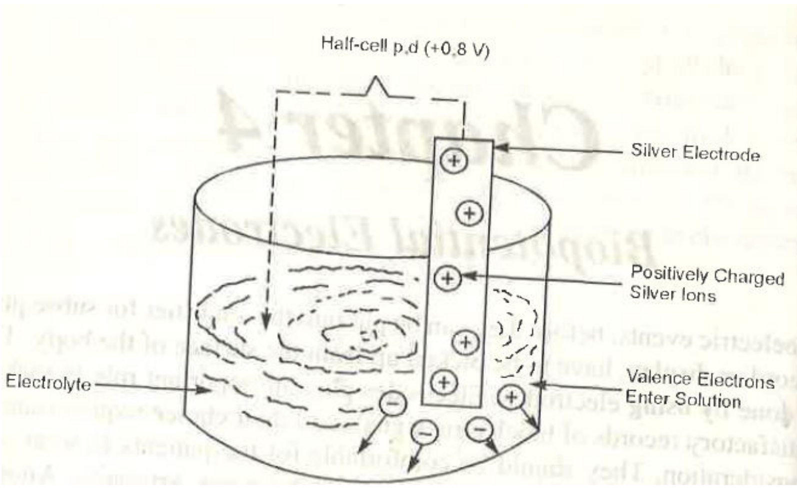
- Where R=gas constant
- T = absolute temperature, degrees kelvin
- n=valence of the ion
- F=Faraday constant
- C1,C2 = two concentrations of the ion on the two sides of the membrane

Electrode Theory

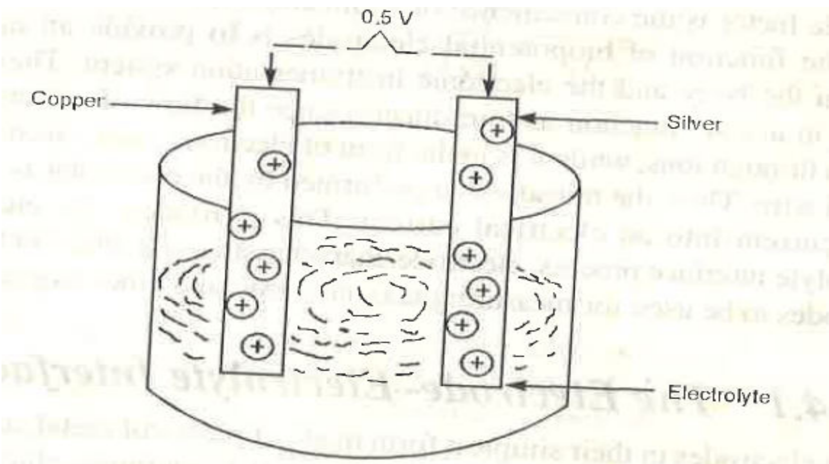
- f1,f2=respective activity coefficients of the ion on the two sides of the membrane
- This above f1 and f2 are depend on such factors as the charges of all ions in the solution and the distance between ions.
- The product of C1f1 of concentration and its associated activity coefficient is called the activity of the ion responsible for the electrode potential.
- The metal-electrolyte interface developed and the potential generated.

Metal-Electrolyte Interface

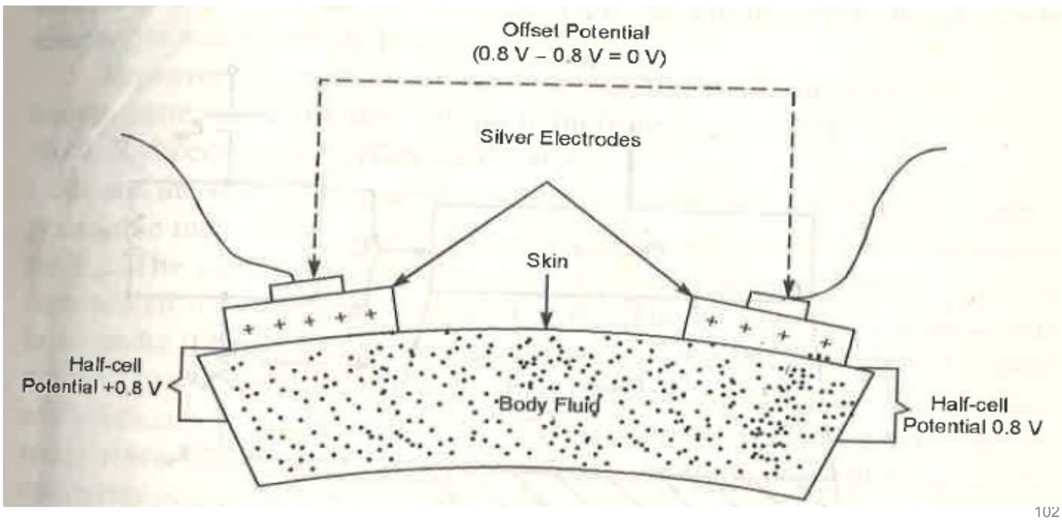
- Silver Electrode Half-cell potential



Terminal Voltage between Silver and Copper Electrodes Half-cell potential



Two Silver plates used as biopotential electrodes on the surface of the skin



Biopotential electrodes

- Basically three types.
- 1. **Microelectrodes:** Electrodes used to measure bioelectric potentials near or within a single cell.
- **Skin surface electrodes:** Electrodes used to measure ECG, EEG, and EMG potentials from the surface of the skin.
- **Needle electrodes:** Electrodes used to penetrate the skin to record EEG potentials from a local region of the brain or EMG potentials from a specific group of muscles.
- The equivalent circuit of the electrode in upcoming figure.

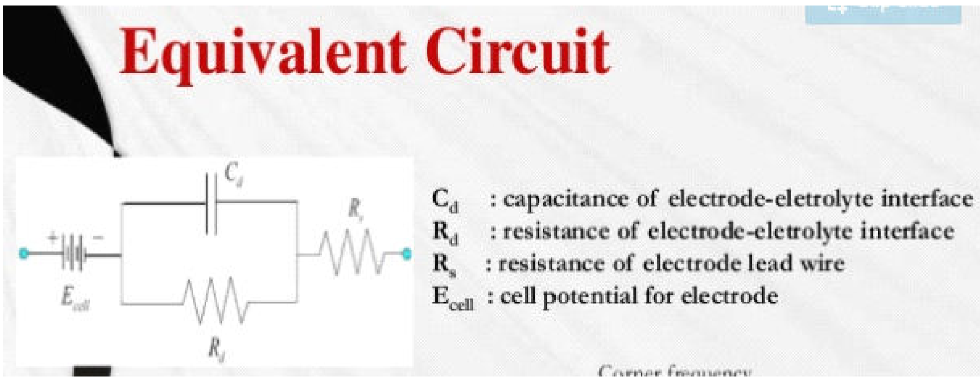
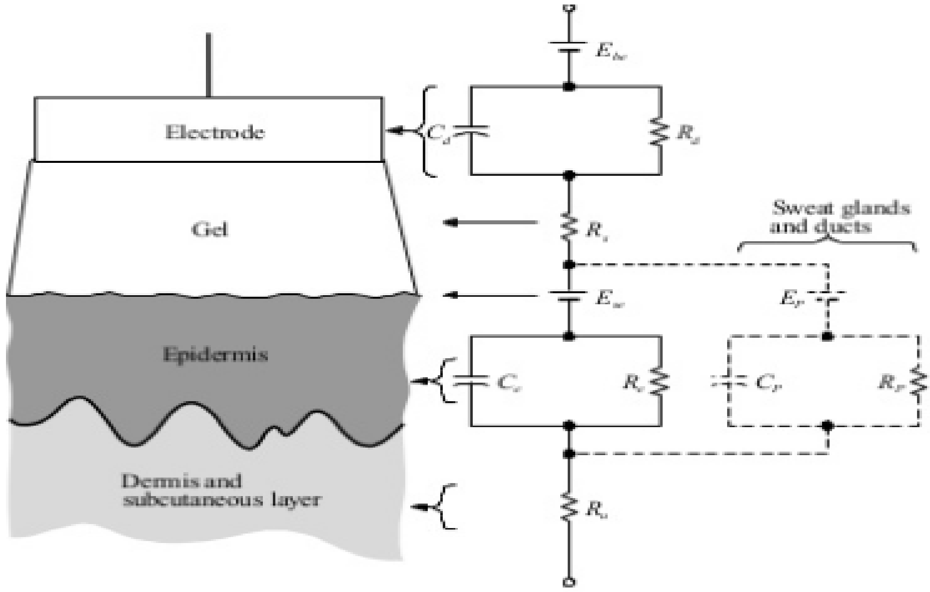


Figure 4.1. Equivalent circuit of biopotential electrode interface.

The Electrode-Skin Interface



Biopotential electrodes

- Two electrodes are require to do measurements.
- If the same type of electrodes are used, the potential difference is usually small and depends on the actual difference of ionic potential between the two points of the body.
- If the electrodes are different, the dc voltage generated which is nothing but a electrode offset voltage. Which can cause an error in the measurement.
- Some dc also produce in the same type of electrodes we use.
- To reduce that error by choice of materials, or by special treatment, such as coating the electrodes by some……contd

Biopotential electrodes

- ….contd….electrolytic method to improve stability.
- E.g : silver silver chloride electrode is very stable prepared by electrolytically coating a piece of pure silver with silver chloride.
- We can see the equivalent diagram of the use of two electrodes for the biopotential measurements.
- In that the impedance is varies according to the polarization which is a result of direct current passing through the metal electrolyte interface.
- Size and type of electrodes also affects the impedance . Higher the size lower impedance. E.g surface electrodes….have 2 to 10 kohm, where as small needle electrodes have much larger value.

Biopotential electrodes

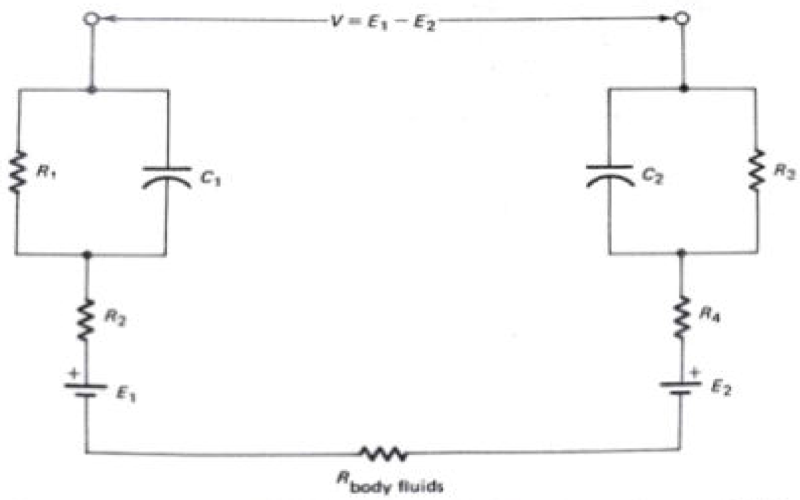


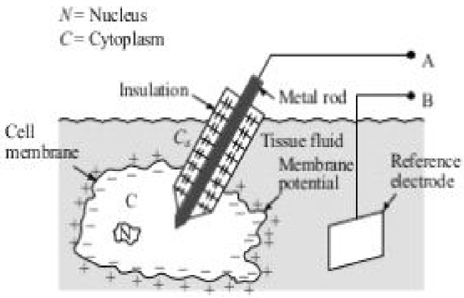
Figure 4.2. Measurement of biopotentials with two electrodes—equivalent

Biopotential electrodes

- Electrodes with tips sufficiently small to penetrate a single cell in order to obtain readings from within the cell.
- Basically two types: 1. Metal , 2. Micropipet.
- Metal type are formed by electrolytically etching the tip of a fine tungsten or stainless steel wire to the desired size. Then wire is coated with the an insulating material.
- Micropipet as shown in upcoming diagram.
- The problem with such electrodes is that high impedance and for that amplifier with very high impedance required.

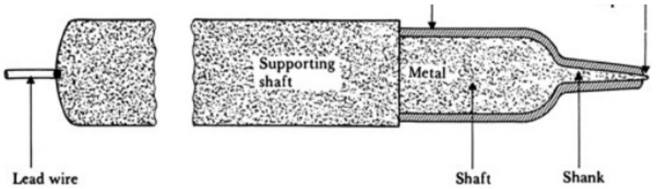
Microelectrodes

Used in studying the electrophysiology of excitable cells by measure potential differences across the cell membrane.



Electrode need to be small and strong to penetrate the cell membrane without damaging the cell.
Tip diameters = 0.05 to 10 µm

The structure of a metal microelectrode for intracellular recordings.



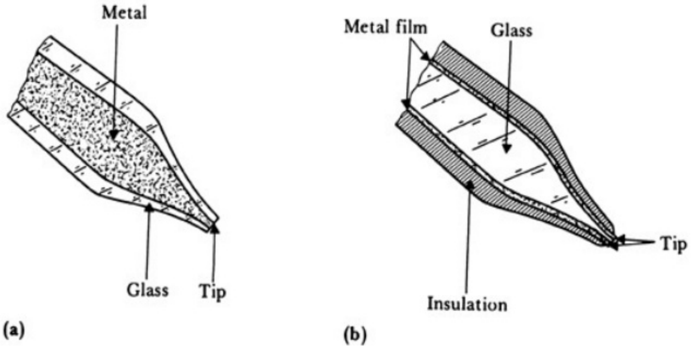
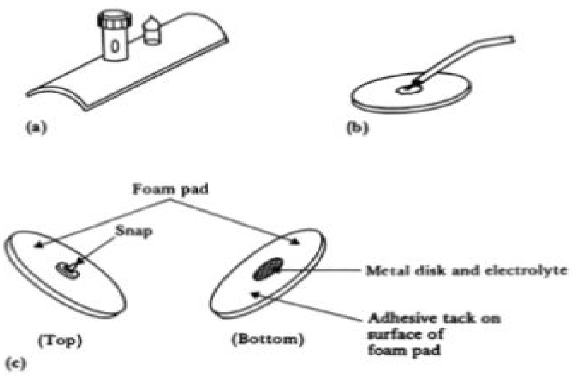


Figure 5.18 Structures of two supported metal microelectrodes (a) Metal-filled glass micropipet. (b) Glass micropipet or probe, coated with metal film.

Biopotential electrodes

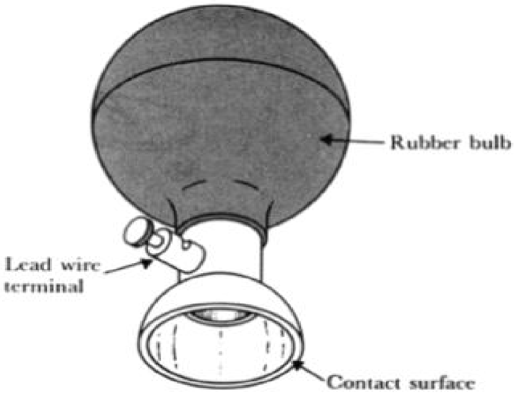
Metal-Plate Electrodes



Body-surface biopotential electrodes (a) Metal-plate electrode used for application to limbs. (b) Metal-disk electrode applied with surgical tape. (c) Disposable foam-pad electrodes, often used with electrocardiograph monitoring apparatus.

Body Surface electrode

Suction Electrodes

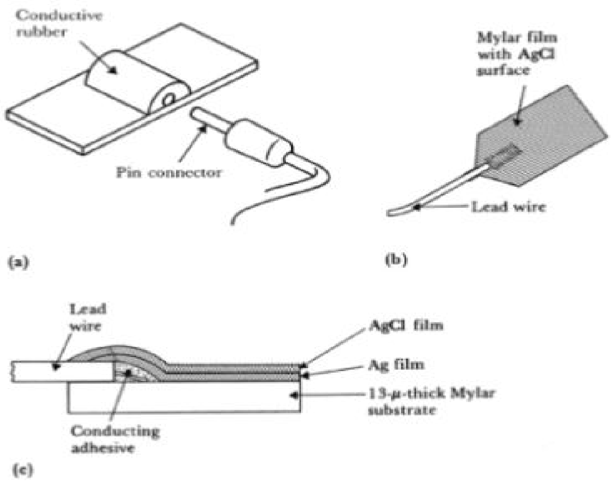


A metallic suction electrode is often used as a precordial electrode on clinical electrocardiographs. **No need for strap or adhesive** and can be **used frequently**. **Higher source impedance** since the contact area is small

Body-Surface Recording Electrode

Flexible Electrodes

Flexible body-surface electrodes (a) Carbon-filled silicone rubber electrode. (b) Flexible thin-film neonatal electrode.
(c) Cross-sectional view of the thin-film electrode in (b).



Used for **newborn infants**.

Electrolyte hydrogel material is used to hold electrodes to the skin.

Biopotential electrodes

- One difficulty in using plate electrodes is that possibility of electrode slippage or movement.
- This also occurs with the suction cup electrode after a sufficient length of time. Number of attempts were made to overcome this problem.
- All the preceding electrodes suffer from a common problem. They are sensitive to movement, some to a greater degree than others.
- The adhesive tape and "nutmeg grater" electrodes reduce this movement artifact by limiting electrode movement and reducing the interface impedance, but neither is satisfactory insensitive to movement.

Biopotential electrodes

- A new type of electrode, the floating electrode, was introduced in varying forms by several manufacturers. This principle of this electrode is to practically eliminate movement artifact by avoiding any direct contact of the metal with the skin.
- The only conductive path between metal and skin is the electrolyte paste or jelly.
- Floating electrodes are generally attached to the skin by means of two sided adhesive rings.
- ECG measurement for long time can make some problem.

Body-Surface Recording Electrode

Floating Electrodes

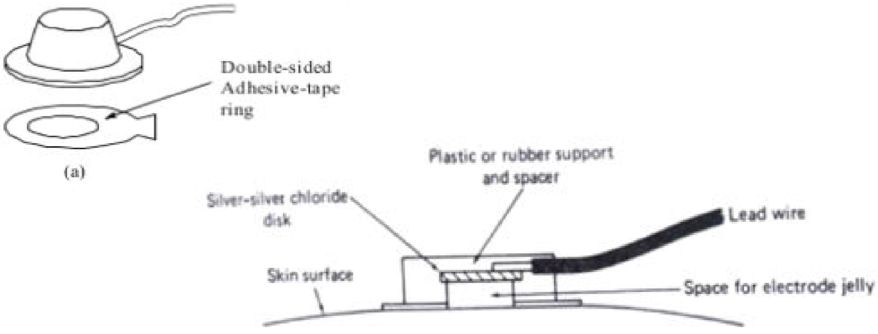


Figure 4.7. Diagram of floating type skin surface electrode.

The recess in this electrode is formed from an open foam disk, saturated with electrolyte gel and placed over the metal electrode. **Minimize motion artifact**

Biopotential electrodes

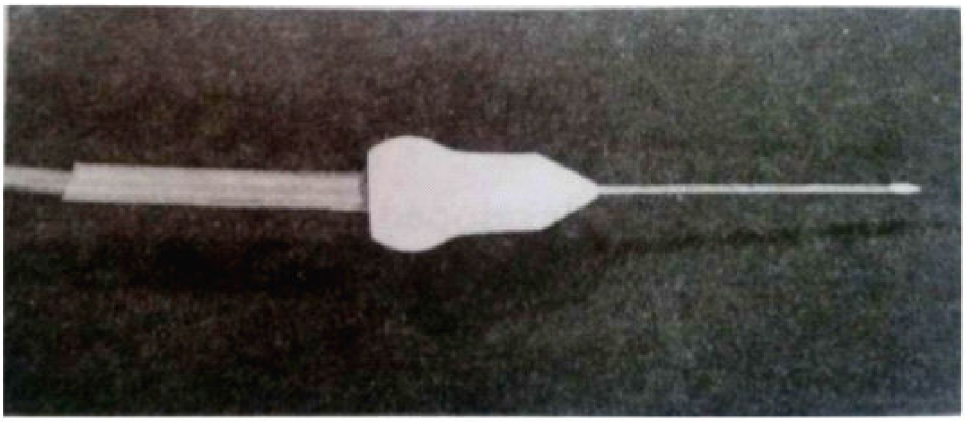
- Various types of disposable electrodes have been introduced in recent years to eliminate the requirement of cleaning and care after each use.
- Special types of have been developed for other applications. For example, a special ear-clip electrode was developed for use as a reference electrode for EEG measurements.
- Scalp surface electrodes for EEG are usually small disks about 7 mm in diameter or small solder pellets that are placed on the cleaned scalp, using an electrolyte paste.

Biopotential electrodes

- To reduce interface impedance and, consequently, movement artifacts, some electroencephalographers use smalls subdermal needles to penetrate the scalp for EEG measurements. (For measuring brain activity)
- In animal research longer needles are actually inserted into the brain to obtain localized measurement of potentials from a specific part of the brain.
- Sometimes a special instrument, called stereotaxic instrument, is used to hold the animal's head and guide the placement of electrodes.

Biopotential electrodes

Needle electrode



Biopotential electrodes

- Needle electrodes for EMG consist merely of fine insulated wires, placed so that their tips are in contact with the nerve muscle. Or other tissue from which the measurement is made.
- Wire electrodes of copper or platinum are often used for EMG pickup from specific muscles.
- A single wire inside the needle serves as a unipolar electrode, If a two wire placed inside the needle, the measurement is called bipolar and provide a very localized measurement between the two wire tips.

TABLE 48.1 Bioelectric Signals Sensed by Biopotential Electrodes and Their Sources

Bioelectric Signal	Abbreviation	Biologic Source
Electrocardiogram	ECG	Heart—as seen from body surface
Cardiac electrogram	—	Heart—as seen from within
Electromyogram	EMG	Muscle
Electroencephalogram	EEG	Brain
Electrooptigram	EOG	Eye dipole field
Electroretinogram	ERG	Eye retina
Action potential	—	Nerve or muscle
Electrogastrogram	EGG	Stomach
Galvanic skin reflex	GSR	Skin

The Nervous System

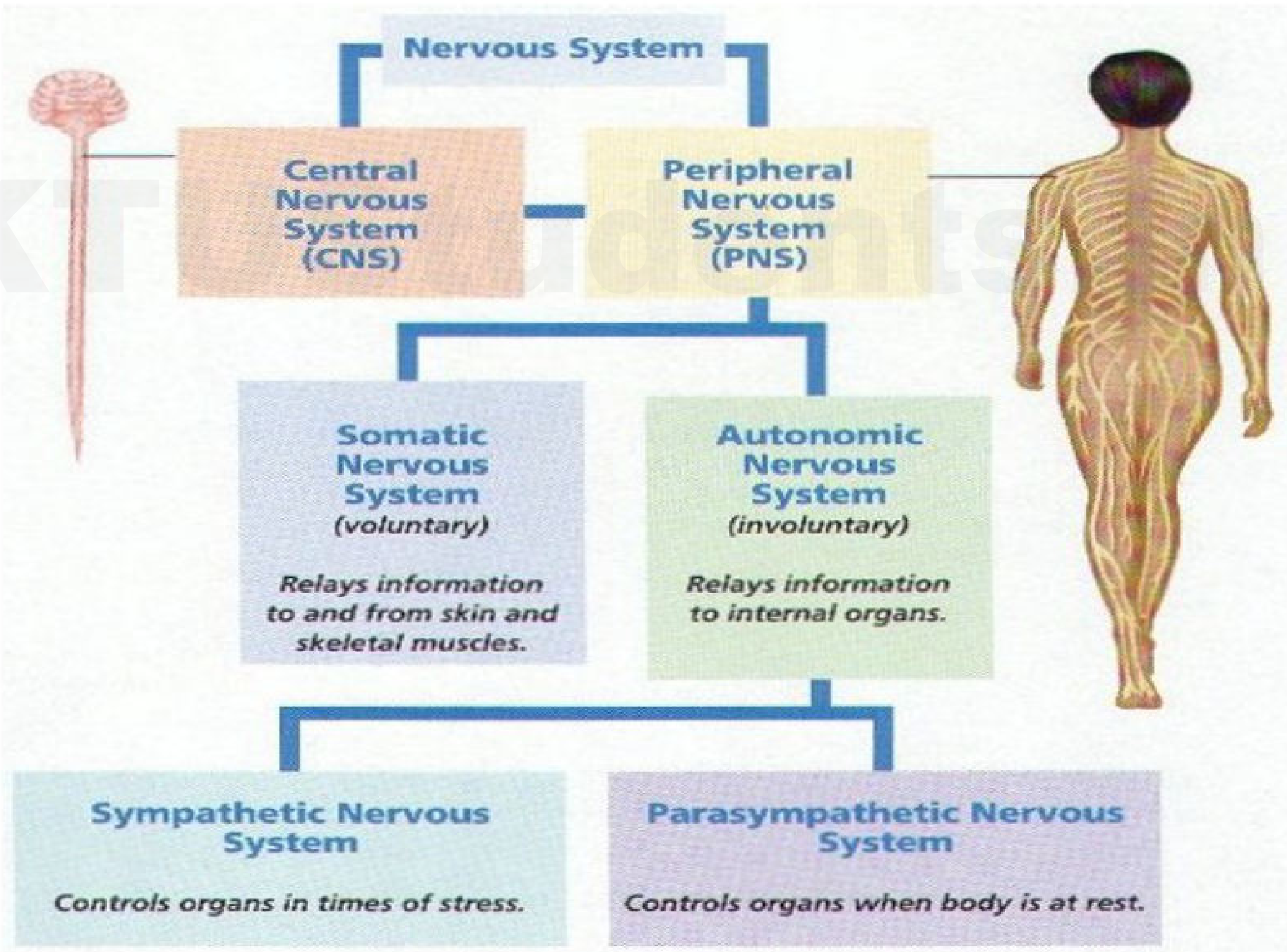
Functions of the Nervous System

1. Gathers information from both inside and outside the body - Sensory Function
2. Transmits information to the processing areas of the brain and spine
3. Processes the information in the brain and spine – Integration Function
4. Sends information to the muscles, glands, and organs so they can respond appropriately – Motor Function

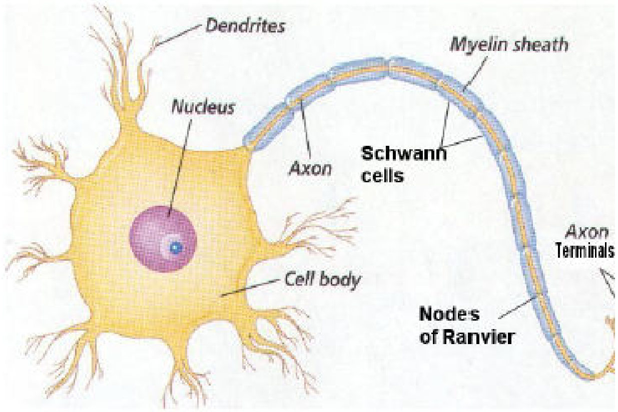
It controls and coordinates all essential functions of the body including all other body systems allowing the body to maintain homeostasis or its delicate balance.

The Nervous System is divided into **Two Main Divisions**: **Central Nervous System (CNS)** and the **Peripheral Nervous System (PNS)**

Divisions of the Nervous System



Basic Cells of the Nervous System

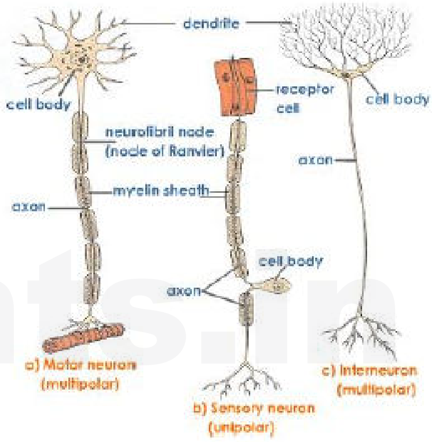


Neuron

- Basic functional cell of nervous system
- Transmits impulses (up to 250 mph)

Parts of a Neuron

- **Dendrite** – receive stimulus and carries it impulses toward the cell body
- **Cell Body** with nucleus – nucleus & most of cytoplasm
- **Axon** – fiber which carries impulses away from cell body
- **Schwann Cells-** cells which produce myelin or fat layer in the Peripheral Nervous System
- **Myelin sheath** – dense lipid layer which insulates the axon – makes the axon look gray
- **Node of Ranvier** – gaps or nodes in the myelin sheath
- Impulses travel **from dendrite to cell body to axon**



Three types of Neurons

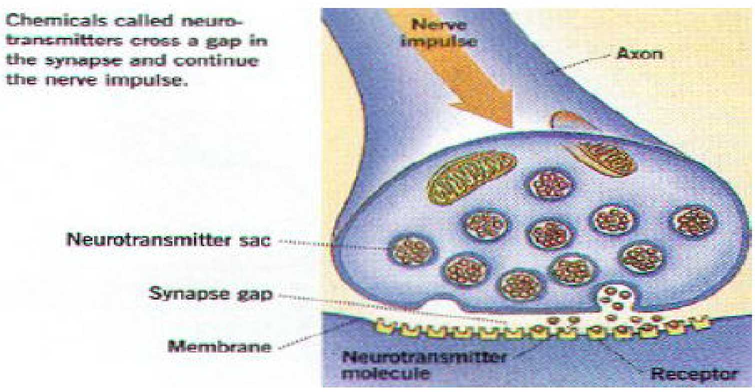
- **Sensory neurons** – bring messages to CNS
- **Motor neurons** - carry messages from CNS
- **Interneurons** – between sensory & motor neurons in the CNS

Impulses

- A **stimulus** is a change in the environment with sufficient strength to initiate a response.
- **Excitability** is the ability of a neuron to respond to the stimulus and convert it into a nerve impulse
- **All of Nothing Rule** – The stimulus is either strong enough to start and impulse or nothing happens
- Impulses are always the **same strength along a given neuron** and they are **self-propagation** – once it starts it continues to the end of the neuron in only one direction- **from dendrite to cell body to axon**
- The nerve impulse causes a movement of ions across the cell membrane of the nerve cell.

Synapse

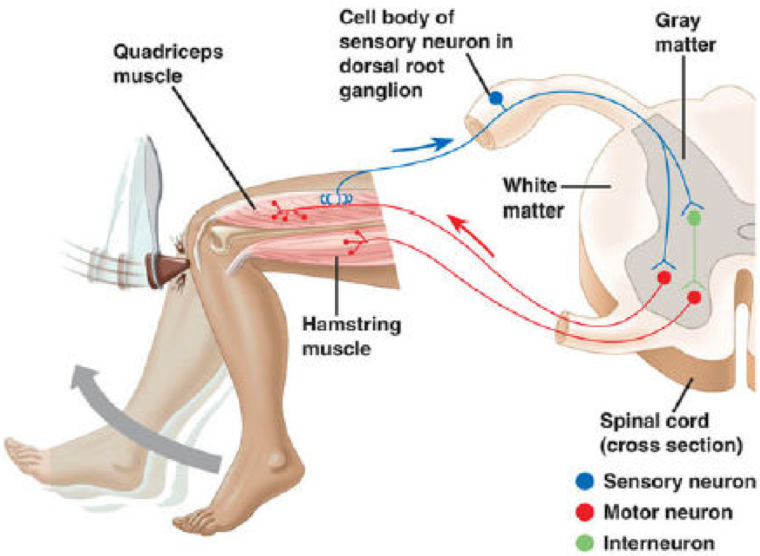
- **Synapse** - small gap or space between the axon of one neuron and the dendrite of another - **the neurons do not actually tough at the synapse**
- It is junction between neurons which uses neurotransmitters to start the impulse in the second neuron or an effector (muscle or gland)
- The synapse insures one-way transmission of impulses



Neurotransmitters

Neurotransmitters – Chemicals in the junction which allow impulses to be started in the second neuron

Reflex Arc



omponents of a Reflex Arc

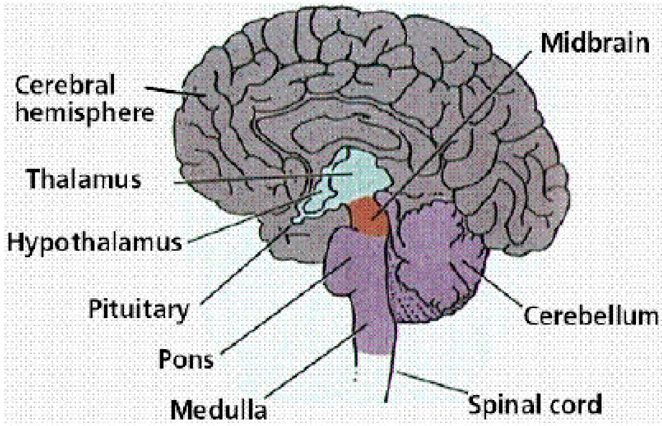
. **Receptor -** reacts to a stimulus
. **Afferent pathway (sensory neuron) -** conducts impulses to the CNS
. **Interneuron -** consists of one or more synapses in the CNS (most are in the spine)
. **Efferent pathway (motor neuron)** conducts impulses from CNS to effector.
. **Effector -** muscle fibers (as in the Hamstring muscle) or glands responds by contracting or secreting a product.

pinal reflexes - initiated and completed at the spinal cord level. Occur without the involvement of higher :nters.

Central Nervous System

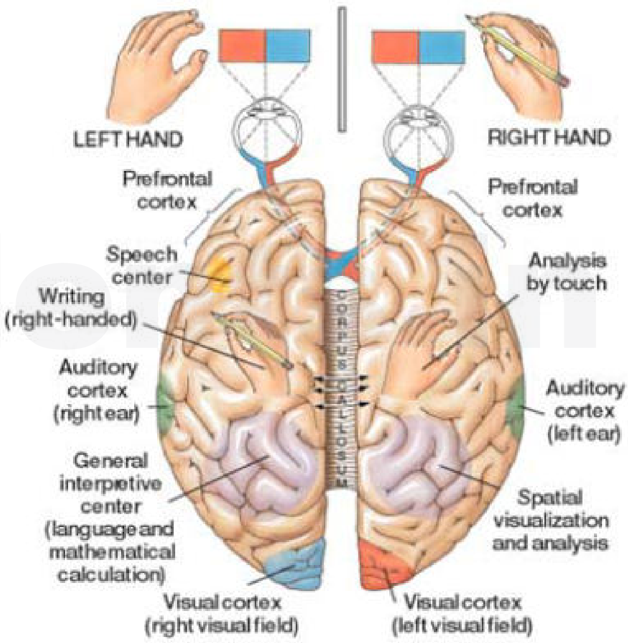
- Brain
    - Brain stem – medulla, pons, midbrain
    - Diencephalon – thalamus & hypothalamus
    - Cerebellem
    - Cerebrum
- Spine
    - Spinal Cord

Regions of the Brain



Cerebellum – coordination of movement and aspects of motor learning
Cerebrum – conscious activity including perception, emotion, thought, and planning
Thalamus – Brain's switchboard – filters and then relays information to various brain regions
Medulla – vital reflexes as heart beat and respiration
Brainstem – medulla, pons, and midbrain (involuntary responses) and relays information from spine to upper brain
Hypothalamus– involved in regulating activities internal organs, monitoring information from the autonomic nervous system, controlling the pituitary gland and its hormones, and regulating sleep and appetite

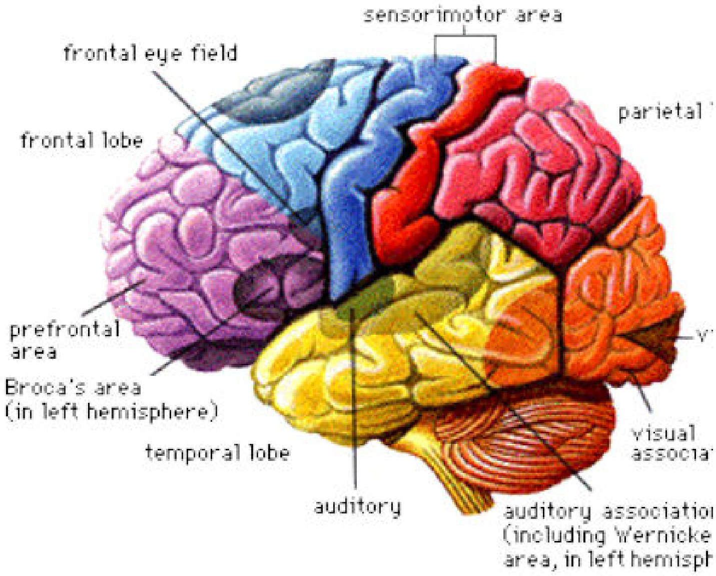
Cerebrum



- Is the largest portion of the brain encompasses about two-thirds of the brain mass -
- It consists of two hemispheres divided by a fissure – corpus callosum
- It includes the cerebral cortex, the medullary body, and basal ganglia
- **cerebral cortex** is the layer of the brain often referred to as gray matter because it has cell bodies and synapses but no myelin
  - The cortex (thin layer of tissue) is gray because nerves in this area lack the insulation or white fatty myelin sheath that makes most other parts of the brain appear to be white.
  - The cortex covers the outer portion (1.5mm to 5mm) of the cerebrum and cerebellum
  - The cortex consists of folded bulges called **gyri** that create deep furrows or fissures called **sulci**
  - The folds in the brain add to its surface area which increases the amount of gray matter and the quantity of information that can be processed
- **Medullary body** – is the white matter of the cerebrum and consists of myelinated axons
  - Commisural fibers – conduct impulses between the hemispheres and form corpus callosum
  - Projection fibers – conduct impulse in and out of the cerebral hemispheres
  - Association fibers – conduct impulses within the hemispheres
- **Basal ganglia** – masses of gray matter in each hemisphere which are involved in the control of voluntary muscle movements

Lobes of the Cerebrum

- **Frontal** – motor area involved in movement and in planning & coordinating behavior
- **Parietal** – sensory processing, attention, and language
- **Temporal** – auditory perception, speech, and complex visual perceptions
- **Occipital** – visual center – plays a role in processing visual information



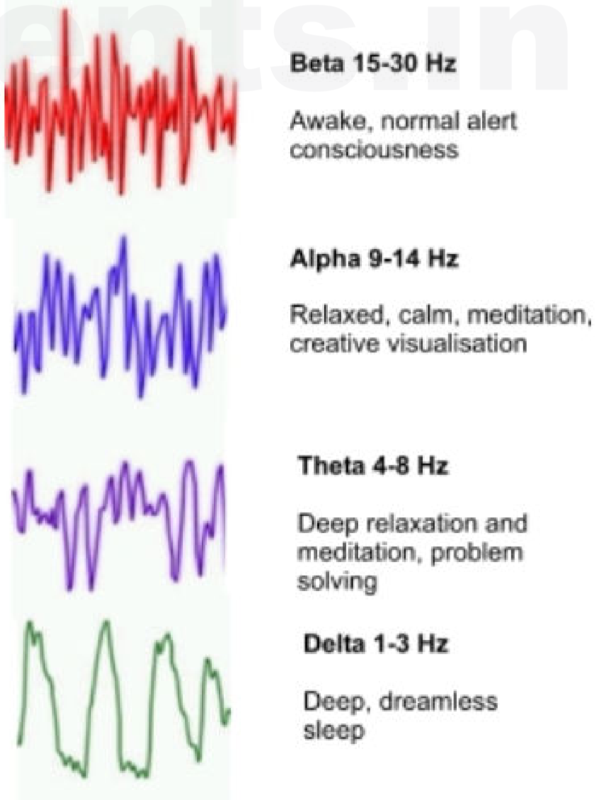
Special regions

- **Broca's area** – located in the frontal lobe – important in the production of speech
- **Wernicke's area** – comprehension of language and the production of meaningful speech
- **Limbic System** – a group of brain structures (aamygdala, hippocampus, septum, basal ganglia, and others) that help regulate the expression of emotions and emotional memory

in Waves

in waves are rhythmic fluctuation of electric potential een parts of the brain as seen on an **troencephalogram** (EEG).

- To measure brain waves electrodes are placed onto the scalp using the EEG.
- There are four types of brainwaves:
  - Beta
  - Alpha
  - Theta
  - Delta



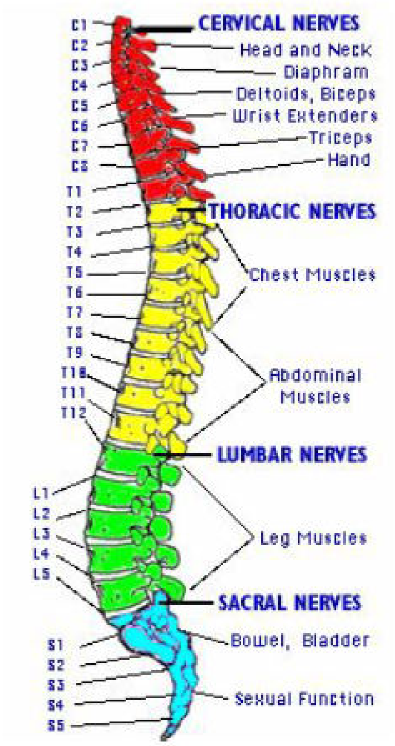
- **<u>Peripheral Nervous System</u>**

Cranial nerves

- 12 pair
- Attached to undersurface of brain

Spinal nerves

- 31 pair
- Attached to spinal cord



<u>Somatic Nervous System (voluntary)</u>

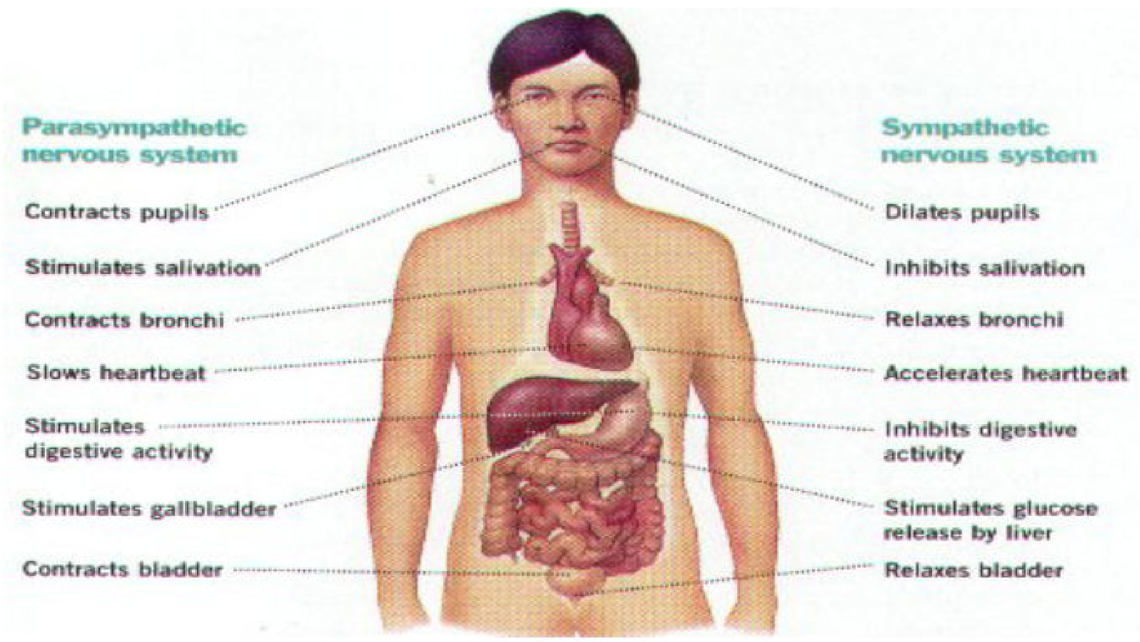
- Relays information from skin, sense organs & muscles to CNS
- Brings responses back to skeletal muscles for responses

skeletal

voluntary

<u>Autonomic Nervous System (involuntary)</u>

- Regulates bodies involuntary responses
- Relays information to internal organs
- Two divisions
  - Sympathetic nervous system – in times of stress
    - Emergency response
    - Fight or flight
  - Parasympathetic nervous system – when body is at rest or with normal functions
    - Normal everyday conditions

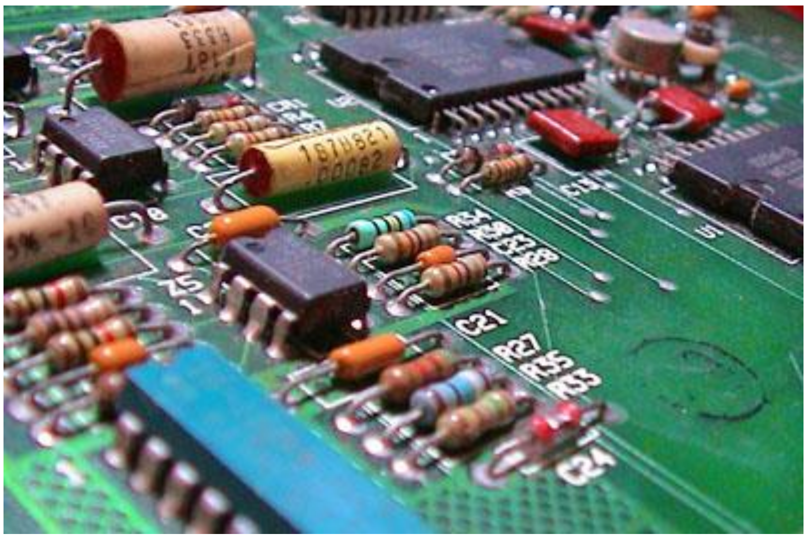


EST130 - BASICS OF ELECTRONICS ENGG

MODULE 4

Evolution of electronics

The word 'electronics' is derived from electron mechanics, which means the study of the behavior of an electron under different conditions of externally applied fields. The Institution of Radio Engineers (IRE) has given a standard definition of electronics as "that field of science and engineering, which deals with electron devices and their utilization."



Applications of electronics

Electronics play a major role in almost every sphere of our life. The main applications of electronics are as follows.

Communication and Entertainment In communication,

the main application of electronics was in the field of telegraphy and telephony. This utilizes a pair of wires. However, it is now possible with the help of radio waves to transmit any message from one place to another, thousands of kilometers away, without any wires. With such wireless communication (radio broadcasting), people in any part of the world can know what is happening in other parts. Radio and TV broadcasting provide a means of both communication as well as entertainment. With the help of satellites it has become possible to establish instant communication between places very far apart.

Defense Applications

One of the most important developments during World War II was the RADAR. By using radar it is possible to detect and find the exact location of the enemy aircraft.The antiaircraft guns directed to shoot down the aircraft. The radar and antiaircraft guns can be linked by an automatic control system to make a complete unit.

Guided missiles are completely controlled by electronic circuits. In a war, success or defeat for the nation depends on the reliability of its communication system.

Industrial Applications

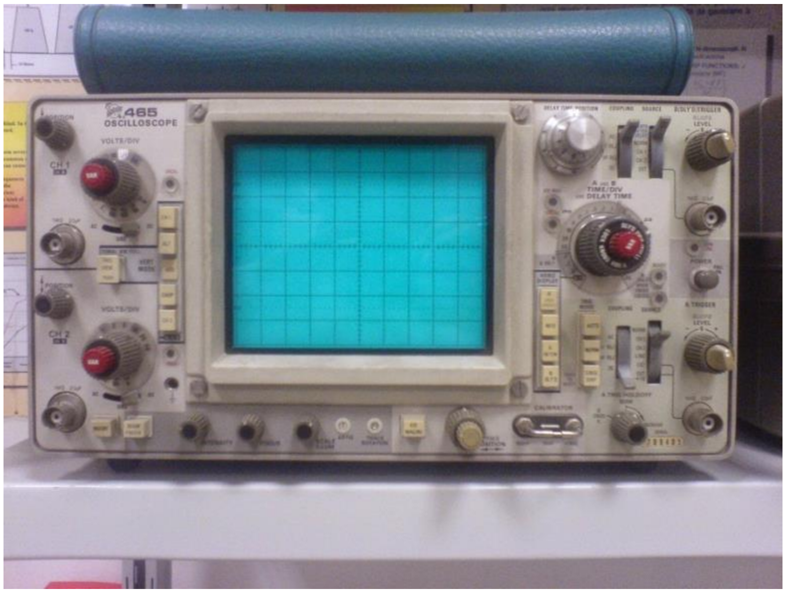
Use of automatic control systems in industries is increasing day by day. Electronic circuits are used in industrial applications like control of thickness, quality, weight and moisture content of a material. It is also used in automatic dooropeners, lightning systems, power systems and safety devices.

Medical Sciences

Doctors and scientists are constantly finding new uses for electronic systems in the diagnosis and treatment of various diseases. Some of the instruments which have been in use are: Xrays, for taking pictures of internal bone structures and also treatment of some diseases Electrocardiographs (ECG), to find the condition of the heart of a patient. Short-wave diathermy units, for healing sprains and fractures. Oscillographs for studying muscle action.

Instrumentation

Instrumentation plays a very important role in any industry and research organization,for precise measurement of various quantities. e,g. VTVM, CRO, frequency counters, pH-meters,straingauges,etc



CRO

Integrated circuit

An integrated circuit or monolithic integrated circuit (also referred to as an IC, a chip, or a microchip) is a set of electronic circuits on one small flat piece (or "chip") of semiconductor material that is normally silicon. The integration of large numbers of tiny MOS transistors into a small chip results in circuits that are orders of magnitude smaller, faster, and less expensive than those constructed of discrete electronic components.

Integrated circuits were made practical by technological advancements in metal–oxide–silicon (MOS) semiconductor device fabrication. Since their origins in the 1960s, the size, speed, and capacity of chips have progressed enormously, driven by technical advances that fit more and more MOS transistors on chips of the same size – a modern chip may have many billions of MOS transistors in an area the size of a human fingernail. These advances, roughly following Moore's law, make computer chips of today possess millions of times the capacity and thousands of times the speed of the computer chips of the early 1970s.

In the early days of simple integrated circuits, the technology's large scale limited each chip to only a few transistors, and the low degree of integration meant the design process was relatively simple. Manufacturing yields were also quite low by today's standards. As the technology progressed, millions, then billions of transistors could be placed on one chip, and good designs required thorough planning, giving rise to the field of electronic design automation, or EDA.

Scale	Components Count	Year
SSI (Small Scale Integration)	< 100	1963
MSI (Medium Scale Integration)	100-1000	1970
LSI (Large Scale Integration)	1000-10000	1975
VLSI (Very Large Scale Integration)	$10000 - 10^9$	1980
ULSI (Ultra Large Scale Integration)	$> 10^6$	1990
GSI (Giga Scale Integration)	$> 10^{10}$	2010

Electronic Components

The main components used in electronics are of two general types: passive and active.

(i) Active components

Components required to be powered in some way to make them work i.e. rely on a source of energy

Examples: Active components include amplifying components such as Vacuum Tubes, Transistors, Integrated Circuits, etc

(ii) Passive components

Doesn't rely on a source of power.

Examples: Passive components include components such as resistors, capacitors, and inductors.

Resistor

Resistors decrease the intensity of the electric current flowing through a circuit. Resistors do not block electricity. Instead, they convert a percentage of the electric current into heat energy, which is transmitted into an area around the device.

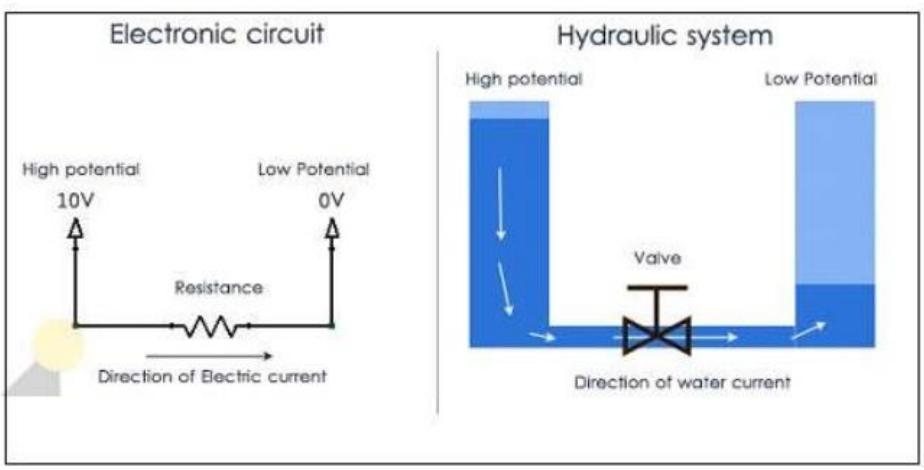
Resistance: The ability of the material to oppose current.

The amount of electric current absorbed by a resistor is called "resistance," and is measured in "ohm" units

Ohm: an ohm is defined as the electrical resistance between two points of a conductor when a constant potential difference applied between these points produces a current of one ampere

$R = V / I$

A simple analogy with a hydraulic system. Notice that the flow of electricity resembles the flow of water from a point of high potential energy (high voltage) to a point of low potential energy (low voltage). In this simple analogy water is compared to electrical current, the voltage Difference is compared to the head difference between two water reservoirs, and finally the valve resisting the flow of water is compared to the resistor limiting the flow of current.



There won't be any flow of current between 2 points if there is no potential difference between them. In other words, for a flow of current to exist, there must be a voltage difference between two points.

The electric current in a conductor will increase with the decrease of the resistance, exactly as the rate of flow of water will increase with the decrease of the resistance of the valve.

A lot more deductions are based on this simple analogy, but those rules are summarized in the most fundamental equations of electronics: Ohm's law.

Ohm's law states that, at constant temperature the current through a conductor between two points is directly proportional to the potential difference or voltage across the two points, and inversely proportional to the resistance between them.

The mathematical equation that describes this relationship is: $R = V / I$

Where

I is the current through the conductor in unit of ampere,

V is the potential difference measured across the conductor in unit of volt,

R is the resistance of the conductor in unit of ohm.

Fixed value Resistors

The value of resistance remains constant and cannot be varied by the user

The major types of fixed resistors are

(i) Carbon composition resistor

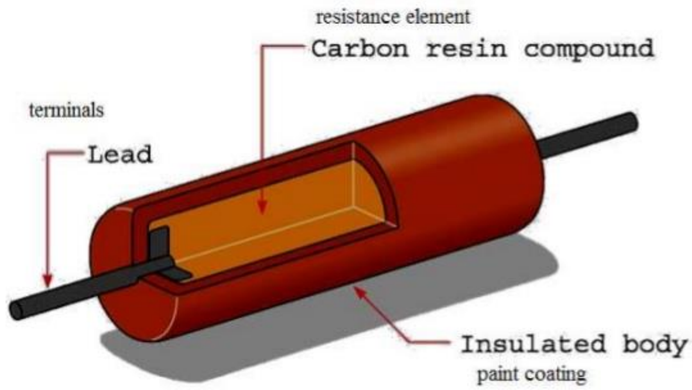
(ii) wire wound resistor

(iii) Carbon film resistor

(iv) Metal film resistor

Choice of resistor for a desired application depends upon the **value of resistance, size, shape, leads, power rating, tolerance, maximum operating voltage ,etc**.

CARBON COMPOSITION RESISTOR



Resistance element: mixture of powdered carbon and powdered insulator.

The resistance element are solidified by a bonding compound and the mixture is extruded into desired shape and size by forcing it through a die.

The process is achieved by sintering in the presence of hydrogen or nitrogen at 1400ºC.

Specifications:

Resistance range:	2Ω to20MΩ
Tolerance:	5% to 10%
Power rating:	0.125W to 2W
Operating Voltage:	125V to 800V
Operating temperature:	-55ºC to150ºC
Uses:	General purpose electronic instruments

Wire-wound resistors

Wire-wound resistors are fixed resistors that are made by winding a piece of resistive wire around a cylindrical ceramic core. These are used when a high power rating is required.

The wire is preferred according to its resistivity.

The required resistance can be achieved by varying the thickness and length of the resistive wire during winding process.

The resistive wire has to be tightly wound to the ceramic substrate.

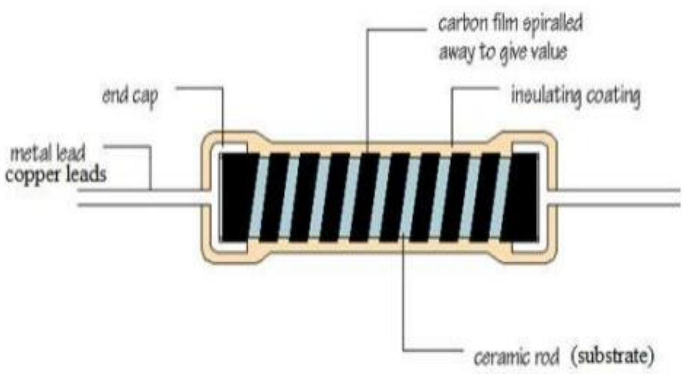
The entire setup is covered by an enamel to prevent it from moisture.

Specifications:

Resistance range:	0.1Ω to1MΩ
Tolerance:	0.1% to 5%
Power rating:	10W to 75W
Operating Voltage:	<150V
Operating temperature:	55ºC to375ºC

Applications: Low resistance, low noise, higher power handling capacity in small size.

Carbon film resistor



➢A thin film of pure carbon is deposited onto a small ceramic rod(substrate) by thermal decomposition at 1000ºC.

➢ The resistive coating is spiralled away in an automatic machine until the resistance between the two ends of the rod is as close as possible to the correct value.

➢Metal leads and end caps are added, the resistor is covered with an insulating coating and finally painted with coloured bands to indicate the resistor value.

Specifications:

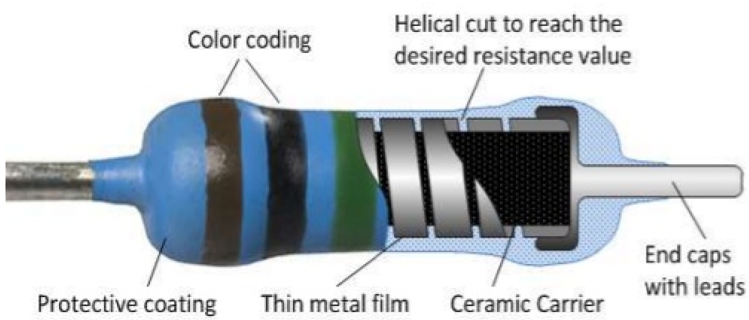
Resistance range:	1Ω to10MΩ
Tolerance:	1% to 5%
Power rating:	5W
Operating Voltage:	500V

Applications: used in measuring instruments where close tolerances are required.

Carbon film resistors posses better stability than carbon composition resistors, but are of relatively larger size compared to carbon composition resistors . Carbon film resistors cannot withstand electric overloads.

Metal film resistor

Metal film resistors are axial resistors with a thin metal film(Ni) as resistive element. The thin film is deposited on usually a ceramic body(substrate).



Specifications:

Resistance range:	0.5Ω to10KΩ
Tolerance:	2% to 3%
Power rating:	5W
Operating Voltage:	300V
Working temperature:	-40 to 150ºC

Stable, reliable and capable of handling overload for short time.

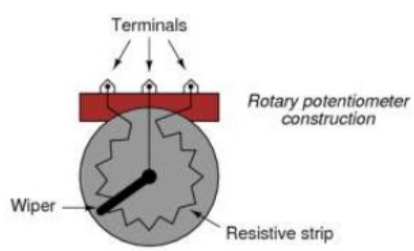
Applications: electronic instruments.

Variable resistors

Variable resistors can change their value over a specific range. A potentiometer is a variable resistor with three terminals. A rheostat has only two terminals.

A potentiometer is a three terminal variable resistor used to divide voltage

A rheostat is a variable resistor used to control current



Potentiometers work on the principle that longer lengths of resistance material have greater resistance.

The closer the wiper is to the end terminal it is connected to, the less resistance there is. This is because the current will not have to travel as far. The further away the wiper moves from the terminal it is wired with, the greater the resistance will be.

Potentiometers usually have three connecting points. Two are connected to the ends of the resistance material and the third is connected to the central sliding contact. The slider can either slide in a straight line or around a curve

Types of variable resistors

(i) Carbon composition potentiometer
(ii) Wire wound resistor
(iii) Wire wound solenoid
(iv) Helical wound POT

Characteristics of Variable resistor:

(i) resistance law: relation between change in R and movement of wiper
(ii) Tolerance
(iii) Insulation resistance(high)
(iv) Speed of operation
(v) Life time
(vi) Ruggedness

CARBON COMPOSITION POTENTIOMETER(POT)

(i) Coated film Carbon composition potentiometer

Resistance element: mixture of carbon, silica and binder

Substrate: ring shaped insulating material

End terminals: brass or phosphor bronze

The resistance element is coated on the ring shaped insulating material.

Applications: Preset POT in T.V brightness and contrast control, radio and measuring instruments.

Specifications:

Range:100 to $10^7\,\Omega$;

power :0.5W to 2.25W;

tolerance: 20% for 1 to $10^6\,\Omega$

30% for> $10^6\,\Omega$

(ii) Moulded type Carbon composition potentiometer: the resistance material is moulded into a cavity in a plastic base(substrate).

Wiper(moving contact): carbon brush.

ON& OFF switch can be incorporated in this type of POT

Applications: Computers, Industrial and defence . Also used in HF applications as associated inductive and capacitive effects are low.

Wire wound Solenoid

Resistance element: oxidised form of Nickel, copper

Former: ceramic or steel in hexagonal or circular shape

Brush: copper or graphite.

Resistance element is wound on the former.

Range:500 to 10KΩ.

Current :0.1 to 20A

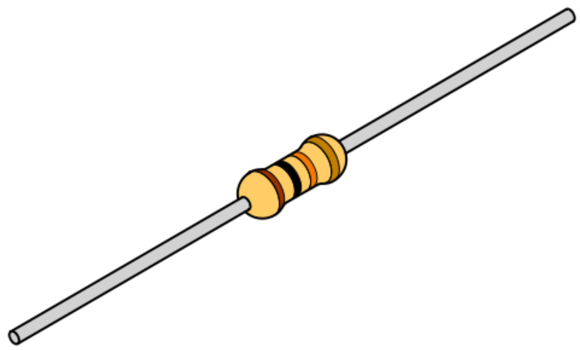
Helical wound variable resistor

Resistance element is wound on the helical former .

Range: 1 to 125K Ω.

tolerance: 2%

Power rating: 100W to 200W



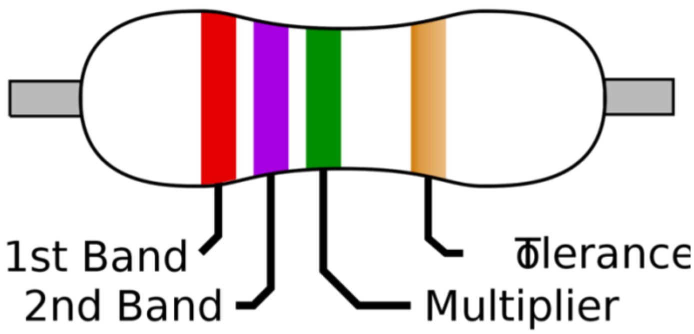
RESISTOR

RESITOR SYMBOL

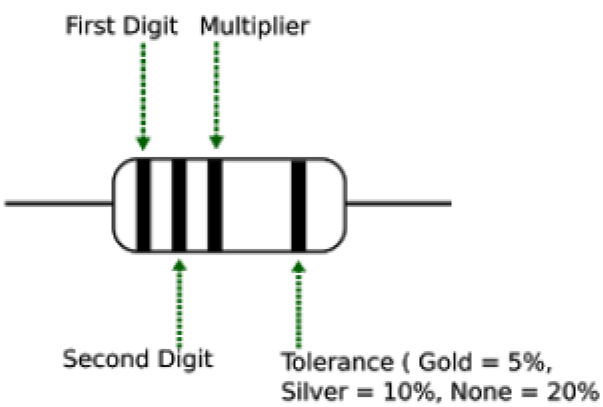
A resistor is a passive electronic component that offers a specific amount of electrical resistance to the flow of current when connected in a circuit. Unit of resistance is ohm (Symbol Ω). Ohm is a very small unit. Most practical resistors have resistance in thousands or hundred of thousands of ohm. Therefore resistance is often measured in kilo and megaohms.

Color coding of resistors

Carbon resistors are color coded. Carbon resistors are very small size, it is difficult to write the ohmic values as numbers so color coding is used. Each color has specific numerical values, this help to find the value of the resistor.



The color bands are read from left to right. The first and second bands represent significant digits respectively of the resistance value. The third band shows the multiplier value. The fourth band gives the tolerance value

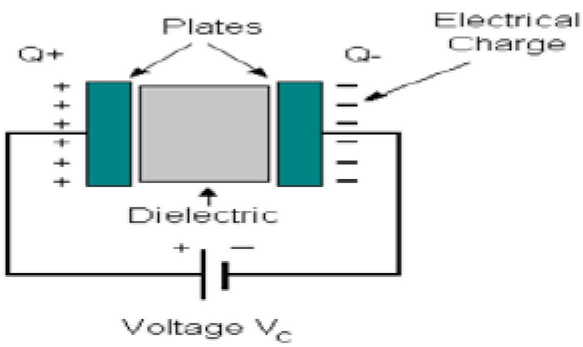


Color	Digit	Multiplier
Black	0	x 1
Brown	1	x 10
Red	2	x 100
Orange	3	x 1K
Yellow	4	x 10K
Green	5	x 100K
Blue	6	x 1M
Violet	7	-
Grey	8	-
White	9	-
Silver	-	x 0.01
Gold	-	x 0.1

CAPACITORS

Capacitor is a physical device which is capable of storing energy by virtue of a voltage existing across it. Capacitor store energy in electrostatic fields. A capacitor consists of two conducting plates separated by an insulating material, The insulating material is known as dielectric. Capacitance is measured by the ability of capacitor to store charge. Capacitance is measured in farads (F). Practical capacitors are measured in microfarads (µF) and picofarads (pF).

$1\ \mu F = 10^{-6} F,\ 1pF = 10^{-12} F,\ 1\ nF = 10^{-9} F$



$Q\ \alpha\ V;\ Q = CV$

Factors Affecting Capacitance

1 Plate Area:

It affects capacitance directly ie, capacitance increases with the increase in plate area (A)

2 Plate Separation:

It affects the capacitance inversely ie, capacitance decreases with the increase in plate separation

3. **Type of Dielectric:**

It also affects capacitance directly

$$C\ \alpha\ \frac{\varepsilon_r A}{d}$$

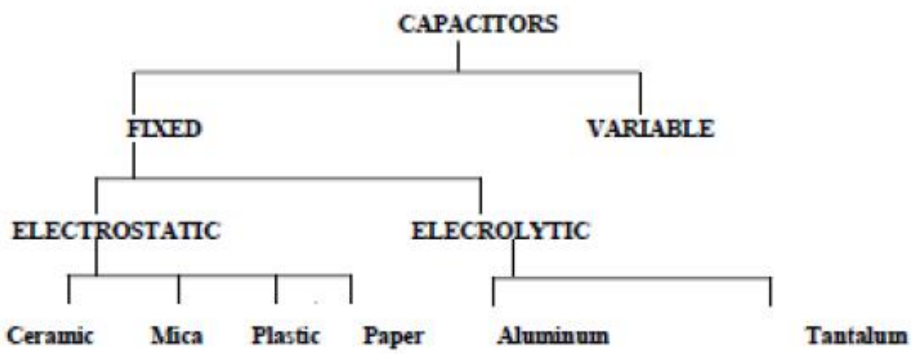
$$C = \frac{\varepsilon_r \varepsilon_0 A}{d}$$

Where ϵ_0 absolute permittivity = $8.854*10^{-14}$ F/M

ϵ_r Relative permittivity

Classification of capacitors

The capacitors are commonly classified on basis of dielectric material used. The capacitors may be divided in to two classes, namely fixed and variable capacitors. Each type is further sub divided into two types.



<u>Fixed Capacitors</u>

In fixed capacitors their capacitance value cannot be varied mechanically or by any external means. In fixed capacitors the dielectric is permanently kept in between two fixed plates.

Commonly used fixed capacitors are :

Paper capacitors

Paper capacitors are one of the earliest types of capacitors. They are made by placing paper soaked with mineral oil between two aluminum foils. The entire assembly is rolled up, wire leads are attached to the aluminum foils, and the assembly is enclosed in a cylindrical cardboard case and sealed with wax.

Nominal Capacitance	0.001 uF to 10 uF
Working Voltage (at 85°C)	200V to 1600V
Typical Tolerance	10%
Temperature Range	-55°C to 125°C
Temperature Coefficient (PPM/°C)	+/-800
Insulation Resistance (Meg Ohms)	$5x10^3$
Polarization	Non-Polarized
Dielectric Absorption	2.5%
Dissipation Factor (Operating Losses)	1%
Disadvantage	Size, Hygroscopic and susceptible to moisture
Advantage	Low Cost, Stable, High Voltage Rating
Applications	Motor Capacitors
Cost	Low

Mica & Metalized Mica capacitors

Mica capacitors use mica sheets as a dielectric and are usually constructed as multi-plate capacitors. A variation of mica capacitors use silver inked mica sheets as a dielectric for better immunity to moisture and ionization. Mica capacitors are known for low tolerance (as low as 1%), low operating losses (dissipation factor of 0.001%), high-quality factor, and stability at high frequency

Capacitance value vary from 1pF to 10,000pF

These capacitors are able to withstand very high voltage about 500V due to high dielectric constant.

Plastic film capacitors

Film capacitors include many families of capacitors that use different plastics as a dielectric material. They have nearly replaced the paper capacitors in audio, radio circuits, and circuits operating at low to moderate voltages. Some of the commonly used plastics in film capacitors include Polycarbonate, Polyester (PET), Polypropylene (PP), Polystyrene, Polysulphone, Parylene, Kapton Polyimide, Teflon (PTFE Fluorocarbon), and Metalized Polyester (Metalized Plastic). These capacitors come in a variety of geometries such as oval or round wrap and fill, rectangular epoxy case, round epoxy case, metal hermetically sealed rectangular or round case, and with radial or axial leads.

Nominal Capacitance	1000 pF to 50 uF
Working Voltage (at 85°C)	50V to 600V
Typical Tolerance	5% to 10%
Temperature Range	-55°C to 125°C
Temperature Coefficient (PPM/°C)	+400
Insulation Resistance (Meg Ohms)	10^5
Polarization	Non-Polarized
Dielectric Absorption	0.3%
Dissipation Factor (Operating Losses)	0.75%
Disadvantage	High Temperature Coefficient, Frequency Dependence
Advantage	Low Cost, Small Size
Applications	DC and low power low frequency AC applications
Cost	Low

Ceramic capacitors

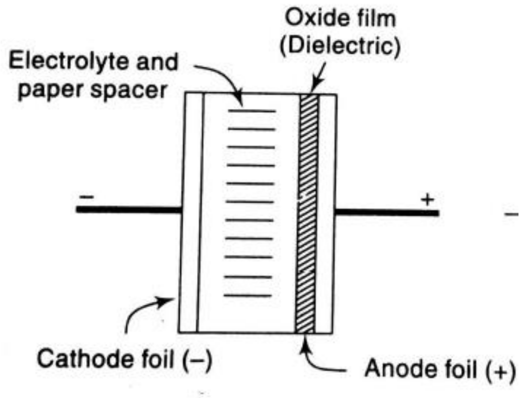
Ceramic capacitors refer to a wide range of capacitors available as disc capacitors, MLC (Multi-Layer Ceramic) capacitors, and SMD capacitors. The composition of these capacitors varies with the manufacturers. Some of the commonly used materials in the construction of ceramic capacitors include strontium titanate, titanium oxide, barium titanate, etc

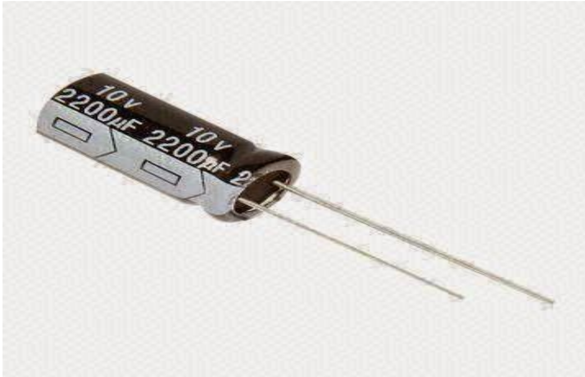
Nominal Capacitance	100 pF to 1 uF
Working Voltage (at 85°C)	50V to 30,000V
Typical Tolerance	1% to 5%
Temperature Range	-55°C to 125°C
Temperature Coefficient (PPM/°C)	+/-30 to +/-2500
Insulation Resistance (Meg Ohms)	$5x10^3$
Polarization	Non-Polarized
Dielectric Absorption	0.75
Dissipation Factor (Operating Losses)	0.02%
Disadvantage	Cost, Size
Advantage	Low Operating Losses, Stability, Low Tolerance
Applications	High Frequency Applications
Cost	High

Electrolytic capacitors

Electrolytic Capacitors are polarized capacitors that offer high capacitance per unit volume. Since these capacitors are polarized, they must be hooked up in a circuit with the right polarity. They have one terminal as the anode, which is a metal plate coated with metal oxide; a liquid or solid electrolytic serves as the cathode. When DC current flows through the electrolytic capacitor, the metal plate starts oxidizing due to an electrolytic and a thin insulating metal oxide layer is deposited on it which serves as a dielectric. As the metal oxide layer is extremely thin, it offers very high capacitance per unit volume. Generally, these capacitors are designed to maximize the surface area of the anode.

When connecting these capacitors in reverse polarity, the electrolyte starts emitting gas which expands in the sealed body of the capacitor and may lead to an explosion. These capacitors have significant leakage current, which makes them unsuitable for many applications.



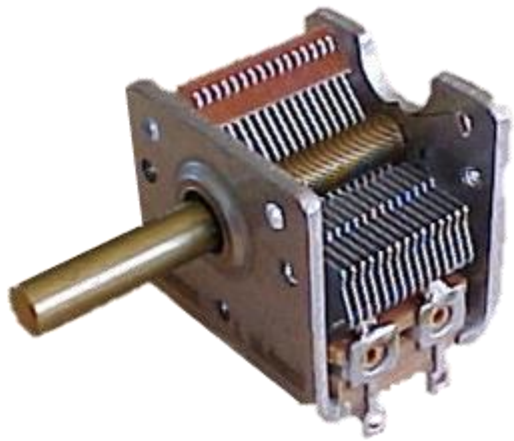


Nominal Capacitance	0.1 uF to 47,000 uF
Working Voltage (at 85°C)	3V to 600V
Typical Tolerance	20%
Temperature Range	-40°C to 85°C
Temperature Coefficient (PPM/°C)	+2500
Insulation Resistance (Meg Ohms)	100
Polarization	Polarized
Dielectric Absorption	8
Dissipation Factor (Operating Losses)	10%
Disadvantage	Polarized, High Operating Losses, Leakage Current
Advantage	High Volumetric Capacitance
Applications	Power Supply Filters, Audio Circuits
Cost	High

Variable capacitors

The capacitance of the variable capacitors can be varied by changing distance between the conducting plates or by changing the mutual surface area between overlapping plates.

Air Variable (Air-Gap Trimmer) – These variable capacitors have a rotatable set of plates called rotor and a fixed set of plates called stator. The capacitance is varied by rotating a control shaft which varies the distance or surface area between the plates. These capacitors can have a capacitance of a few Picofarad to 1000 Picofarad and voltage rating up to thousands of volts. These non-polarized capacitors were commonly used in RF and audio circuits. Varactor diodes have almost replaced these capacitors.



Colour coding of capacitor

Band	Digit	Digit	Multiplier	Tolerance	Tolerance
Colour	A	B	D	(T) > 10pf	(T) < 10pf
Black	0	0	x1	± 20%	± 2.0pF
Brown	1	1	x10	± 1%	± 0.1pF
Red	2	2	x100	± 2%	± 0.25pF
Orange	3	3	x1,000	± 3%	
Yellow	4	4	x10,000	± 4%	
Green	5	5	x100,000	± 5%	± 0.5pF
Blue	6	6	x1,000,000		
Violet	7	7			
Grey	8	8	x0.01	+80%,-20%	
White	9	9	x0.1	± 10%	± 1.0pF
Gold			x0.1	± 5%	
Silver			x0.01	± 10%	

Inductor

This is the third classification of Passive components.It stores the energy in the form of magnetic field and delivers it as and when required

Whenever current pass through a conductor ,lines of magnetic flux are generated around it. Thismagnetic flux opposes any change in current due to the induced emf . This opposition to the change in current is known as inductance and the component producing inductance is known as inductor.

Unit of inductance is Henry (H). The induced emf is actually given by

$$e = -L\frac{d_i}{d_t}$$

Where e = induced emf in volts in any instant

L= Inductance in Henry

$\frac{d_i}{d_t}$ = rate of change of current

The negative sign indicates that the induced emf opposes the cause for the change in current

An inductor is actually a coil of copper wire wound around a core made up of a ferromagnetic material. The inductance L of the coil is given by

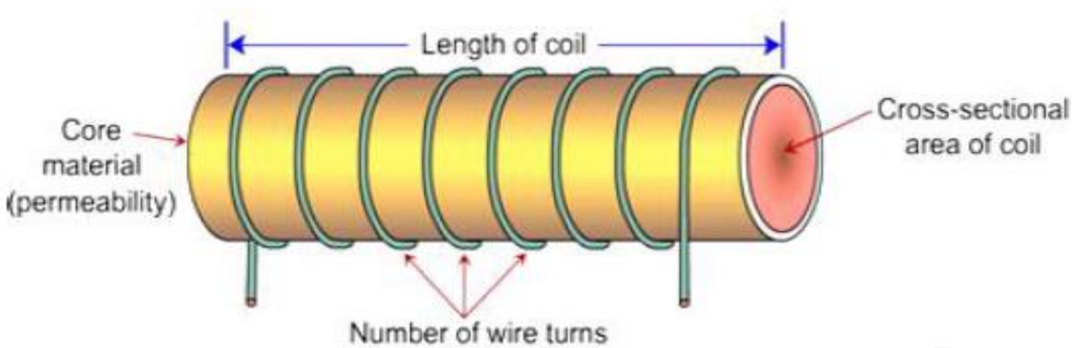
$$L = \frac{\mu_0\, \mu_r . A\, N^2}{l}$$

Where $\mu_0 = Permiability\ of\ free\ space = 4\pi\ X\ 10^{-7} H/m = 1.257x\ 10^{-6}\ H/m$

$\mu_r = relative\ permiability\ of\ the\ core$

N= number of turns of the coil

L= length of the core



Hence the value of the inductor depends on the following factors

i) Number of turns

ii) Permeability of the material

iii) Size of the core

Inductors can be further divided into two catagaries

i) Fixed inductors

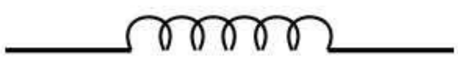
ii) Variable inductors

Inductor Types

There are many differnet types of inductor, each with their own properties - understanding the properties of the different types is essential for selecting the right type for a circuit.

Inductors perform a number of different styles of function within a circuit. Some types can be used for filtering and removing spikes on power lines, others are used within high performance filters. Others may be used within oscillators, and there are many other areas where inductors can be used.

As a result of this, there are many different types of inductor that can be obtained. Size, frequency, current, value, and many other factors means that there is a whole host of different types and forms of inductor.



INDUCTOR SYMBOL

Different inductor core types

Like other types of component such as the capacitor, there are very many different types of inductor. However it can be a little more difficult to exactly define the different types of inductor because the variety of inductor applications is so wide.

Although it is possible to define an inductor by its core material, this is not the only way in which they can be categorised. However for the basic definitions, this approach is used.

- ***Air cored inductor:*** This type of inductor is normally used for RF applications where the level of inductance required is smaller. The fact that no core is used has several advantages: there is no loss within the core as air is lossless, and this results in a high level of Q, assuming the inductor or coil resistance is low. Against this the number of turns on the coil is larger to gain the same level of inductance and this may result in a physical increase in size.
- ***Iron cored inductor:*** Iron cores are normally used for high power and high inductance types of inductor. Some audio coils or chokes may use iron laminate. They are generally not widely used.
- ***Ferrite cored inductor :*** Ferrite is one of the most widely used cores for a variety of types of inductor. Ferrite is a metal oxide ceramic based around a mixture of Ferric Oxide Fe2O3 and either manganese-zinc or nickel-zinc oxides which are extruded or pressed into the required shape.

Inductors on a toroidal ferrite former

- ***Iron power inductor:*** Another core that can be used in a variety of types of inductor is iron oxide. Like ferrite, this provides a considerable increase in the permeability, thereby enabling much higher inductance coils or inductors to be manufactured in a small space

Different mechanical inductor types and applications

Inductors may also be categorised in terms of their mechanical construction. There are a number of different standard types by which inductors may be categorised:

- ***Bobbin based inductor:*** This type of inductor is would on a cylindrical bobbin. They may be designed for printed circuit board mounting, even surface mount of they may be much larger and mounted via some other mechanical means. Some older versions of these inductors may even be in a similar format to normal leaded resistors.

- ***Toroidal inductor:*** This form of inductor is wound on a toroid - a circular former. Ferrite is often used as the former as this increases the permeability of the core. The advantage of a toroid is that the toroid enables the magnetic flux to travel in a circle around the toroid and as a result the flux leakage is very low. The disadvantage with a toroidal inductor is that it requires a special winding machine is required to perform the manufacture as the wire has to be passed thought the toroid for each turn required.

- ***Multilayer ceramic inductor:*** This type of inductor is widely used for surface mount technology. The inductor is manufactured within a ferrite or more commonly a magnetic ceramic material. The coil is contained within the body of the ceramic and is presented to the external circuit on end caps in the same way as chip capacitors, etc.
- ***Film inductor:*** This form of inductor uses a film of conductor on a base material. The film is then etched or shaped to give the required conductor profile.

PN JUNCTION DIODE

A PN-junction diode is formed when a p-type semiconductor is fused to an n-type semiconductor creating a potential barrier voltage across the diode junction

However, if we were to make electrical connections at the ends of both the N-type and the P-type materials and then connect them to a battery source, an additional energy source now exists to overcome the potential barrier.

The effect of adding this additional energy source results in the free electrons being able to cross the depletion region from one side to the other. The behaviour of the PN junction with regards to the potential barrier's width produces an asymmetrical conducting two terminal device, better known as the **PN Junction Diode**.

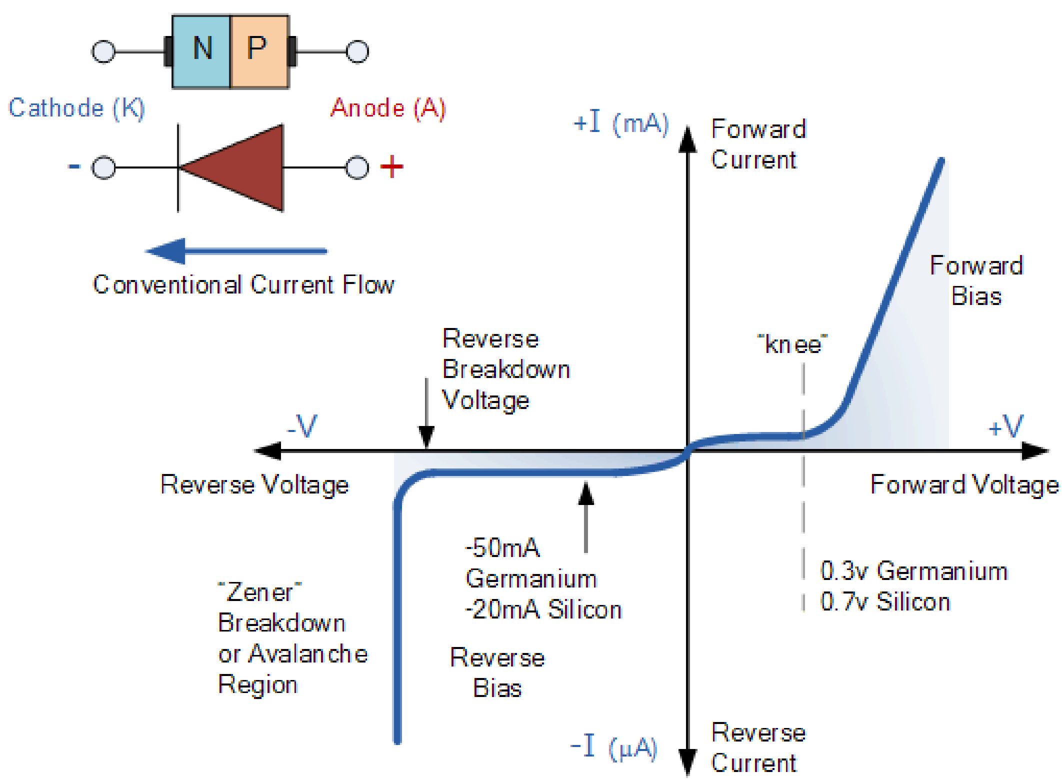
A *PN Junction Diode* is one of the simplest semiconductor devices around, and which has the characteristic of passing current in only one direction only. However, unlike a resistor, a diode does not behave linearly with respect to the applied voltage as the diode has an exponential current-voltage (I-V) relationship and therefore we can not described its operation by simply using an equation such as Ohm's law.

If a suitable positive voltage (forward bias) is applied between the two ends of the PN junction, it can supply free electrons and holes with the extra energy they require to cross the junction as the width of the depletion layer around the PN junction is decreased.

By applying a negative voltage (reverse bias) results in the free charges being pulled away from the junction resulting in the depletion layer width being increased. This has the effect of increasing or decreasing the effective resistance of the junction itself allowing or blocking current flow through the diode.

Then the depletion layer widens with an increase in the application of a reverse voltage and narrows with an increase in the application of a forward voltage. This is due to the differences in the electrical properties on the two sides of the PN junction resulting in physical changes taking place. One of the results produces rectification as seen in the PN junction diodes static I-V (current-voltage) characteristics. Rectification is shown by an asymmetrical current flow when the polarity of bias voltage is altered as shown below.

Junction Diode Symbol and Static I-V Characteristics

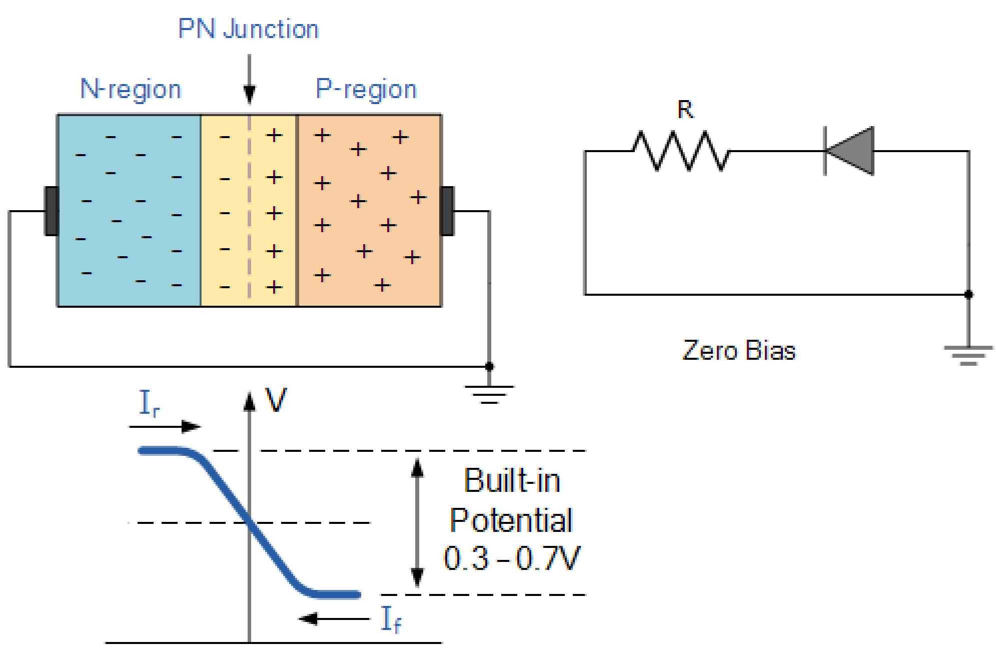


But before we can use the PN junction as a practical device or as a rectifying device we need to firstly **bias** the junction, ie connect a voltage potential across it. On the voltage axis above, “Reverse Bias” refers to an external voltage potential which increases the potential barrier. An external voltage which decreases the potential barrier is said to act in the “Forward Bias” direction.

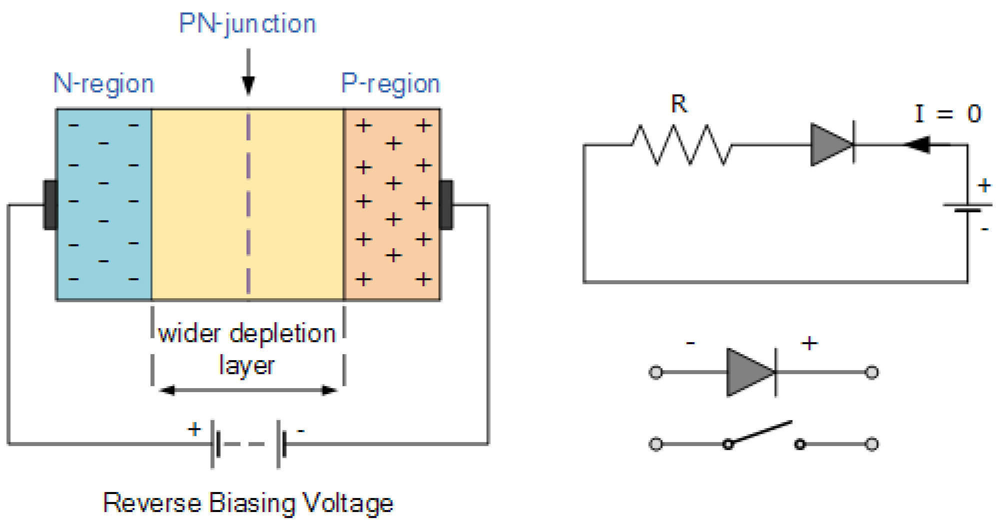
There are two operating regions and three possible “biasing” conditions for the standard **Junction Diode** and these are:

- 1. Zero Bias – No external voltage potential is applied to the PN junction diode.
- 2. Reverse Bias – The voltage potential is connected negative, (-ve) to the P-type material and positive, (+ve) to the N-type material across the diode which has the effect of **Increasing** the PN junction diode’s width.
- 3. Forward Bias – The voltage potential is connected positive, (+ve) to the P-type material and negative, (-ve) to the N-type material across the diode which has the effect of **Decreasing** the PN junction diodes width.

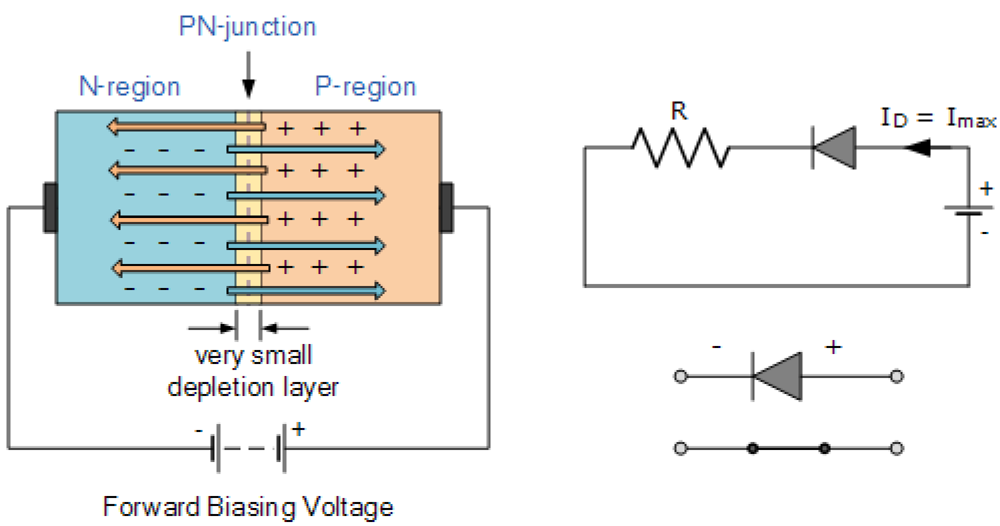
Zero Biased PN Junction Diode



Increase in the Depletion Layer due to Reverse Bias



Reduction in the Depletion Layer due to Forward Bias



Junction Diode Summary

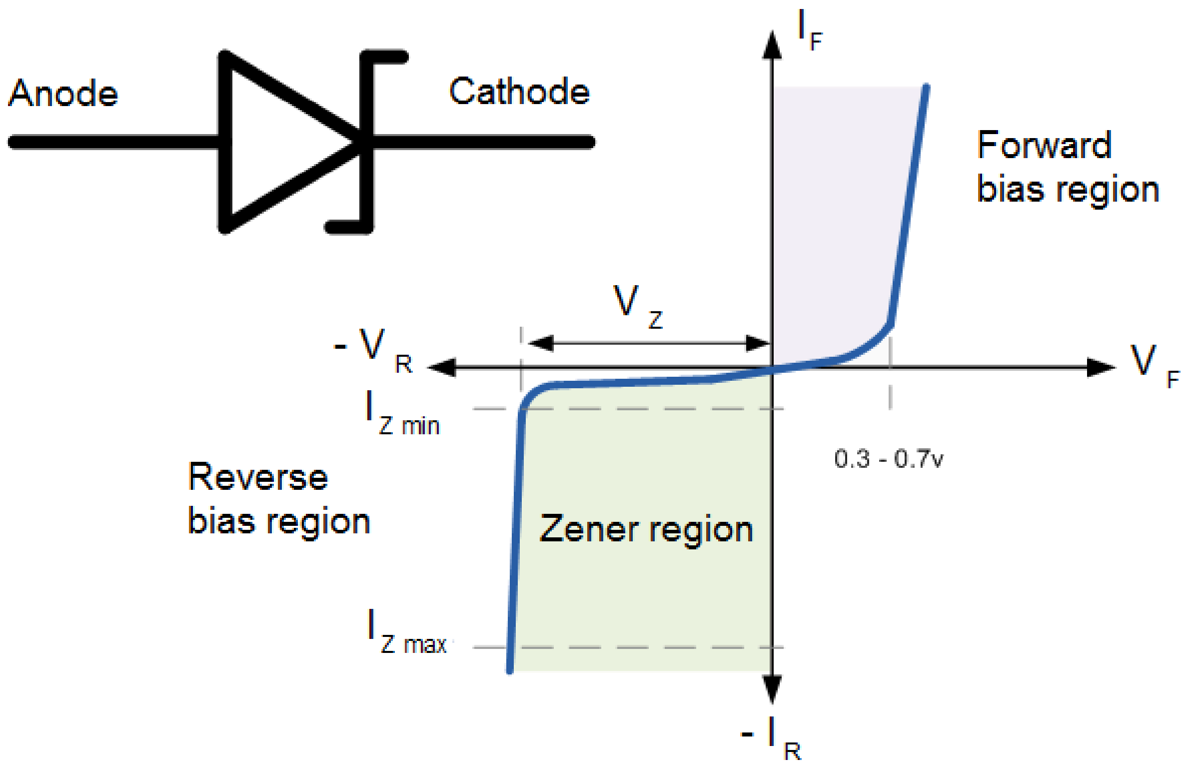
The PN junction region of a **Junction Diode** has the following important characteristics:

- Semiconductors contain two types of mobile charge carriers, “Holes” and “Electrons”.
- The holes are positively charged while the electrons negatively charged.

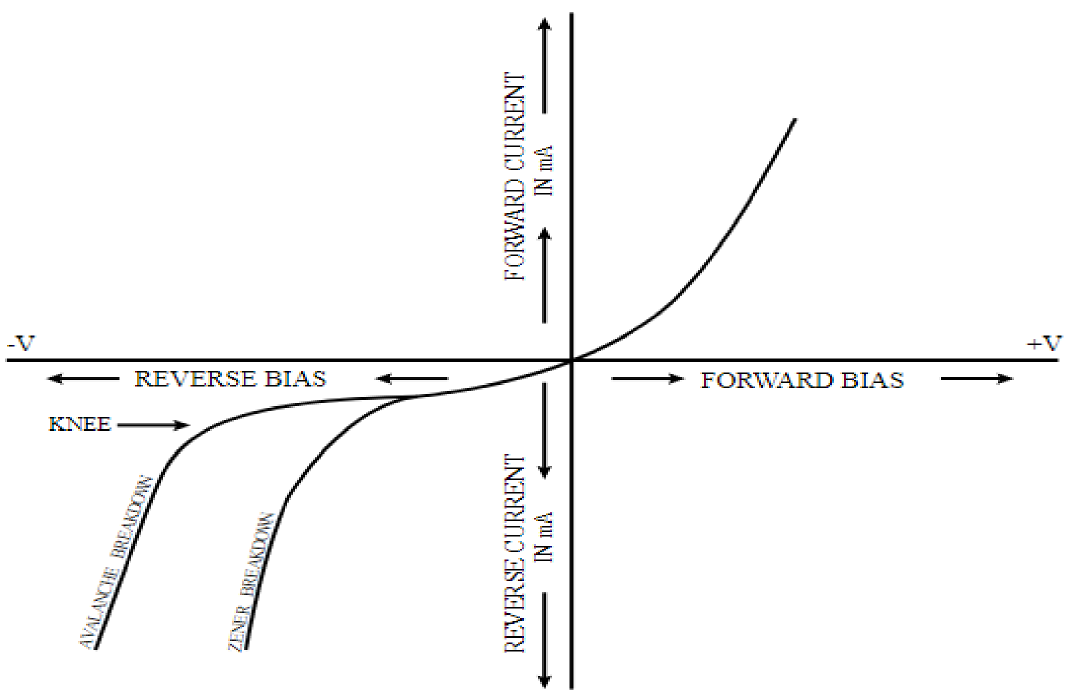
- A semiconductor may be doped with donor impurities such as Antimony (N-type doping), so that it contains mobile charges which are primarily electrons.
- A semiconductor may be doped with acceptor impurities such as Boron (P-type doping), so that it contains mobile charges which are mainly holes.
- The junction region itself has no charge carriers and is known as the depletion region.
- The junction (depletion) region has a physical thickness that varies with the applied voltage.
- When a diode is **Zero Biased** no external energy source is applied and a natural **Potential Barrier** is developed across a depletion layer which is approximately 0.5 to 0.7v for silicon diodes and approximately 0.3 of a volt for germanium diodes.
- When a junction diode is **Forward Biased** the thickness of the depletion region reduces and the diode acts like a short circuit allowing full current to flow.
- When a junction diode is **Reverse Biased** the thickness of the depletion region increases and the diode acts like an open circuit blocking any current flow, (only a very small leakage current).

ZENER DIODE

- A **Zener diode** is a type of diode that allows current to flow in the conventional manner - from its anode to its cathode i.e. when the anode is positive with respect to the cathode. When the voltage across the terminals is reversed and the potential reaches the *Zener voltage* (or "knee"), the junction will breakdown and current will flow in the reverse direction - a desired characteristic. This effect is known as the Zener effect, after Clarence Zener, who first described the phenomenon. Zener diodes are manufactured with a great variety of Zener voltages (Vz) and some are even variable.
- Zener diodes have a highly doped p–n junction. A similar break down is observed in general purpose diodes (which might be quite high), but the voltage and sharpness of the knee is not clearly defined as in Zener diodes. Normal diodes are not designed to operate in the breakdown region and it can cause permanent failure of the device. Zener diodes are manufactured to operate reliably and quite precisely in this region, recovering fully from the junction breakdown and not being harmed in proper use.



AVALANCHE BREAK DOWN AND ZENER BREAK DOWN



Avalanche breakdown is a phenomenon that can occur in both insulating and semiconducting materials. It is a form of electric current multiplication that can allow very large currents within materials which are otherwise good insulators. It is a type of electron avalanche. The avalanche process occurs when carriers in the transition region are accelerated by the electric field to energies sufficient to create mobile or free electron-hole pairs via collisions with bound electrons.

Materials conduct electricity if they contain mobile charge carriers. There are two types of charge carriers in a semiconductor: free electrons (mobile electrons) and electron holes (mobile holes which are missing electrons from the normally occupied electron states). A normally bound electron (e.g., in a bond) in a reverse-biased diode may break loose due to a thermal fluctuation or excitation, creating a mobile electron-hole pair. If there is a voltage gradient (electric field) in the semiconductor, the electron will move towards the positive voltage while the hole will move towards the negative voltage. Usually, the electron and hole will simply move to opposite ends of the crystal and enter the appropriate electrodes. When the electric field is strong enough, the mobile electron or hole may be accelerated to high enough speeds to knock other bound electrons free, creating more free charge carriers, increasing the current and leading to further "knocking out" processes and creating an avalanche. In this way, large portions of a normally insulating crystal can begin to conduct.

The large voltage drop and possibly large current during breakdown necessarily leads to the generation of heat. Therefore, a diode placed into a reverse blocking power application will usually be destroyed by breakdown if the external circuit allows a large current. In principle, avalanche breakdown only involves the passage of electrons and need not damage to the crystal. Avalanche diodes (commonly encountered as high voltage Zener diodes) are constructed to break down at a uniform voltage and to avoid current crowding during breakdown. These diodes can indefinitely sustain a moderate level of current during breakdown.

The voltage at which the breakdown occurs is called the breakdown voltage. There is a hysteresis effect; once avalanche breakdown has occurred, the material will continue to conduct even if the voltage across it drops below the breakdown voltage. This is different from a Zener diode, which will stop conducting once the reverse voltage drops below the breakdown voltage.

DIFFERENCE BETWEEN ZENER AND AVALANCHE BREAKDOWN

Zener Breakdown	Avalanche breakdown
1.This occurs at junctions which being heavily doped have narrow depletion layers	1. This occurs at junctions which being lightly doped have wide depletion layers.
2. This breakdown voltage sets a very strong electric field across this narrow layer.	2. Here electric field is not strong enough to produce Zener breakdown.
3. Here electric field is very strong to rupture the covalent bonds thereby generating electron-hole pairs. So even a small increase in reverse voltage is capable of producing Large number of current carriers.	3. Her minority carriers collide with semi conductor atoms in the depletion region, which breaks the covalent bonds and electron-hole pairs are generated. Newly generated charge carriers are accelerated by the electric field which results in more collision and generates avalanche of charge carriers. This results in avalanche breakdown.
4. Zener diode exhibits negative temp: coefficient. Ie. breakdown voltage decreases as temperature increases.	4. Avalanche diodes exhibits positive temp: coefficient. i.e breakdown voltage increases with increase in temperature.

BIPOLAR JUNCTION TRANSISTOR

A Bipolar Junction Transistor (BJT) is a three terminal semiconductor device in which the operation depends on the interaction of both majority and minority carriers and hence the name Bipolar. The BJT is analogous to a vacuum triode and is comparatively smaller in size. It is used in amplifier and oscillator circuits, and as a switch in digital circuits. It has wide applications in computers, satellites and other modern communication systems.

CONSTRUCTION

The BJT consists of a silicon (or germanium) crystal in which a thin layer of N-type Silicon is sandwiched between two layers of P-type silicon. This transistor is referred to as PNP. Alternatively, in a NPN transistor, a layer of P-type material is sandwiched between two layers of N-type material. The two types of the BJT are represented in Fig. 6.1.

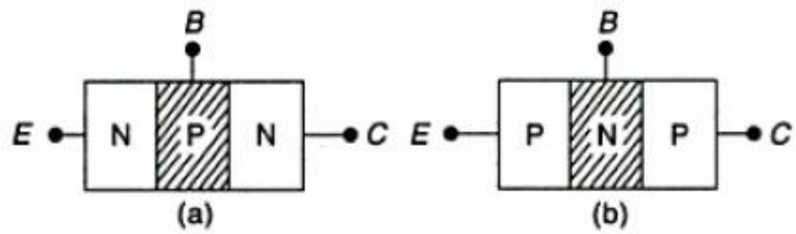


Fig. 6.1 Transistor (a) NPN and (b) PNP

The symbolic representation of the two types of the BJT is shown in Fig. 6.2. The three portions of the transistor are Emitter, Base and Collector, shown as *E*, *B* and *C*, respectively. The arrow on the emitter specifies the direction of current flow when the *EB* junction is forward biased.

Emitter is heavily doped so that it can inject a large number of charge carriers into the base. Base is lightly doped and very thin. It passes most of the injected charge carriers from the emitter into the collector. Collector is moderately doped.

TRANSISTOR BIASING

As shown in Fig. 6.3, usually the emitter-base junction is forward biased and collector-base junction is reverse biased. Due to the forward bias on the emitter-base

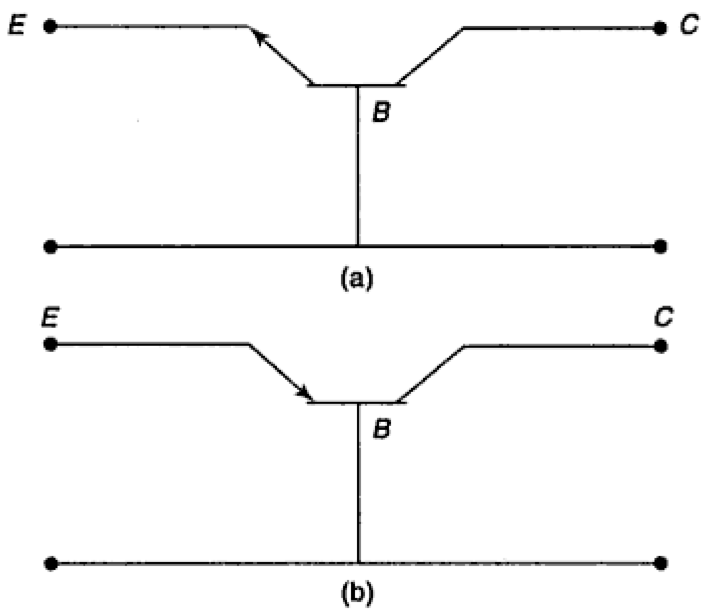


Fig. 6.2 Circuit symbol. (a) NPN transistor and (b) PNP transistor

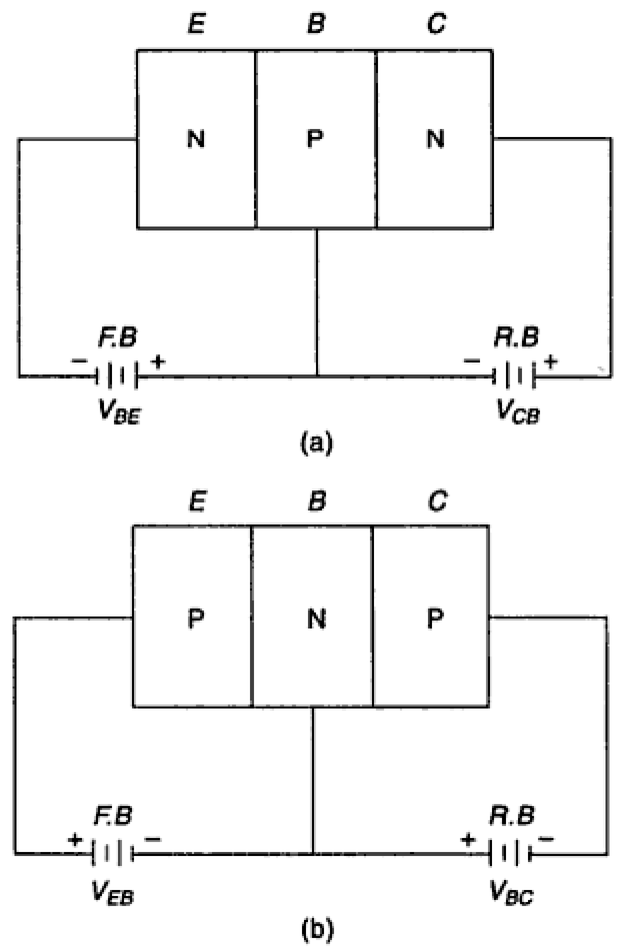


Fig. 6.3 Transistor biasing (a) NPN transistor and (b) PNP transistor

OPERATION OF NPN TRANSISTOR

As shown in Fig. 6.4, the forward bias applied to the emitter base junction of an NPN transistor causes a lot of electrons from the emitter region to crossover to the base region. As the base is lightly doped with P-type impurity, the number of holes in the base region is very small and hence the number of electrons that combine with holes in the P-type base region is also very small. Hence a few electrons combine with holes to constitute a base current I_B. The remaining electrons (more than 95%) crossover into the collector region to constitute a collector current I_C. Thus the base and collector current summed up gives the emitter current, i.e. $I_E = -(I_C + I_B)$.

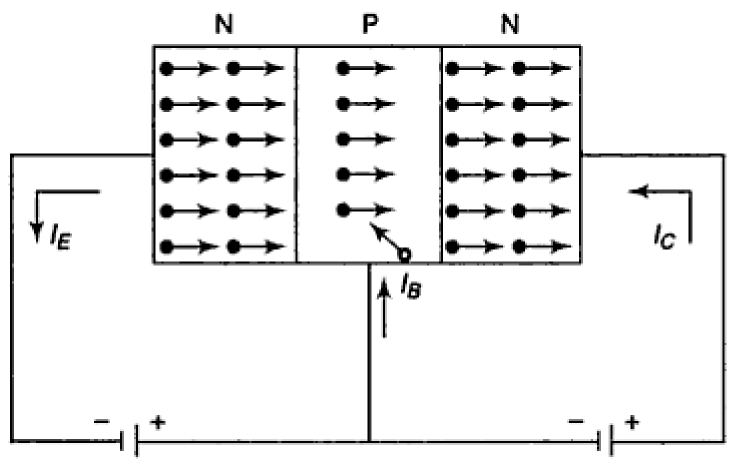


Fig. 6.4 Current in NPN transistor

In the external circuit of the NPN bipolar junction transistor, the magnitudes of the emitter current I_E, the base current I_B and the collector current I_C are related by $I_E = I_C + I_B$.

OPERATION OF PNP TRANSISTOR

As shown in Fig. 6.5, the forward bias applied to the emitter-base junction of a PNP transistor causes a lot of holes from the emitter region to crossover to the base region as the base is lightly doped with N-types impurity. The number of electrons in the base region is very small and hence the number of holes combined with

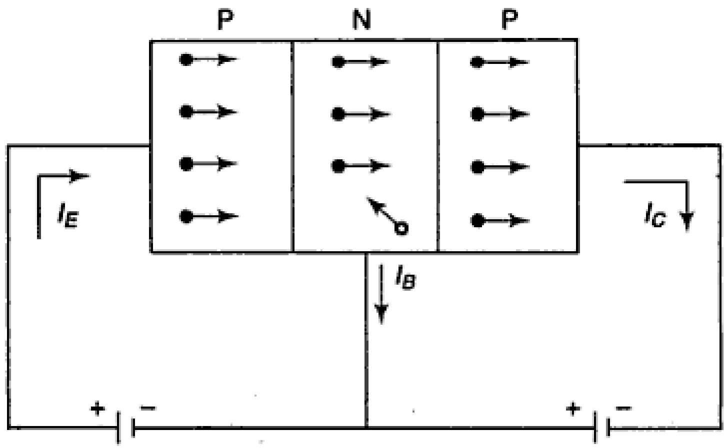


Fig. 6.5 Current in PNP transistor

electrons in the N-type base region is also very small. Hence a few holes combined with electrons to constitute a base current I_B. The remaining holes (more than 95%) crossover into the collector region to constitute a collector current I_C. Thus the collector and base current when summed up gives the emitter current, i.e. $I_E = -(I_C + I_B)$.

In the external circuit of the PNP bipolar junction transistor, the magnitudes of the emitter current I_E, the base current I_B and the collector current I_C are related by

$$I_E = I_C + I_B \tag{6.1}$$

This equation gives the fundamental relationship between the currents in a bipolar transistor circuit. Also, this fundamental equation shows that there are current amplification factors α and β in common base transistor configuration and common emitter transistor configuration respectively for the static (d.c.) currents, and for small changes in the currents.

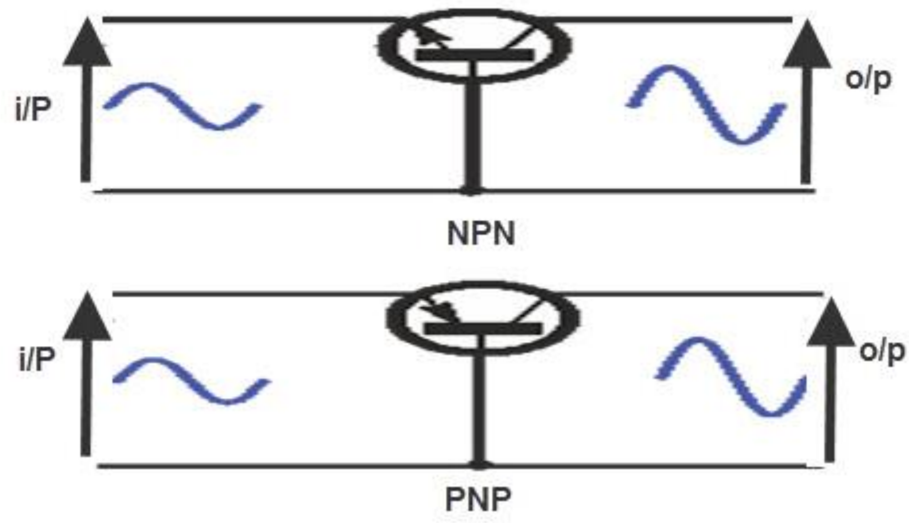
Types of Transistor Configurations

The three different kinds of transistor configurations are

- Common base transistor configuration
- Common emitter transistor configuration
- Common collector transistor configuration

Common Base Transistor Configuration (CB)

The common base transistor configuration gives a low i/p while giving a high o/p impedance. When the voltage of the CB transistor is high, the gain of the current and overall gain of the power is also low compared to the other transistor configurations. The main feature of the B transistor is that the i/p and o/p of the transistor are in phase. The following diagram shows the configuration of CB transistor. In this circuit, the base terminal is mutual to both i/p & o/p circuits.



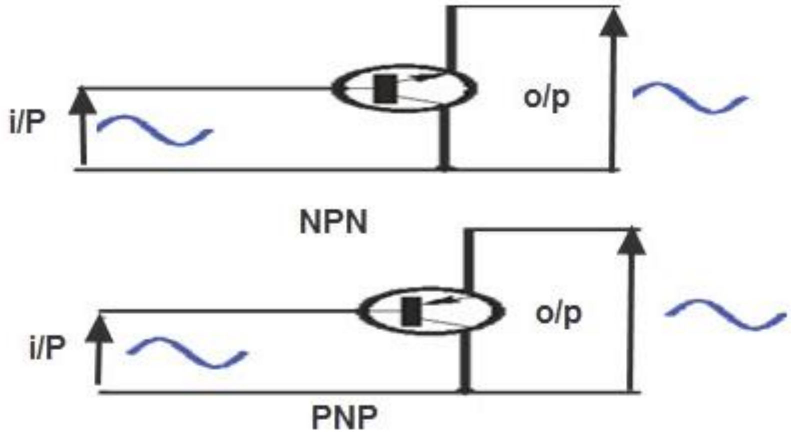
The current gain of the CB circuit is calculated in a method related to that of the CE concept and it is denoted with alpha (α). It is the relationship between collector current and emitter current.The current gain is calculated by using the following formula.

Alpha is the relationship of collector current (output current) to emitter current (input current). Alpha is calculated using the formula:

$$\alpha = (\Delta I_C)/\Delta I_E$$

Common Collector Transistor Configuration (CC)

The common collector transistor configuration is also known as the emitter follower because the emitter voltage of this transistor follows the base terminal of the transistor. Offering a high i/p impedance & a low o/p impedance are commonly used as a buffer.The voltage gain of this transistor is unity, the current gain is high and the o/p signals are in phase. The following diagram shows the configuration of CC transistor. The collector terminal is mutual to both i/p and o/p circuits.

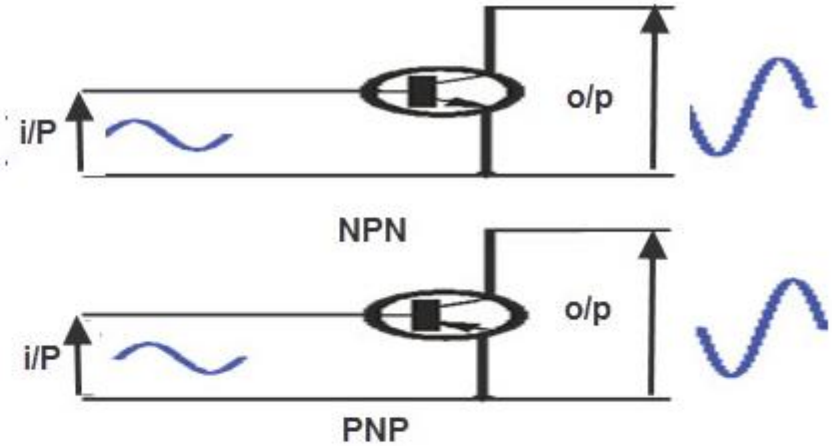


The current gain of the CC circuit is denoted with (γ) and it is calculated by using the following formula.

$$\gamma = \frac{I_E}{I_B}$$

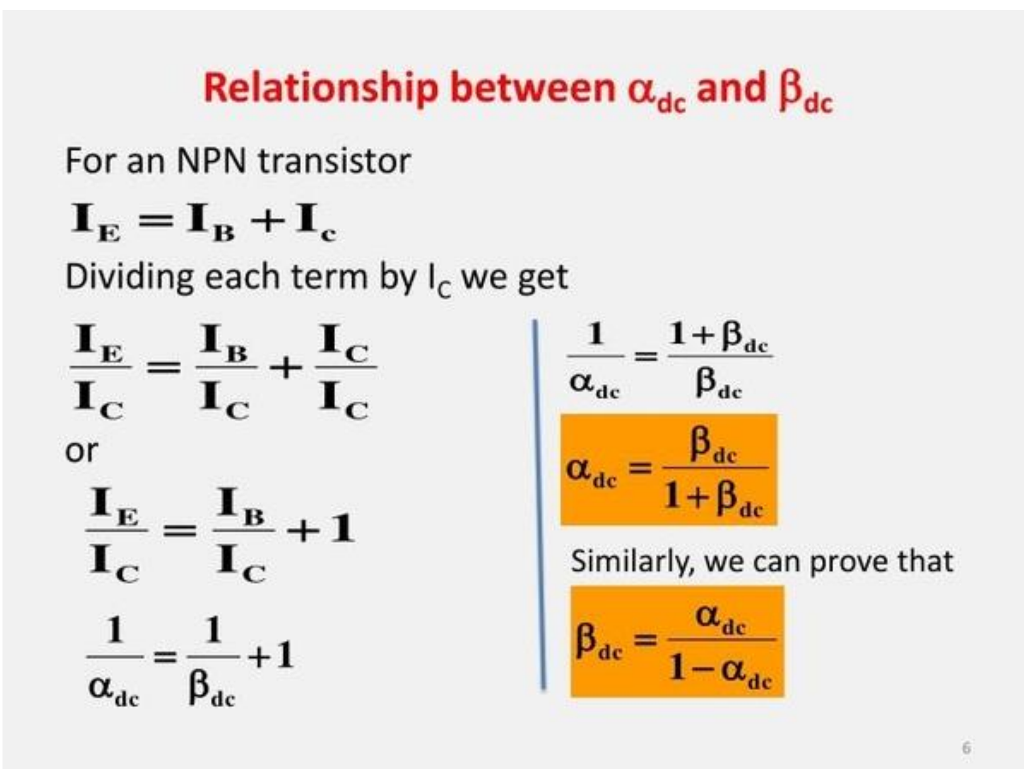
Common Emitter Transistor Configuration (CE)

The common emitter transistor configuration is most widely used configuration. The circuit of CE transistor gives a medium i/p and o/p impedance levels. The gain of the both voltage and current can be defined as a medium, but the o/p is opposite to the i/p that is 1800 change in the phase. This gives a good performance and it is frequently thought of as the most commonly used configurations. The following diagram shows the configuration of CE transistor. In this kind of circuit, the emitter terminal is mutual to both i/p & o/p.



The current gain of the common emitter (CE) circuit is denoted with beta (β).It is the relationship between collector current and base current.The following formula is used to calculate the beta (β). Delta is used to specify a small change

$$\beta = \frac{I_C}{I_B}$$



$$\alpha_{dc} = \frac{\beta_{dc}}{\beta_{dc} + 1}$$

$$\beta_{dc} = \frac{\alpha_{dc}}{1 - \alpha_{dc}}$$

Similarly we can prove,

$\gamma = \beta + 1$

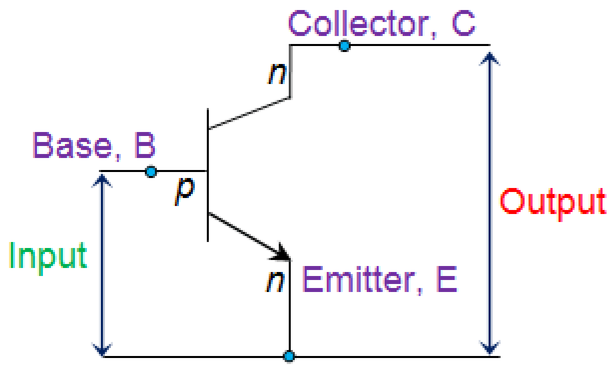
INPUT AND OUTPUT CHARACTERISTICS OF COMMON EMITTER CONFIGURATION

Transistor Characteristics are the plots which represent the relationships between the current and the voltages of a transistor in a particular configuration. By considering the transistor configuration circuits to be analogous to two-port networks, they can be analyzed using the characteristic-curves which can be of the following types

1. Input Characteristics: These describe the changes in input current with the variation in the values of input voltage keeping the output voltage constant.
2. Output Characteristics: This is a plot of output current versus output voltage with constant input current.
3. Current Transfer Characteristics: This characteristic curve shows the variation of output current in accordance with the input current, keeping output voltage constant.

Common Emitter (CE) Configuration of Transistor

In this configuration, the emitter terminal is common between the input and the output terminals as shown by Figure 9. This configuration offers medium input impedance, medium output impedance, medium current gain and voltage gain.



Input Characteristics for CE Configuration of Transistor

Figure 10 shows the input characteristics for the CE configuration of transistor which illustrates the variation in I_B in accordance with V_{BE} when V_{CE} is kept constant.

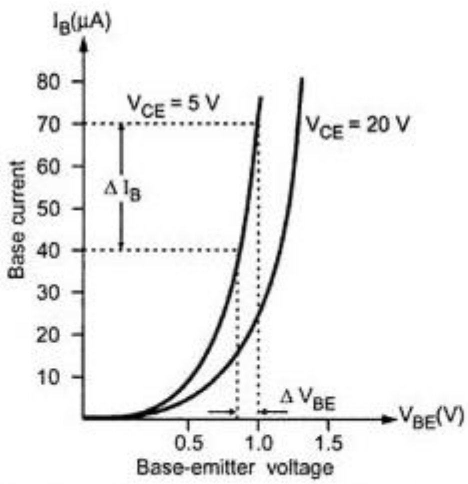


Fig 3.2: Input characteristics of the transistor in CE configuration

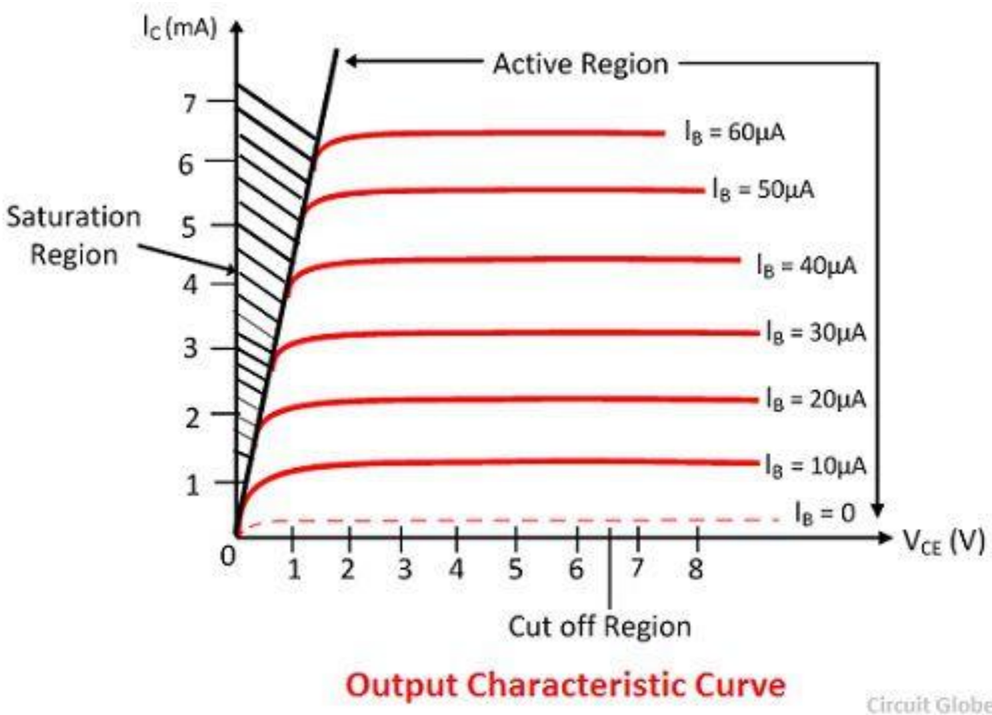
From the graph shown in Figure 10 above, the input resistance of the transistor can be obtained as

$$R_{in} = \left.\frac{\Delta V_{BE}}{\Delta I_B}\right|_{V_{CE}=constant}$$

Output Characteristics for CE Configuration of Transistor

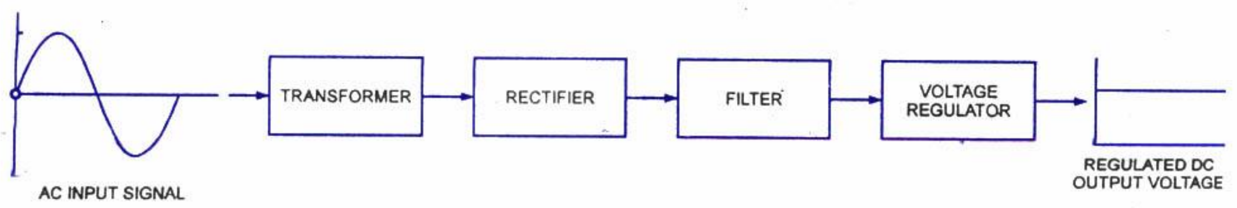
The output characteristics of CE configuration (Figure 11) are also referred to as collector characteristics. This plot shows the variation in I_C with the changes in V_{CE} when I_B is held constant. From the graph shown, the output resistance can be obtained as:

$$R_{out} = \frac{\Delta V_{CB}}{\Delta I_C}\bigg|_{I_E=constant}$$



MODULE 5

BLOCK DIAGRAM DESCRIPTION OF A DC POWER SUPPLY



Block Diagram of a DC Power Supply

The electrical power is almost exclusively generated, transmitted and distributed in the form of ac because of economical consideration but for operation of most of the electronic devices and circuits, dc supply is required. Dry cells and batteries can be used for this purpose. No doubt, they have the advantages of being portable and ripple free but their voltages are low, they need frequent replacement and are expensive in comparison to conventional dc power supplies.

Now a days, almost all electronic equipment include a circuit that converts ac supply into dc supply. The part of equipment that converts ac into dc is called DC power supply. In general at the input of the power supply there is a power transformer. It is followed by a rectifier (a diode circuit)a smoothing filter and then by a *voltage* regulator circuit.

From the block diagram, the basic power supply is constituted by four elements viz a *transformer,* a *rectifier,* a *filter,* and a *regulator* put together. The output of the dc power supply is used to provide a constant dc voltage across the load. Let us briefly outline the function of each of the elements of the dc power supply.

Transformer is used to step-up or step-down (usually to step-down) the-supply voltage as per need of the solid-state electronic devices and circuits to be supplied by the dc power supply. It can provide isolation from the supply line-an important safety consideration. It may also include internal shielding to prevent unwanted electrical noise signal on the power line from getting into the power supply and possibly disturbing the load.

Rectifier is a device which converts the sinusoidal ac voltage into either positive or negative pulsating dc. P-N junction diode, which conducts when forward biased and practically does not conduct when reverse biased, can be used for rectification *i.e.* for conversion of ac into dc. The rectifier typically needs one, two or four diodes. Rectifiers may be either **half-wave rectifiers** or full-wave rectifiers (**centre-tap** or **bridge**) type.

The output voltage from a rectifier circuit has a pulsating character i.e., it contains unwanted ac components (components of supply frequency *f* and its harmonics) along with dc component. For most supply purposes, constant direct voltage is required than that furnished by a rectifier. To reduce ac components from the rectifier output voltage a *filter circuit is required.*

Thus filter is a device which passes dc component to the load and blocks I ac components of the rectifier output. Filter is typically constructed from reactive circuit I elements such as capacitors and/or inductors and resistors.The magnitude of output dc voltage may vary with the variation of either the input ac voltage or the magnitude of load current. So at the output of a rectifier filter combination a voltage regulator is required, to provide an almost constant dc voltage at the output of the regulator. The voltage regulator may be constructed from a Zener diode, and or discrete transistors, and/or integrated circuits (ICs). Its main function is to maintain a constant dc output voltage. However, it also rejects any ac ripple voltage that is not removed by the filter. The regulator may also include protective devices such as short-circuit protection, current limiting, thermal shutdown, or over-voltage protection.

WORKING OF A FULL WAVE BRIDGE RECTIFIER

FULL-WAVE RECTIFICATION

Bridge Rectifier

The dc level obtained from a sinusoidal input can be improved 100% using a process called full-wave rectification. The most familiar network for performing such a function appears in Fig. 2.52 with its four diodes in a bridge configuration. During the period t = 0 to T/2 the polarity of the input is as shown in Fig. 2.53. The resulting polarities across the ideal diodes are also shown in Fig. 2.53 to reveal that D2 and D3 are conducting while D1 and D4 are in the “off” state. The net result is the configuration of Fig. 2.54, with its indicated current and polarity across R. Since the diodes are ideal the load voltage is Vo = Vi, as shown in the same figure

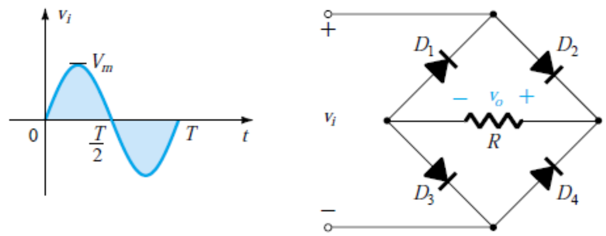


Figure 2.52 Full-wave bridge rectifier.

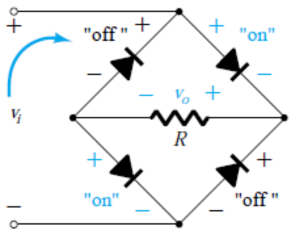


Figure 2.53 Network of Fig. 2.52 for the period $0 \rightarrow T/2$ of the input voltage v_i.

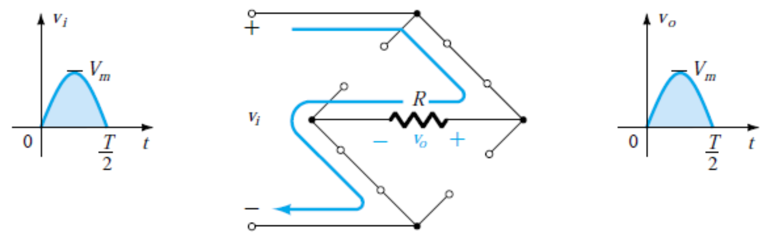


Figure 2.54 Conduction path for the positive region of v_i.

For the negative region of the input the conducting diodes are D_1 and D_4, resulting in the configuration of Fig. 2.55. The important result is that the polarity across the load resistor R is the same as in Fig. 2.53, establishing a second positive pulse, as shown in Fig. 2.55. Over one full cycle the input and output voltages will appear as shown in Fig. 2.56.

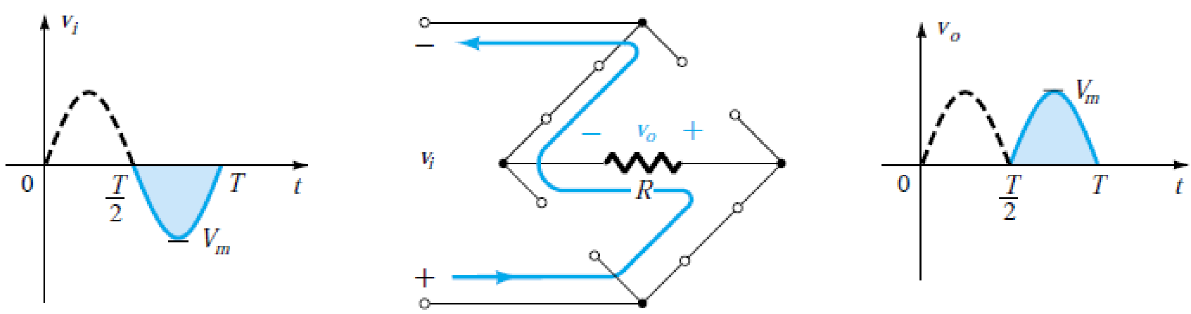


Figure 2.55 Conduction path for the negative region of v_i.

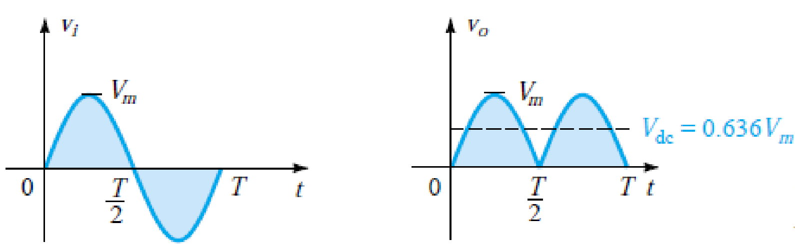
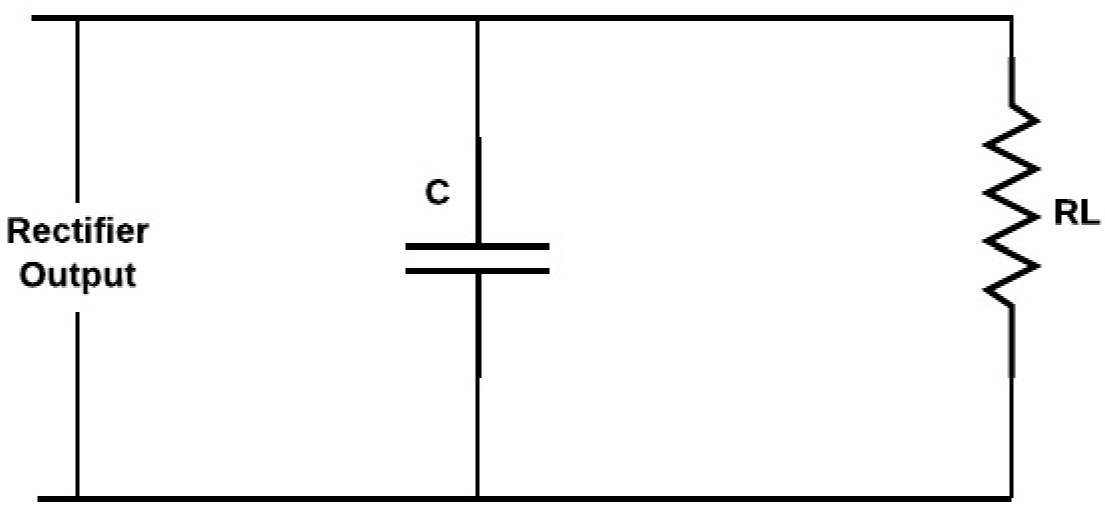


Figure 2.56 Input and output waveforms for a full-wave rectifier.

Parameters	Center tapped full wave rectifier	Bridge rectifier
Number of diodes	2	4
Maximum efficiency	81.2%	81.2%
Peak inverse voltage	$2V_m$	V_m
Vdc(no load)	$2V_m/\pi$	$2V_m/\pi$
Transformer utilization factor	0.693	0.812
Ripple factor	0.48	0.48
Form factor	1.11	1.11
Peak factor	√2	√2
Average current	$I_{dc}/2$	$I_{dc}/2$
Output frequency	2f	2f

CAPACITOR FILTER

A typical **capacitor filter** circuit diagram is shown below. The designing of this circuit can be done with a capacitor (C) as well as load resistor (RL). The rectifier's exciting voltage is given across the terminals of a capacitor. Whenever the voltage of the rectifier enhances then the capacitor will be charged as well as supplies the current to the load.



At the last part of the quarter phase, the capacitor will be charged to the highest rectifier voltage value that is denoted with Vm, and then the voltage of the rectifier starts to reduce. As this happens, the capacitor starts discharging through the voltage across it and load. The voltage across the load will reduce little only because the next peak voltage occurs instantaneously to charge the capacitor. This procedure will repeat many times and the output waveform will be seen that very slight ripple is missing in the output. Furthermore, the output voltage is superior because it remains significantly close to the highest value of the output voltage of the rectifier.

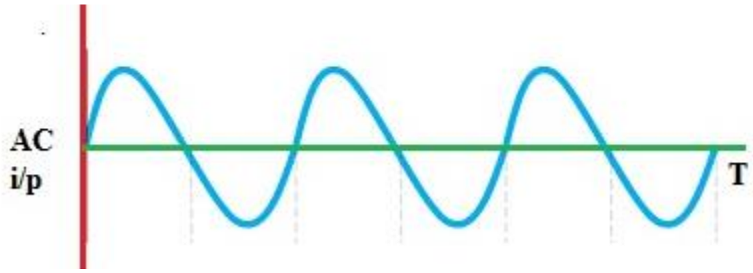


Figure: AC input waveform

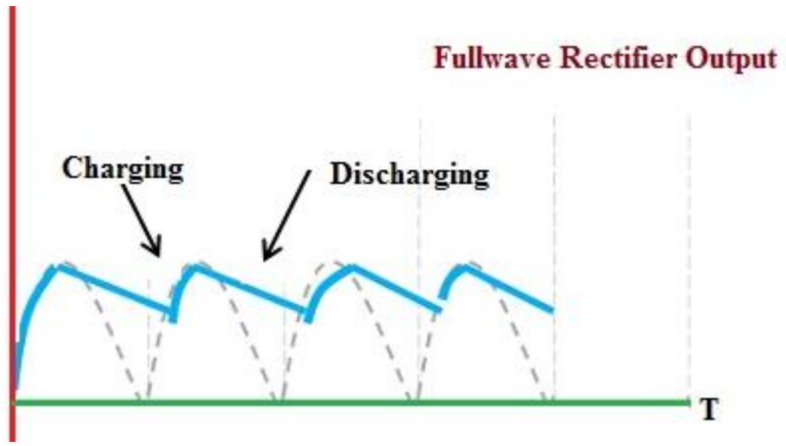


Figure: Output waveform using capacitor filter

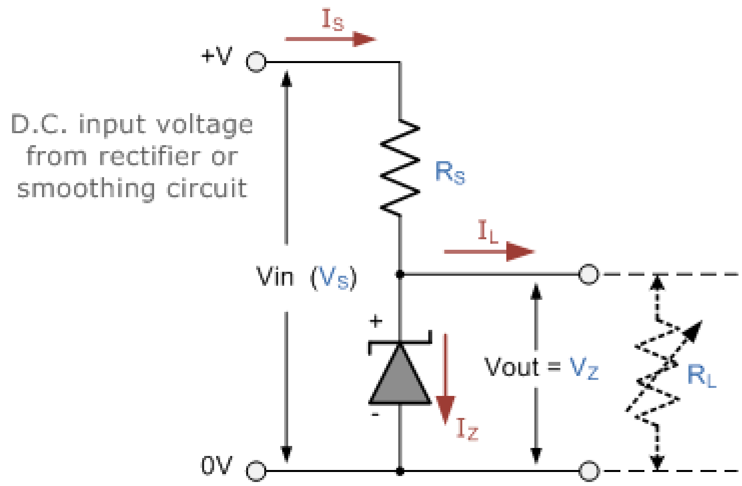
A capacitor gives an infinite reactance to DC .For DC, f=0

$$\mathbf{X_c = 1/\ 2\pi fc = 1/2\pi \times 0 \times C = infinite}$$

Therefore, a capacitor doesn’t permit DC to flow through it.

The capacitor filter circuit is very famous due to its features like low cost, less weight, small size, & good characteristics. The capacitor filter circuit is applicable for small load currents.

WORKING OF SIMPLE ZENER VOLTAGE REGULATOR



Resistor, R_S is connected in series with the zener diode to limit the current flow through the diode with the voltage source, V_S being connected across the combination. The stabilised output voltage V_{out} is taken from across the zener diode.

The zener diode is connected with its cathode terminal connected to the positive rail of the DC supply so it is reverse biased and will be operating in its breakdown condition. Resistor R_S is selected so to limit the maximum current flowing in the circuit.

With no load connected to the circuit, the load current will be zero, ($I_L = 0$), and all the circuit current passes through the zener diode which in turn dissipates its maximum power. Also a small value of the series resistor R_S will result in a greater diode current when the load resistance R_L is connected and large as this will increase the power dissipation requirement of the diode so care must be taken when selecting the appropriate value of series resistance so that the zener's maximum power rating is not exceeded under this no-load or high-impedance condition.

The load is connected in parallel with the zener diode, so the voltage across R_L is always the same as the zener voltage, ($V_R = V_Z$). There is a minimum zener current for which the stabilisation of the voltage is effective and the zener current must stay above this value operating under load within its breakdown region at all times. The upper limit of current is of course dependant upon the power rating of the device. The supply voltage V_S must be greater than V_Z.

One small problem with zener diode stabiliser circuits is that the diode can sometimes generate electrical noise on top of the DC supply as it tries to stabilise the voltage.

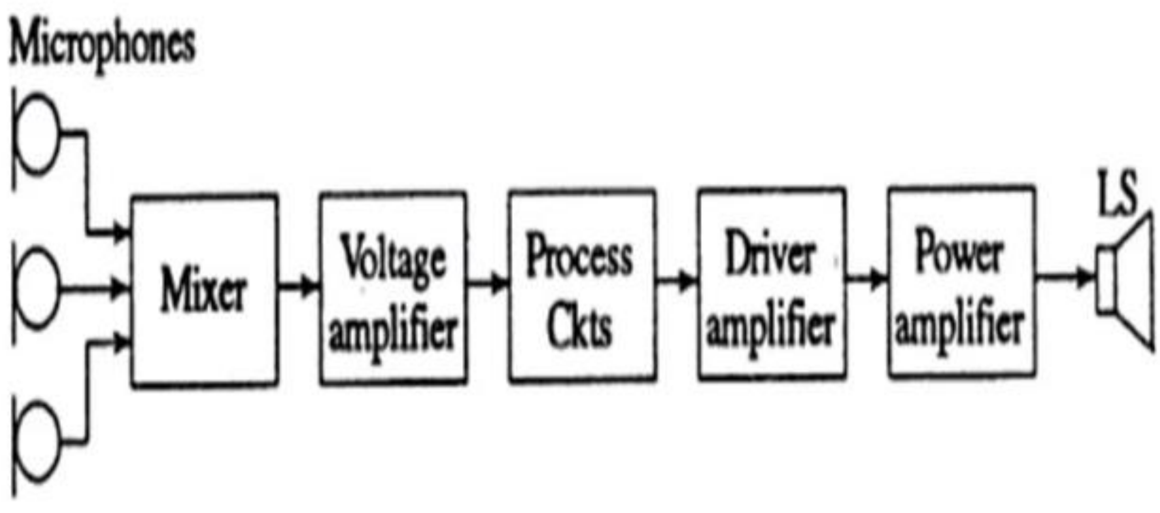
Normally this is not a problem for most applications but the addition of a large value decoupling capacitor across the zener's output may be required to give additional smoothing.

Then to summarise a little. A zener diode is always operated in its reverse biased condition. As such a simple voltage regulator circuit can be designed using a zener diode to maintain a constant DC output voltage across the load in spite of variations in the input voltage or changes in the load current.

The zener voltage regulator consists of a current limiting resistor R_S connected in series with the input voltage V_S with the zener diode connected in parallel with the load R_L in this reverse biased condition. The stabilised output voltage is always selected to be the same as the breakdown voltage V_Z of the diode.

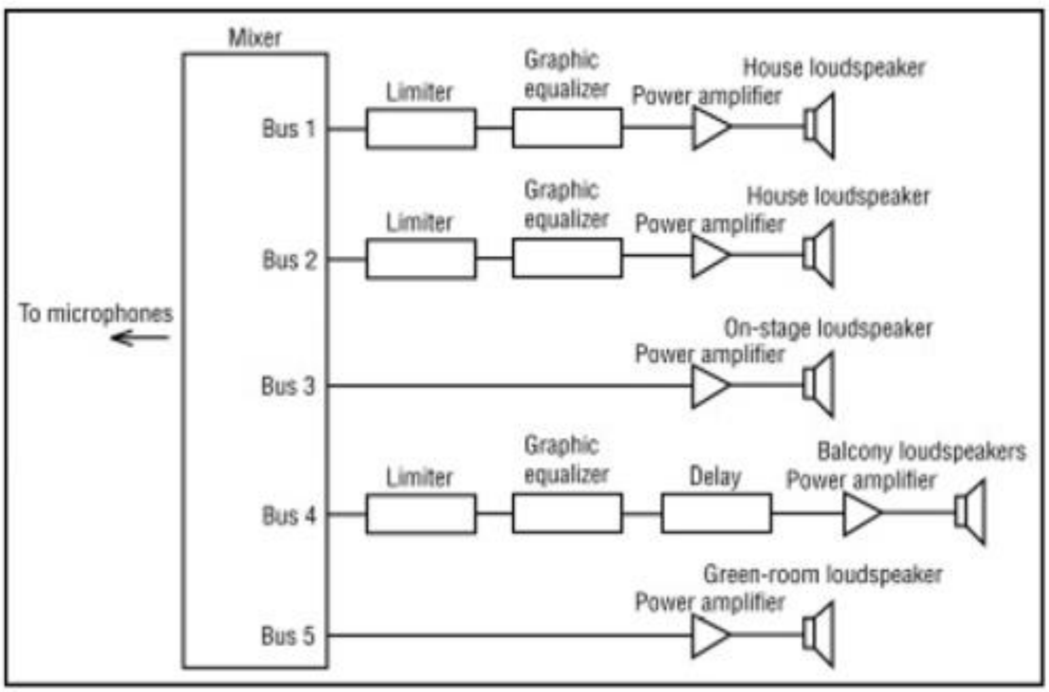
BLOCK DIAGRAM OF PUBLIC ADDRESS SYSTEM

PA system is an electronic sound amplification and distribution system with a microphone, amplifiers and loudspeakers used in many applications such as addressing a large public,announcements in offices and institutions etc.



- Microphone :- Its pic up a sound wave and convert them into electrical variation, called sound signal.
- Mixer:- It is for effectively isolate different channels from each other before feeding to the main amplifier.
- Voltage amplifier:- Its amplifies the output of the mixer.
- Processing circuit:- This circuit have master gain control and tone control (bass and treble control).

- Driver amplifier:- It gives voltage amplification to such extent that internal resistance of that stage is reduced. thus, it drives the power amplifier to give more power.
- Power amplifier:- It gives the desire power amplification to the signal.
- Loudspeaker:- It converts electrical audio signal into pressure variation resulting in sound.



- **Equalization** is the process of altering the frequency response of an audio system using filters.
- It adjusts the amplitude of audio signals at particular frequencies.
- Equalization may also be used to eliminate unwanted signals,make certain instruments or voices more prominent.
- **Graphic equalizer:-** allows the user to see graphically and
- control individually a number of different frequency bands.
- Low frequency (popularly called bass) of the signal is amplified
- and converted into audio using low frequency
- speakers(popularly called woofers).
- Similarly high frequency audio signals are amplified and fed to
- high frequency loud speakers.

RC Coupled Amplifier

A **Resistance Capacitance (RC) Coupled Amplifier** is basically a multi-stage amplifier circuit extensively used in electronic circuits. Here the individual stages of the amplifier are connected together using a resistor–capacitor combination due to which it bears its name as RC Coupled.

Figure 1 shows such a two-stage amplifier whose individual stages are nothing but the common emitter amplifiers. Hence the design of individual stages of the **RC coupled amplifiers** is similar to that in the case of common emitter amplifiers in which the resistors R_1 and R_2 form the biasing network while the emitter resistor RE form the stabilization network. Here the C_E is also called bypass capacitor which passes only AC while restricting DC, which causes only DC voltage to drop across R_E while the entire AC voltage will be coupled to the next stage.

Further, the coupling capacitor C_C also increases the stability of the network as it blocks the DC while offers a low resistance path to the AC signals, thereby preventing the DC bias conditions of one stage affecting the other. In addition, in this circuit, the voltage drop across the collector-emitter terminal is chosen to be 50% of the supply voltage V_{CC} inorder to ensure appropriate biasing point.

In this kind of amplifier, the input signal applied at the base of the transistor in stage 1 (Q_1) is amplified and appears at its collector terminal with a phase-shift of 180°.
The AC component of this signal is coupled to the second stage of the **RC coupled amplifier** through the coupling capacitor C_C and thus appears as an input at the base of the second transistor Q_2. This is further amplified and is passed-on as an output of the second stage and is available at the collector terminal of Q_2 after being shift by 180° in its phase. This means that the output of the second stage will be 360° out-of-phase with respect to the input, which inturn indicates that the phase of the input signal and the phase of the output signal obtained at stage II will be identical.

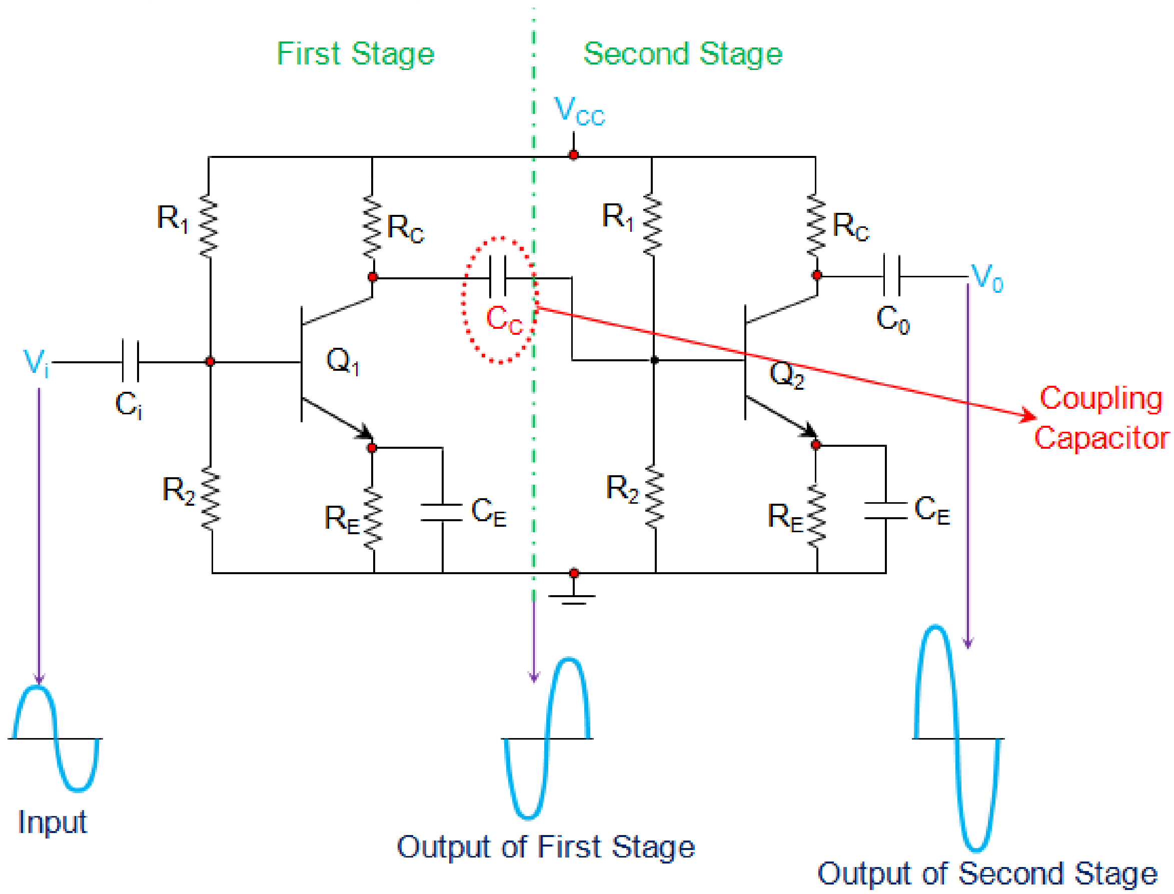
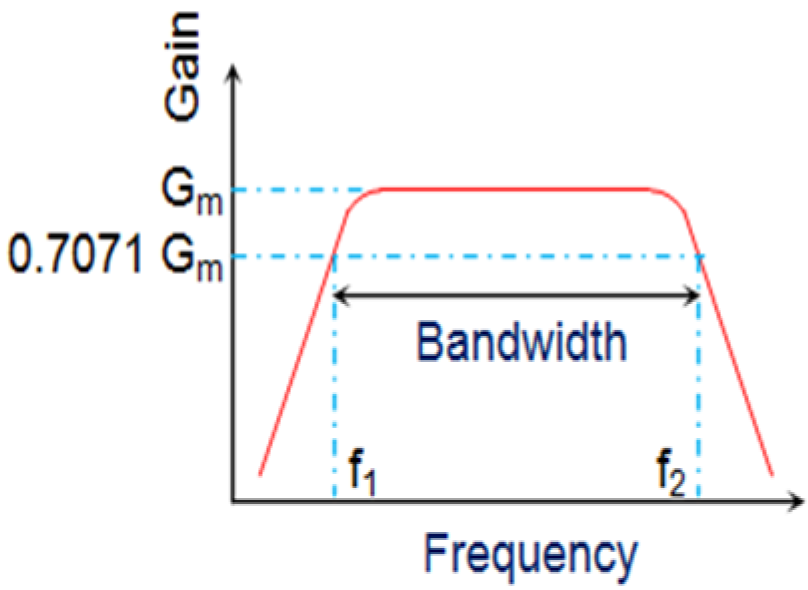


Figure 1 Two-Stage RC Coupled Amplifier

Further it is to be noted that the cascading of individual amplifier stages increases the gain of the overall circuit as the net gain will be the product of the gain offered by the individual stages. However in real scenario, the net gain will be slightly less than this, due to the loading effect. In addition, it is important to note that by following the pattern exhibited by Figure 1, one can cascade any number of common emitter amplifiers but by keeping in mind that when the number of stages are even, the output will be in-phase with the input while if the number of stages are odd, then the output and the input will be out-of-phase.

Frequency Response of RC Coupled Amplifier

Frequency response curve is a graph that indicates the relationship between voltage gain and function of frequency. The frequency response of a RC coupled amplifier is as shown in the following graph.



From the above graph, it is understood that the frequency rolls off or decreases for the frequencies below F_1 and for the frequencies above F_2. Whereas the voltage gain for the range of frequencies between F_1 and F_2 is constant.

We know that,

$$XC=1/2\pi fc$$

It means that the capacitive reactance is inversely proportional to the frequency

At Low frequencies (i.e. below 50 Hz)

The capacitive reactance is inversely proportional to the frequency. At low frequencies, the reactance is quite high. The reactance of input capacitor C_{in} and the coupling capacitor C_C are so high that only small part of the input signal is allowed. The reactance of the emitter by pass capacitor C_E is also very high during low frequencies. Hence it cannot shunt the emitter resistance effectively. With all these factors, the voltage gain rolls off at low frequencies.

At High frequencies (i.e. above 20 KHz)

Again considering the same point, we know that the capacitive reactance is low at high frequencies. So, a capacitor behaves as a short circuit, at high frequencies. As a result of this, the loading effect of the next stage increases, which reduces the voltage gain. Along with this, as the capacitance of emitter diode decreases, it increases the base current of the transistor due to which the current gain (β) reduces. Hence the voltage gain rolls off at high frequencies.

At Mid-frequencies (i.e. 50 Hz to 20 KHz)

The voltage gain of the capacitors is maintained constant in this range of frequencies, as shown in figure. If the frequency increases, the reactance of the capacitor C_C decreases which tends to increase the gain. But this lower capacitance reactive increases the loading effect of the next stage by which there is a reduction in gain.

Due to these two factors, the gain is maintained constant.

Advantages of RC Coupled Amplifier

The following are the advantages of RC coupled amplifier.

- The frequency response of RC amplifier provides constant gain over a wide frequency range, hence most suitable for audio applications.
- The circuit is simple and has lower cost because it employs resistors and capacitors which are cheap.
- It becomes more compact with the upgrading technology.

Disadvantages of RC Coupled Amplifier

The following are the disadvantages of RC coupled amplifier.

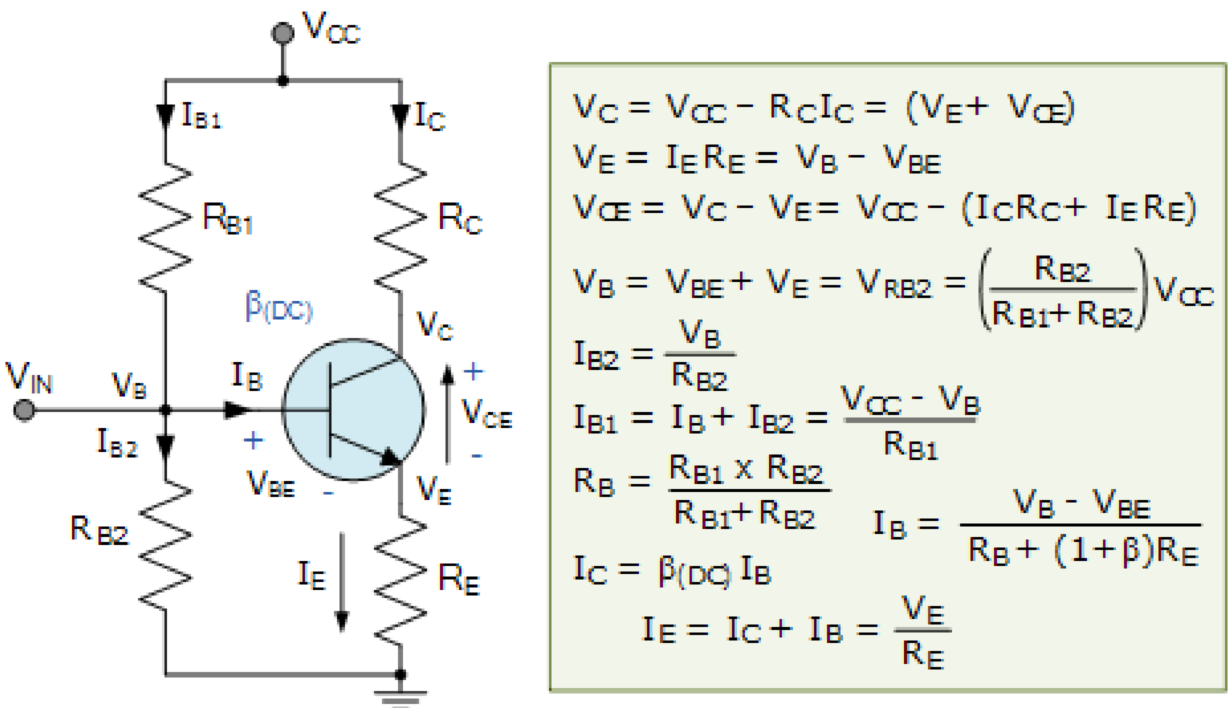
- The voltage and power gain are low because of the effective load resistance.
- They become noisy with age.
- Due to poor impedance matching, power transfer will be low.

Applications of RC Coupled Amplifier

The following are the applications of RC coupled amplifier.

- They have excellent audio fidelity over a wide range of frequency.
- Widely used as Voltage amplifiers
- Due to poor impedance matching, RC coupling is rarely used in the final stages.

<u>CONCEPT OF VOLTAGE DIVIDER BIASING</u>



Here the common emitter transistor configuration is biased using a voltage divider network to increase stability. The name of this biasing configuration comes from the fact that the two resistors R_{B1} and R_{B2} form a voltage or potential divider network across the supply with their center point junction connected the transistors base terminal as shown.

This voltage divider biasing configuration is the most widely used transistor biasing method. The emitter diode of the transistor is forward biased by the voltage value developed across resistor R_{B2}. Also, voltage divider network biasing makes the transistor circuit independent of changes in beta as the biasing voltages set at the transistors base, emitter, and collector terminals are not dependant on external circuit values.

To calculate the voltage developed across resistor R_{B2} and therefore the voltage applied to the base terminal we simply use the voltage divider formula for resistors in series.

Generally the voltage drop across resistor R_{B2} is much less than for resistor R_{B1}. Clearly the transistors base voltage V_B with respect to ground, will be equal to the voltage across R_{B2}.

The amount of biasing current flowing through resistor R_{B2} is generally set to 10 times the value of the required base current I_B so that it is sufficiently high enough to have no effect on the voltage divider current or changes in Beta.

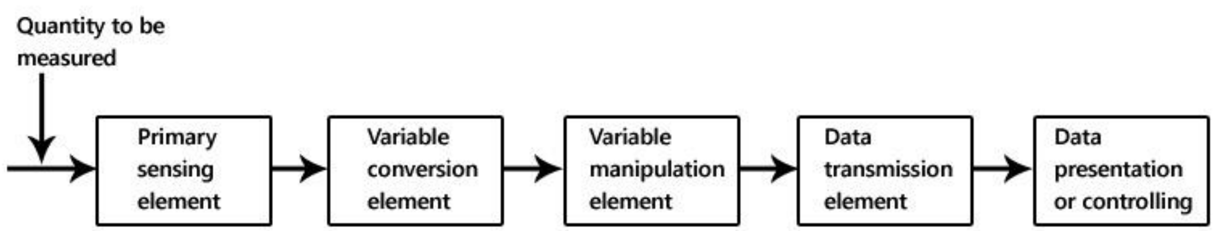
The goal of **Transistor Biasing** is to establish a known quiescent operating point, or Q-point for the bipolar transistor to work efficiently and produce an undistorted output signal. Correct DC biasing of the transistor also establishes its initial AC operating region with practical biasing circuits using either a two or four-resistor bias network.

In bipolar transistor circuits, the Q-point is represented by (V_{CE}, I_C) for the NPN transistors or (V_{EC}, I_C) for PNP transistors. The stability of the base bias network and therefore the Q-point is generally assessed by considering the collector current as a function of both Beta (β) and temperature.

Here we have looked briefly at five different configurations for "biasing a transistor" using resistive networks. But we can also bias a transistor using either silicon diodes, zener diodes or active networks all connected to the transistors base terminal. We could also correctly bias the transistor from a dual voltage power supply if so wished.

BLOCK DIAGRAM OF INSTRUMENTATION SYSTEM

It is branch of engineering which deals with various types of instrument to record, monitor, indicate and control various physical parameters such as pressure, temperature, etc.



The block diagram shown above is of basic instrumentation system. It consist of primary sensing element, variable manipulation element, data transmission element and data presentation element.

Primary sensing element

The primary sensing element is also known as sensor. Basically transducers are used as a primary sensing element. Here, the physical quantity (such as temperature, pressure etc.) are sensed and then converted into analogues signal.

Variable conversion element

It converts the output of primary sensing element into suitable form without changing information. Basically these are secondary transducers.

Variable manipulation element

The output of transducer may be electrical signal i.e. voltage, current or other electrical parameter. Here, manipulation means change in numerical value of signal. This element is used to convert the signal into suitable range.

Data transmission element

Sometimes it is not possible to give direct read out of the quality at a particular place (Example – Measurement of temperature in the furnace). In such a case, the data should transfer from one place to another place through channel which is known as data transmission element. Typically transmission path are pneumatic pipe, electrical cable and radio links. When radio link is used, the electronic instrumentation system is called as telemetry system.

Data presentation or controlling element

Finally the output is recorded or given to the controller to perform action. It performs different functions like indicating, recording or controlling.

MODULE 6

EVOLUTION OF COMMUNICATION SYSTEMS

Just a few generations ago, our ancestors were dependent on what is now considered primitive communications technology. But it's all relative. Wired telegraphy that criss-crossed the United States was a major breakthrough in innovation.

Wireless telegraphy in the form of radio made it possible to carry on a conversation without the use of cables. And improvements in radio communications through the years have only expanded the range of service capabilities. Fifth-generation mobile telephony, known simply as 5G, is the latest invention to thrill and amaze the user.

A more recent telecommunications implementation was the use of semaphore by the French. In the 1700s, they built semaphore towers across the country, each at a distance of a few miles but still within sight. Using mechanically controlled flags, a French communications technician could pass messages along to the next tower. Using this method, a message could be transmitted across the country in short order.

These are just a couple of examples of wireless telecommunications (we left out carrier pigeon) that preceded the digital age. It was Guglielmo Marconi who pioneered the use of long-distance radio communication that forms the basis for all our current mobile telephony. At the heart of it all is the electromagnetic spectrum, which includes radio waves with frequencies ranging from 30 Hz to 300 GHz.

Long before mobile telephony was born, various technologies that it would employ were already in use. Push-to-talk (PTT) systems were being used by police and fire personnel. Powerful radio towers streamed news and entertainment across vast distances. AT&T offered a Mobile Telephone Service (MTS) as far back as 1949, and later introduced its Improved Mobile Telephone Service (IMTS) in 1965. Some people have given the name 0G to these mobile network predecessors.

The birth of 1G was a little more obvious. Nippon Telegraph and Telephone (NTT) in Japan rolled out the first generation (1G) of mobile telephony in 1979. Systems from other carriers were quickly to follow. There was an implementation of 1G by Nordic Mobile Telephone in 1981, standards such as Advance Mobile Phone System (AMPS) by Bell Labs in 1982 and C450 in Germany were propagated worldwide.

Second-generation (2G) was started in Finland in 1991. It was based on the GSM standard, and included the introduction of text messaging known as short message service (SMS), as well as other services. Later develops of 2g included general packet radio service (GPRS) and Enhanced Data Rates for GSM Evolution (EDGE).

With the advent of 3G, things started to get interesting. The internet boom of the late 1990s created a demand for users to go online with their mobile phones. The 3rd Generation Partnership Project (3GPP) was formed in 1998 to develop protocols and standards for 3G. It was a group effort by organizations from around the world. The result was the introduction of robust technologies, such as Wideband Code Division Multiple Access (WCDMA) and High Speed Packet Access (HSPA), that made web access at high speeds and capacities possible.

4G, known as Long-term Evolution (LTE), was a whole restructuring of mobile telephony. It was a new way of doing mobile. In fact, they gave the name Systems Architecture Evolution (SAE) to its core network. The Evolved Packet Core (EPC) includes the mobile management entity (MME), the serving gateway (SGW), the PDN gateway (PGW), and the home subscriber server (HSS). On the radio side, the eNodeB takes signals received through the air interface from mobile handsets and transmits them through network interfaces to the core network. LTE took wireless telephony to a whole new level of sophistication.

And now 5G is upon us. Verizon has already started to roll out its 5G Home and its 5G Mobile. Other carriers are hot on their heels. Like 4G, 5G promises to be a whole new rethink of wireless. The final publication of standards is slated for next year as part of the IMT-2020 Vision created by the ITU-T and 3GPP. But it won’t be entirely new. 5G will borrow and build upon technologies from previous generations.

5G is the fifth generation wireless technology for digital cellular networks that began wide deployment in 2019. As with previous standards, the covered areas are divided into regions called "cells", serviced by individual antennas. Virtually every major telecommunication service provider in the developed world is deploying antennas or intends to deploy them soon. The frequency spectrum of 5G is divided into millimeter waves, mid-band and low-band. Low-band uses a similar frequency range as the predecessor, 4G.

RADIO COMMUNICATION:

NEED FOR MODULATION

- It is because modulation makes the information **signal more compatible** with the medium.
- **Modulation =** Imposing information at low frequency onto a higher frequency signal.
- A technique for transmitting information efficiently from one place to another.
- Simplest form of modulation is the amplitude modulation.

PRINCIPLES OF AM

- AM is defined as:
  - Amplitude of carrier frequency change proportionately to the value of the modulation signal.
- Advantages:
  - Simple modulator circuits
  - Cheap :low-quality form of modulation used for commercial broadcasting of audio & video signal.
- Disadvantages:
  - Poor performance due to noise
  - Inefficient use of transmitter power.
- Application:
  - 2 way radio communications, broadcasting, aircraft comm. & citizen band (CB) radio.

- AM modulators are nonlinear devices
  - 2 input and 1 output: modulating signal and carrier signal.
- Several types of amplitude modulation
  - AM DSBFC
  - DSB-SC
  - SSB
- AM generation is shown in Figure 2.1
- Modulated wave = AM envelope as shown in Figure 2.2

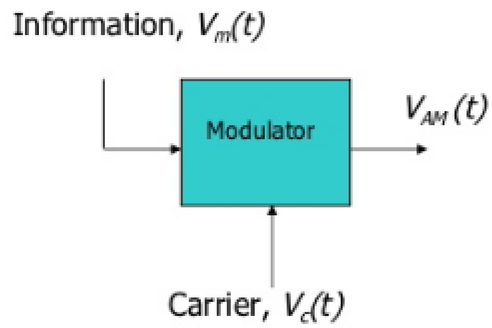
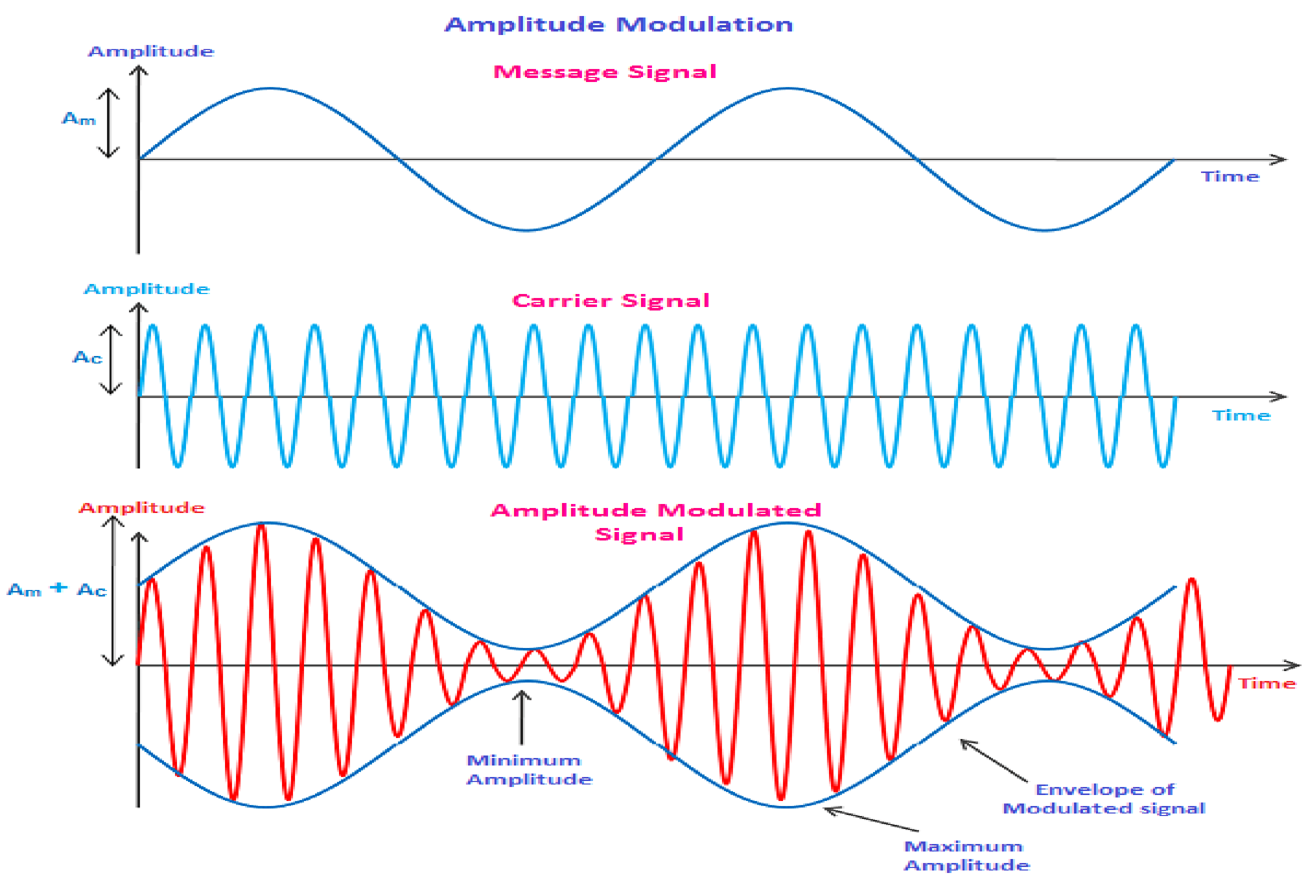


Figure 2.1: Block diagram of Amplitude Modulation



DERIVATION OF AM EQUATION

- AM begins with carrier v_c, → a sine wave with frequency f_c & amplitude V_c:

  $$v_c = V_c \sin 2\pi f_c t$$

- Modulating signal:

  $$v_m = V_m \sin 2\pi f_m t$$

- Then AM is:

$$V_{env} = V_c + v_m$$

$$V_{env} = V_c + V_m \sin 2\pi f_m t \qquad [m = V_m / V_c]$$

$$V_{env} = V_c + m V_c \sin 2\pi f_m t$$

- Where *m (modulation index)* is defined as V_m/V_c, hence:

  $$V_{env} = V_c(1 + m \sin 2\pi f_m t)$$

- The voltage resulting AM wave envelope at any instant is:

  $$v = V_{env} \sin 2\pi f_c t$$
  $$= V_c(1 + m \sin 2\pi f_m t) \bullet \sin 2\pi f_c t$$

Using Trigo ID

$$(\sin a)(\sin b) = 1/2[\cos(a-b) - \cos(a+b)]$$

$$v = V_c \sin 2\pi f_c t + \frac{m}{2} V_c \cos 2\pi (f_c - f_m)t - \frac{m}{2} V_c \cos 2\pi (f_c + f_m)t$$

$$v_{AM} = V_c \sin 2\pi f_c t + \frac{V_m}{2} \cos 2\pi (f_c - f_m)t - \frac{V_m}{2} \cos 2\pi (f_c + f_m)t$$

Carrier — LSB — USB

- This yield, the upper and lower sidebands – frequency & amplitude.

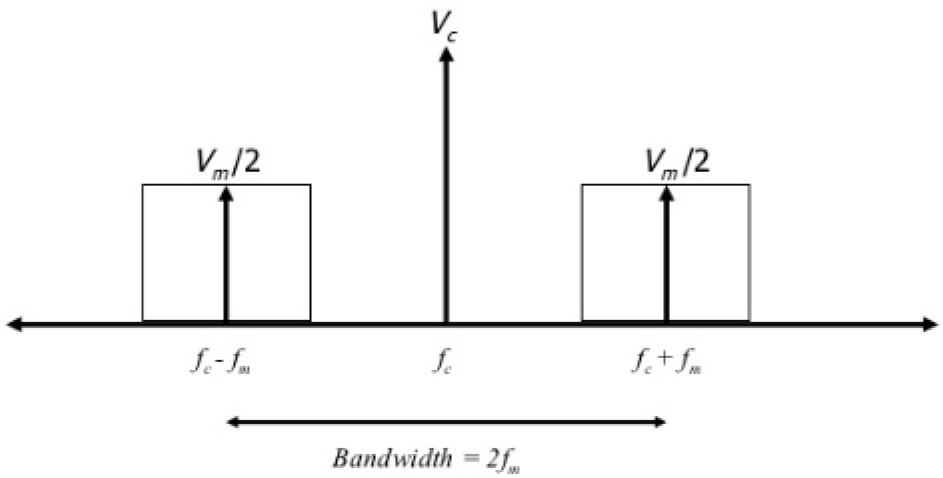
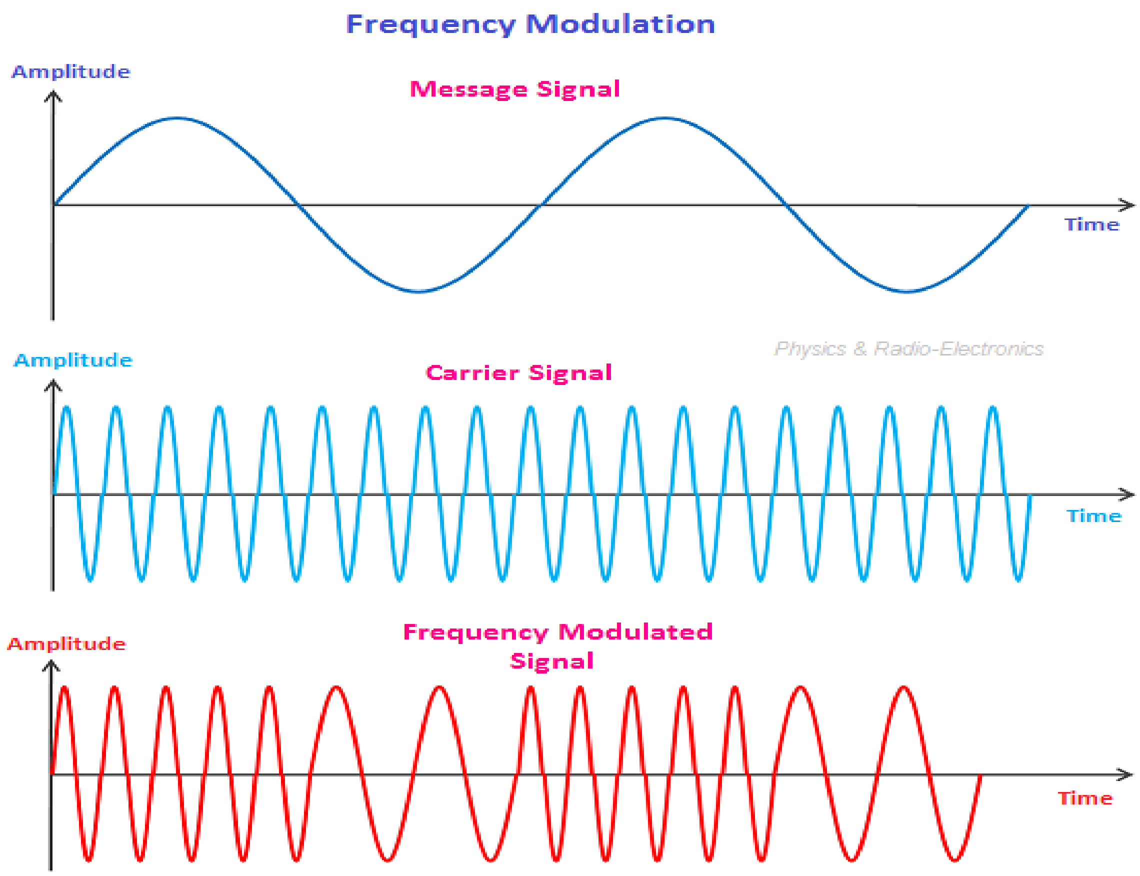


Figure 2.3: Frequency spectrum for AM wave

Principles of FM

- A sine wave carrier can be modified for the purpose of transmitting information from one place to another by varying its frequency. This is known as **frequency modulation (FM).**
- In FM, the carrier amplitude remains constant and the carrier frequency is changed by the modulating signal

- **Frequency deviation (f_d)** is the amount of change in carrier frequency produced by the modulating signal.
- The **frequency deviation rate** is how many times per second the carrier frequency deviates above or below its center frequency.
- The frequency of the modulating signal determines the frequency deviation rate.
- A type of modulation called **frequency-shift keying (FSK)** is used in transmission of binary data in digital cell phones and low-speed computer modems.



Mathematical analysis of FM

- Mathematical analysis:
- Let message signal:

$$v_m(t) = V_m \cos \varpi_m t$$

- And carrier signal:

$$v_c(t) = V_c \cos[\varpi_c t + \theta]$$

- During the process of frequency modulations the frequency of carrier signal is changed in accordance with the instantaneous amplitude of message signal. Therefore the frequency of carrier after modulation is written as

$$\omega_i = \omega_c + K_1 v_m(t) = \omega_C + K_1 V_m \cos\omega_m t$$

- To find the instantaneous phase angle of modulated signal, integrate equation above w.r.t. ***t***

$$\phi_i = \int \omega_i dt = \int (\omega_C + K_1 V_m \cos\omega_m t) dt = \omega_C t + \frac{K_1 V_m}{\omega_m} \sin\omega_m t$$

- Thus, we get the FM wave as:

$$v_{FM}(t) = Vc\cos\phi_1 = V_C\cos(\omega_C t + \frac{K_1 V_m}{\omega_m}\sin\omega_m t)$$

$$v_{FM}(t) = V_C\cos(\omega_C t + m_f \sin\omega_m t)$$

- Where modulation index for FM is given by

$$m_f = \frac{K_1 V_m}{\omega_m}$$

  - Therefore:

$$\Delta f = K_1 V_m;$$

$$m_f = \frac{\Delta f}{f_m}$$

  - K_l – deviation sensitivities Hz/V

FREQUENCY BAND USED FOR VARIOUS COMMUNICATION

Frequency Band		Frequency	Frequency Band Use
Radio and Broadcast		600 kHz to 1.6 MHz	AM radio
		88 to 108 MHz	FM radio
		54 to 700 MHz	TV broadcast
Microwave	L band	1 to 2 GHz	Cell phones 0.9-2.4 GHz Microwave 2.4 GHz Wireless Data 2.4 GHz Radar 1-100 GHz
	S band	2 to 4 GHz	
	C band	4 to 8 GHz	
	X band	8 to 12 GHz	
	K_u band	12 to 18 GHz	
	K band	18 to 26.5 GHz	
	K_a band	26.5 to 40 GHz	
	Q band	30 to 50 GHz	
	U band	40 to 60 GHz	
	V band	50 to 75 GHz	
	E band	60 to 90 GHz	
	W band	75 to 110 GHz	
	F band	90 to 140 GHz	
	D band	110 to 170 GHz	
Terahertz		1 to 10 THz	Bio-imaging
Infrared		300 to 400 THz	Remotes, night vision
Visible Light		400 to 800 THz	
Ultraviolet		800 THz to 30 PHz	Dental curing, tanning
X-ray		30 PHz to 30 EHz	Baggage screening
Gamma		> 30 EHz	PET imaging

SUPER HETERODYNE RECEIVER

A superheterodyne receiver usesfrequency mixing to convert a received signal to a fixedintermediate frequency (IF) which can be more conveniently processed than the original radio carrier frequency. The word "super" referrers to "super-sonic" (ultra-sonic today) meaning the IF frequency was superior to or above human hearing. Heterodyne means to mix two frequencies in a non linear device or translate one frequency to another. The name “Superheterodyne” receiver is sometimes shortened to “superhet”.

The basic block diagram of a superheterodyne receiver is shown in the following figure.The way in which the receiver works can be seen by following the signal as is passes through the receiver.

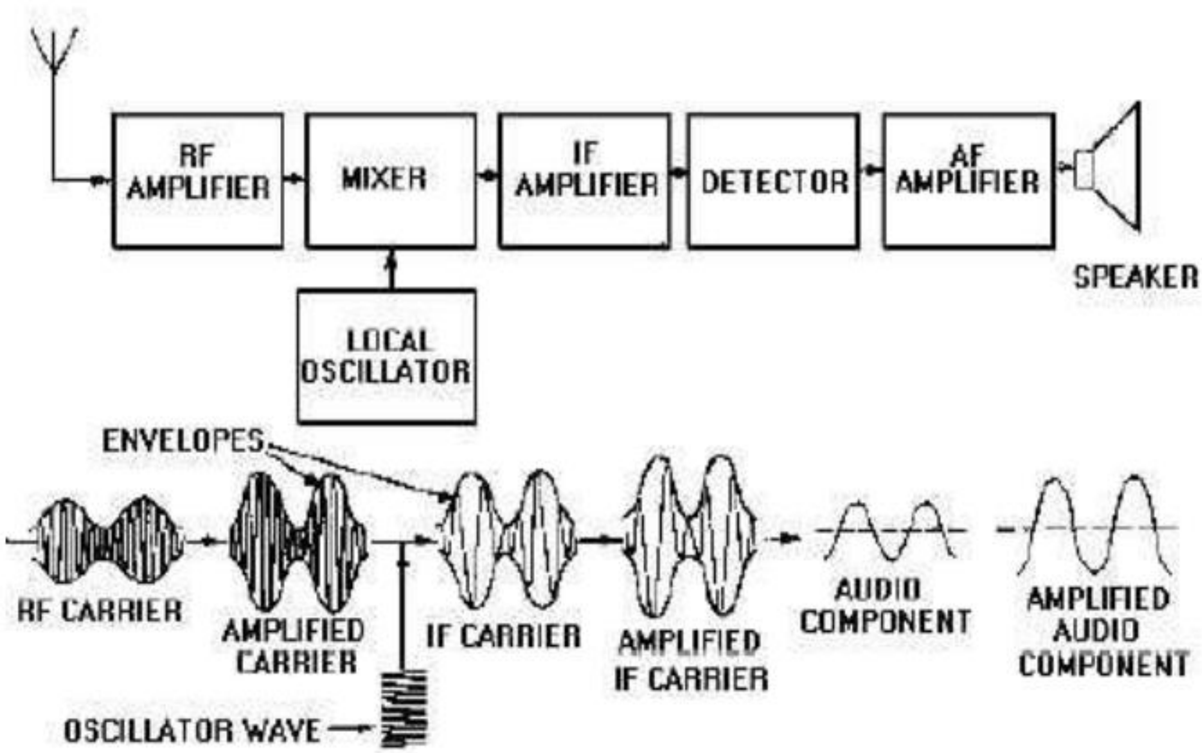


Fig: Block diagram of Superheterodyne Receiver

Front end amplifier and tuning block: Signals enter the front end circuitry from the antenna. This circuit block performs two main functions:

Tuning:- Broadband tuning is applied to the RF stage. The purpose of this is to reject the signals on the image frequency and accept those on the wanted frequency. It must also be able to track the local oscillator so that as the receiver is tuned, so the RF tuning remains on the required frequency. Typically the selectivity provided at this stage is not high. Its main purpose is to reject signals on the image frequency which is at a frequency equal to twice that of the IF away from the wanted frequency. As the tuning within this block provides all the rejection for the image response, it must be at a sufficiently sharp to reduce the image to an acceptable level. However the RF tuning may also help in preventing strong off-channel signals from entering the receiver and overloading elements of the receiver, in particular the mixer or possibly even the RF amplifier.

Amplification:- In terms of amplification, the level is carefully chosen so that it does not overload the mixer when strong signals are present, but enables the signals to be amplified sufficiently to ensure a good signal to noise ratio is achieved. The amplifier must also be a low noise design. Any noise introduced in this block will be amplified later in the receiver.

Mixer / frequency translator block: The tuned and amplified signal then enters one port of the mixer. The local oscillator signal enters the other port. The performance of the mixer is crucial to many elements of the overall receiver performance. It should be as linear as possible. If not, then spurious signals will be generated and these may appear as 'phantom' received signals.

Local oscillator: The local oscillator may consist of a variable frequency oscillator that can be tuned by altering the setting on a variable capacitor. Alternatively it may be a frequency synthesizer that will enable greater levels of stability and setting accuracy.

Intermediate frequency amplifier, IF block : Once the signals leave the mixer they enter the IF stages. These stages contain most of the amplification in the receiver as well as the filtering that enables signals on one frequency to be separated from those on the next. Filters may consist simply of LC tuned transformers providing inter-stage coupling, or they may be much higher performance ceramic or even crystal filters, dependent upon what is required.

Detector / demodulator stage: Once the signals have passed through the IF stages of the superheterodyne receiver, they need to be demodulated. Different demodulators are required for different types of transmission, and as a result some receivers may have a variety of demodulators that can be switched in to accommodate the different types of transmission that are to be encountered.

Audio amplifier: The output from the demodulator is the recovered audio. This is passed into the audio stages where they are amplified and presented to the headphones or loudspeaker.

PRINCIPLE OF ANTENNA – RADIATION FROM ACCELERATED CHARGE

Antenna is a source or radiator of Electromagnetic waves or a sensor of Electromagnetic waves. It is a transition device or transducer between a guided wave and a free space wave or vice versa. It is also an electrical conductor or system of conductors that radiates EM energy into or collects EM energy from free space. Antennas function by transmitting or receiving electromagnetic (EM) waves. Examples of these electromagnetic waves include the light from the sun and the waves received by your cell phone or radio. Your eyes are basically "receiving antennas" that pick up electromagnetic waves that are of a particular frequency. The colors that you see (red, green, blue) are each waves of different frequencies that your eyes can detect. All electromagnetic waves propagate at the same speed in air or in space. This speed (the speed of light) is roughly 671 million miles per hour (1 billion kilometers per hour). This is roughly a million times faster than the speed of sound (which is about 761 miles per hour at sea level). The speed of light will be denoted as c in the equations that follow. We like to use "SI" units in science (length measured in meters, time in seconds, mass in kilograms):

$$c = 3 \times 10^{8} \text{ meter/second}$$

Some Antenna Types:

Wire Antennas- dipoles, loops and Helical

Aperture Antennas-Horns and reflectors

Array Antennas-Yagi, Log periodic

Patch Antennas- Microstrips, PIFAs

Basic Antenna Parameters:

A radio antenna may be defined as the structure associated with the region of transition between a guided wave and a free space wave or vice versa.

Principle:

Under time varying conditions, Maxwell's equations predict the radiation of EM energy from current source (or accelerated charge). This happens at all frequencies, but is insignificant as long as the size of the source region is not comparable to the wavelength. While transmission lines are designed to minimize this radiation loss, radiation into free space becomes main purpose in case ofAntennas. The basic principle of radiation is produced by accelerated charge. The basic equation of radiation is

$$I\,L = Q\,V\ (\mathrm{Ams}^{-1})$$

where,

I = Time changing current in Amps/sec

L = Length of the current element in meters

Q = Charge in Coulombs

V = Time changing velocity

Thus time changing current radiates and accelerated charge radiates. For steady state harmonic variation, usually we focus on time changing current. For transients or pulses, we focus on accelerated charge. The radiation is perpendicular to the acceleration and the radiated power is proportional to the square of IL or QV.

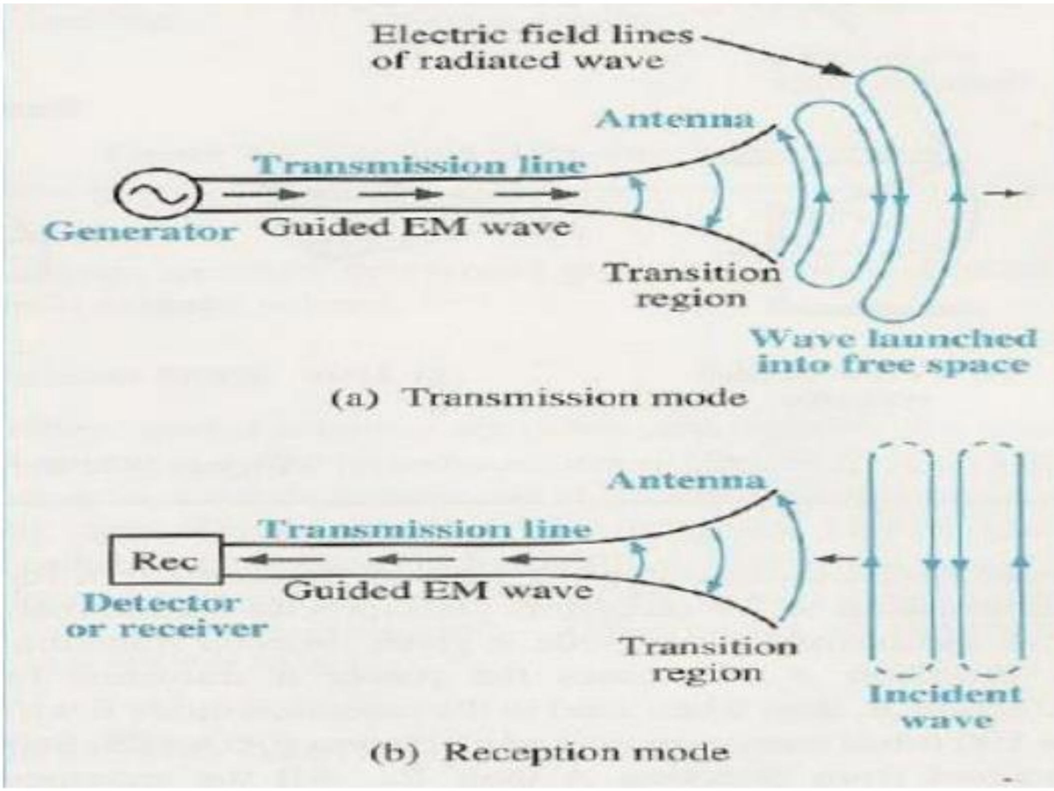
Transmission line opened out in a Tapered fashion as Antenna:

a). **As Transmitting Antenna:**

Here the Transmission Line is connected to source or generator at one end. Along the uniform part of the line energy is guided as Plane TEM wave with little loss. Spacing between line is a small fraction of λ. As the line is opened out and the separation between the two lines becomes comparable to λ, it acts like an antenna and launches a free space wave since currents on the transmission line flow out on the antenna but fields associated with them keep on going. From the circuit point of view the antennas appear to the transmission lines as a resistance Rr , called Radiation resistance.

b) **As Receiving Antenna:**

Active radiation by other Antenna or Passive radiation from distant objects raises the apparent temperature of Rr .This has nothing to do with the physical temperature of the antenna itself but is related to the temperature of distant objects that the antenna is looking at. Rr may be thought of as virtual resistance that does not exist physically but is a quantity coupling the antenna to distant regions of space via a virtual transmission line.



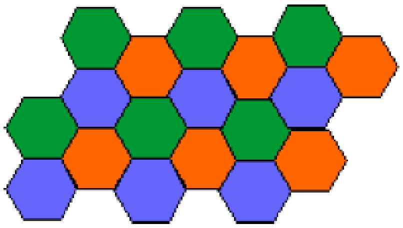
Thus, an antenna is a transition device, or transducer, between a guided wave and a free space wave or vice versa. The antenna is a device which interfaces a circuit and space.

MOBILE COMMUNICATION

Concepts of cells and Frequency reuse

In the cellular concept, frequencies allocated to the service are re-used in a regular pattern of areas, called 'cells', each covered by one base station. In mobile-telephone nets these cells are usually hexagonal. In radio broadcasting, a similar concept has been developed based on rhombic cells.

To ensure that the mutual interference between users remains below a harmful level, adjacent cells use different frequencies. In fact, a set of C different frequencies $\{f_1, \ldots, f_C\}$ are used for each cluster of C adjacent cells. Cluster patterns and the corresponding frequencies are re-used in a regular pattern over the entire service area.

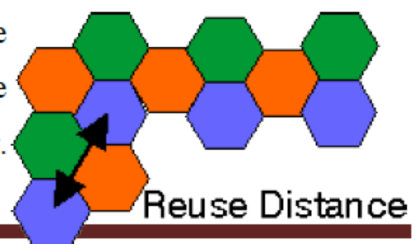


Real-World Cells

In the practice of cell planning, cells are not hexagonal as in the theoretical studies. Computer methods are being used for optimised planning of base station location and cell frequencies. Pathloss and link budgets are computed from the terrain features and antenna data. This determines to coverage of each base station and interference to other cells

Reuse Distance

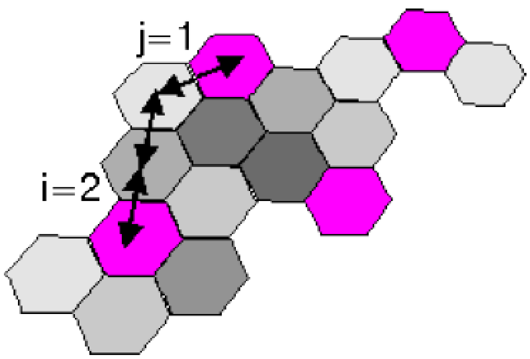
The closest distance between the centres of two cells using the same frequency (in different clusters) is determined by the choice of the cluster size C and the lay-out of the cell cluster.



This distance is called the frequency 're-use' distance. It can be shown that the reuse distance r_u, normalised to the size of each hexagon, is

r_u = SQRT{3 C}

For hexagonal cells, i.e., with 'honeycomb' cell lay-outs commonly used in mobile radio, possible cluster sizes are $C = i^2 + ij + j^2$, with integer i and j (C = 1, 3, 4, 7, 9, ...). Integers i and j determine the relative location of co-channel cells.

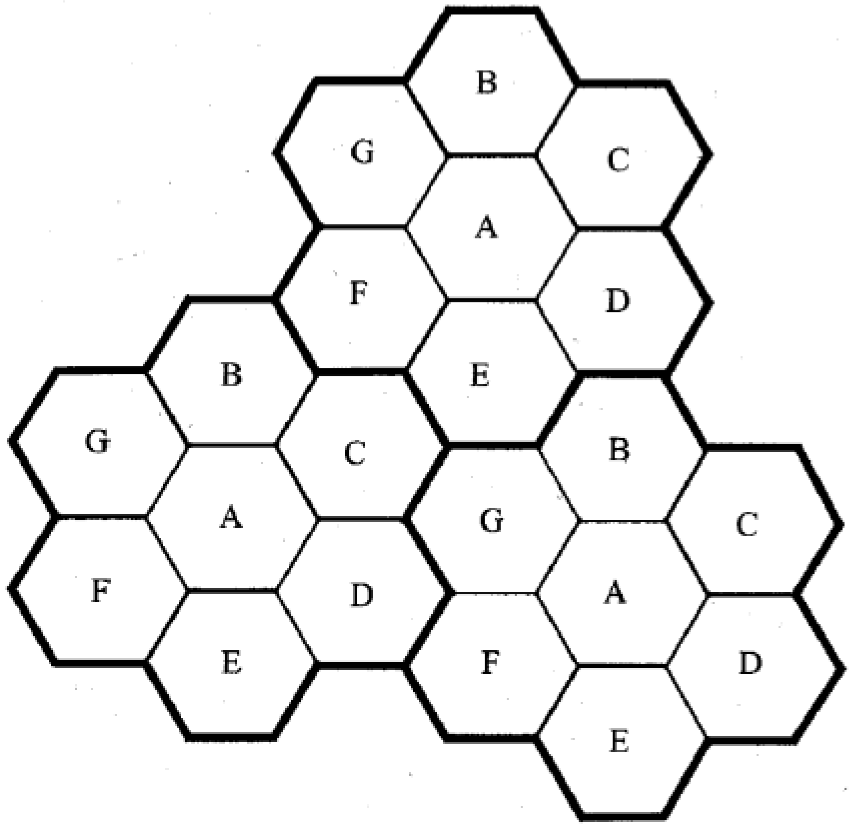


Cells

A cell is the basic geographic unit of a cellular system The term cellular comes from the honeycomb shape of the areas into which a coverage region is divided. Cells are base stations transmitting over small geographic areas that are represented as hexagons. Each cell size varies depending on the landscape. Because of constraints imposed by natural terrain and man-made structures, the true shape of cells is not a perfect hexagon.

Clusters

A cluster is a group of cells. No channels are reused within a cluster.

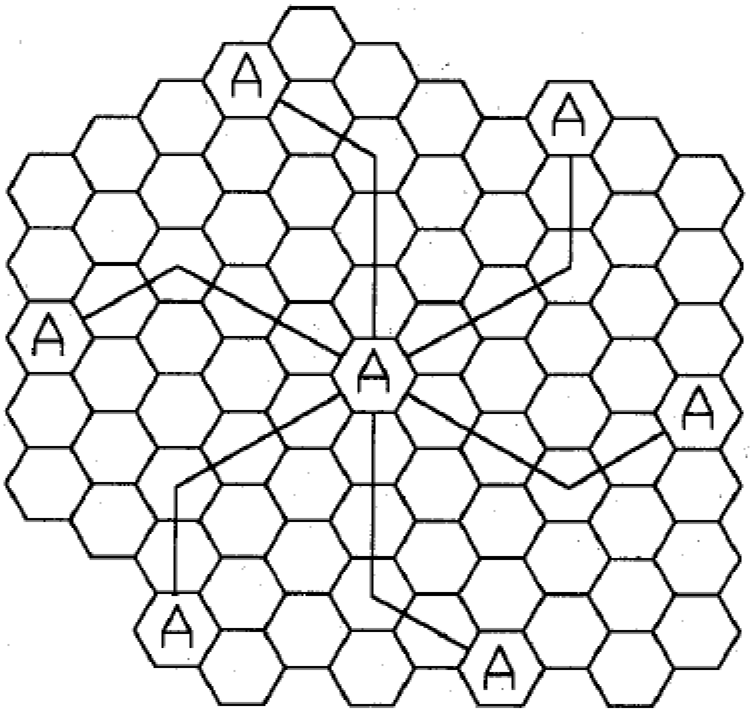


- seven groups of channel from A to G
- footprint of a cell - actual radio coverage
- omni-directional antenna v.s. directional antenna

Frequency Reuse

Because only a small number of radio channel frequencies were available for mobile systems, engineers had to find a way to reuse radio channels in order to carry more than one conversation at a time. The solution the industry adopted was called frequency planning or frequency reuse. Frequency reuse was implemented by restructuring the mobile telephone system architecture into the cellular concept The concept of frequency reuse is based on assigning to each cell a group of radio channels used within a small geographic area. Cells are assigned a group of channels that is completely different from neighboring cells. The coverage area of cells are called the footprint. This footprint is limited by a boundary so that the same group of channels can be used in different cells that are far enough away from each other so that their frequencies do not interfere.

- Consider a cellular system which has a total of *S* duplex channels.
- Each cell is allocated a group of *k* channels,
- The *S* channels are divided among *N* cells.
- The total number of available radio channels
- The *N* cells which use the complete set of channels is called *cluster*.
- The cluster can be repeated *M* times within the system. The total number of channels, *C*, is used as a measure of capacity
- The capacity is directly proportional to the number of replication *M*.
- The cluster size, *N*, is typically equal to 4, 7, or 12.
- Small *N* is desirable to maximize capacity.
- The frequency reuse factor is given by
- Hexagonal geometry has
    - exactly six equidistance neighbors
    - the lines joining the centers of any cell and each of its neighbors are separated by multiples of 60 degrees.
- Only certain cluster sizes and cell layout are possible.
- The number of cells per cluster, *N*, can only have values which satisfy
- Co-channel neighbors of a particular cell, ex, $i=3$ and $j=2$.

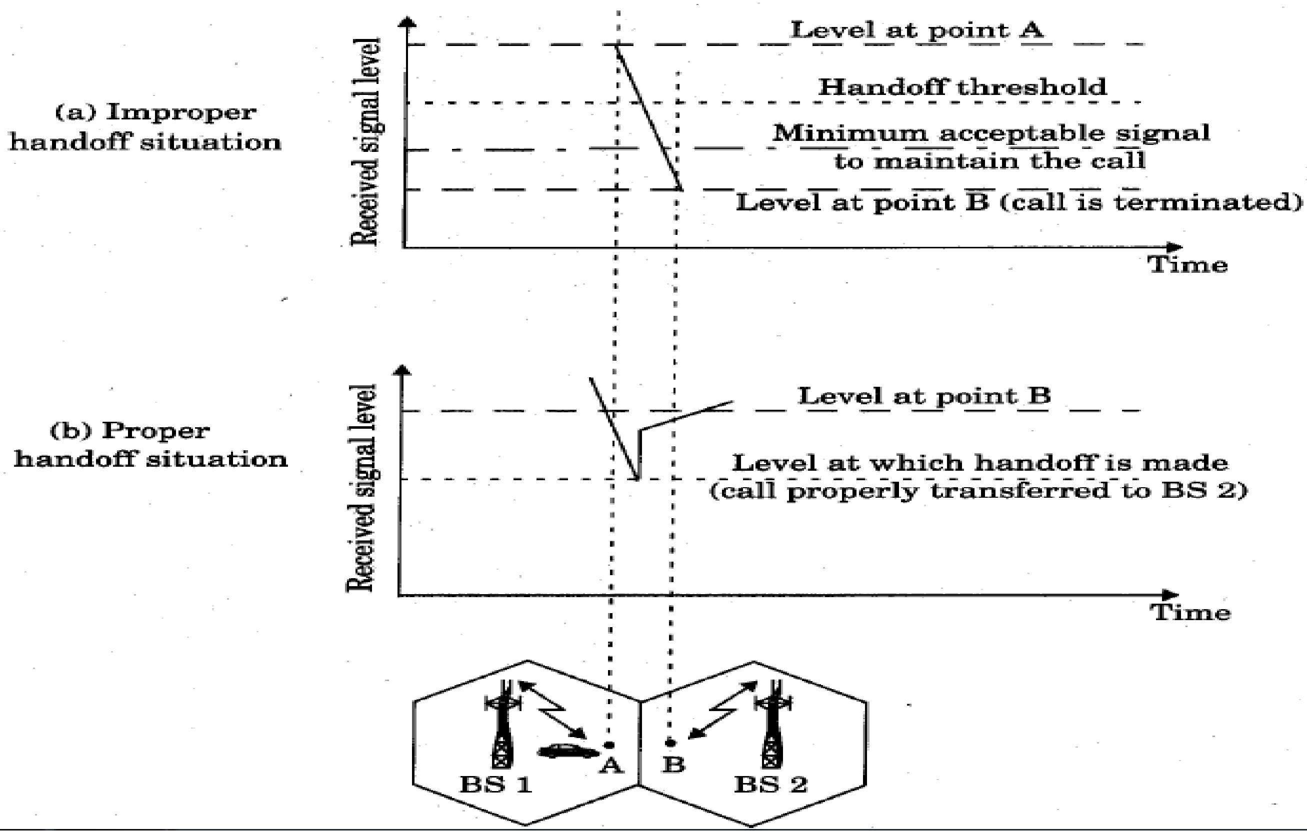


Cell Splitting

Unfortunately, economic considerations made the concept of creating full systems with many small areas impractical. To overcome this difficulty, system operators developed the idea of cell splitting. As a service area becomes full of users, this approach is used to split a single area into smaller ones. In this way, urban centers can be split into as many areas as necessary in order to provide acceptable service levels in heavy-traffic regions, while larger, less expensive cells can be used to cover remote rural regions Handoff The final obstacle in the development of the cellular network involved the problem created when a mobile subscriber traveled from one cell to another during a call. As adjacent areas do not use the same radio channels, a call must either be dropped or transferred from one radio channel to another when a user crosses the line between adjacent cells. Because dropping the call is unacceptable, the process of handoff was created. Handoff occurs when the mobile telephone network automatically transfers a call from radio channel to radio channel as A mobile crosses adjacent cells During a call, two parties are on one voice channel. When the mobile unit moves out of the coverage area of a given cell site, the reception becomes weak. At this point, the cell site in use requests a handoff. The system switches the call to a stronger-frequency channel in a new site without interrupting the call or alerting the user. The call continues as long as the user is talking, and the user does not notice the handoff at all

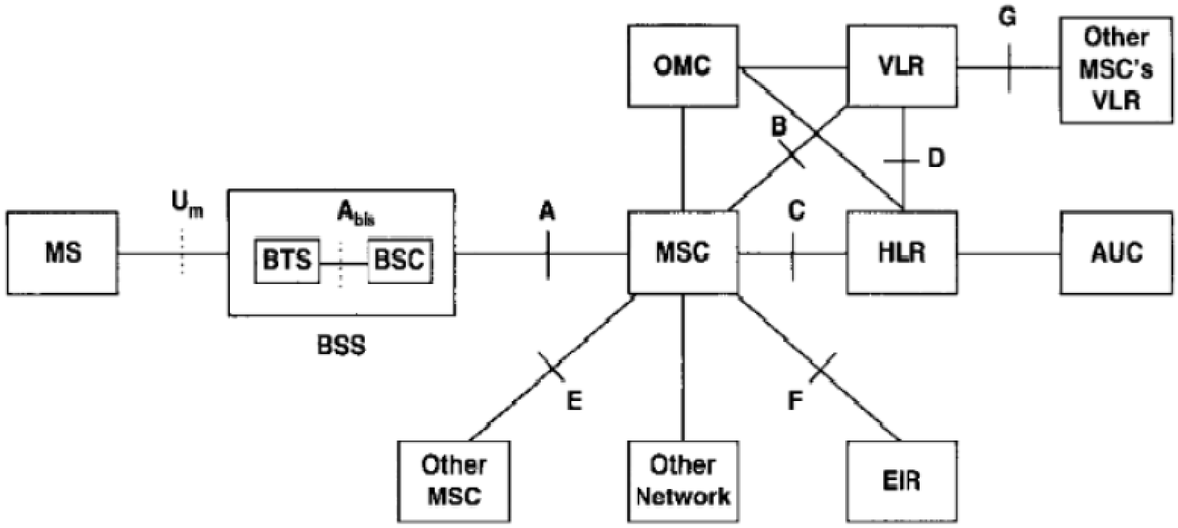
- When a mobile moves into a different cell while a conversation is in progress, the MSC automatically transfers the call to a new channel belonging to the new base station.
- Handoff operation
  - identifying a new base station
  - re-allocating the voice and control channels with the new base station.
- Handoff Threshold
  - Minimum usable signal for acceptable voice quality (-90dBm to -100dBm)
  - Handoff margin cannot be too large or too small.
  - If is too large, unnecessary handoffs burden the MSC

– If too small, there may be insufficient time to complete handoff before a call is lost.



- Handoff must ensure that the drop in the measured signal is not due to momentary fading and that the mobile is actually moving away from the serving base station.
- Running average measurement of signal strength should be optimized so that unnecessary handoffs are avoided.
  - Depends on the speed at which the vehicle is moving.
  - Steep short term average -> the hand off should be made quickly
  - The speed can be estimated from the statistics of the received short-term fading signal at the base station
- Dwell time: the time over which a call may be maintained within a cell without handoff.
- Dwell time depends on
  - propagation
  - interference
  - distance
  - speed
- Handoff measurement
  - In first generation analog cellular systems, signal strength measurements are made by the base station and supervised by the MSC.
  - In second generation systems (TDMA), handoff decisions are mobile assisted, called mobile assisted handoff (MAHO)
- Intersystem handoff: If a mobile moves from one cellular system to a different cellular system controlled by a different MSC.
- Handoff requests is much important than handling a new call.

Block diagram of GSM

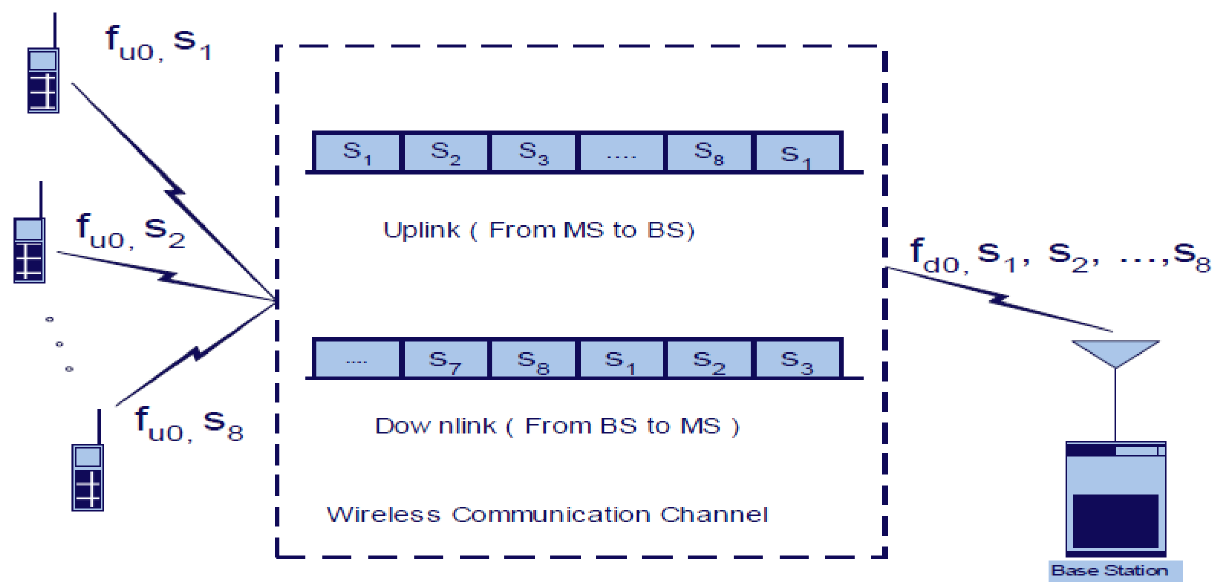


- **MS:** Mobile Station
- **BSS:** Base Station Subsystem
- **BTS:** Base Transceiver Station
- **BSC:** Base Station Controller
- **MSC:** Mobile Service Switching Center
- **OMC:** Operations and Maintenance Center
- **HLR:** Home Location Register
- **VLR:** Visitor Location Register

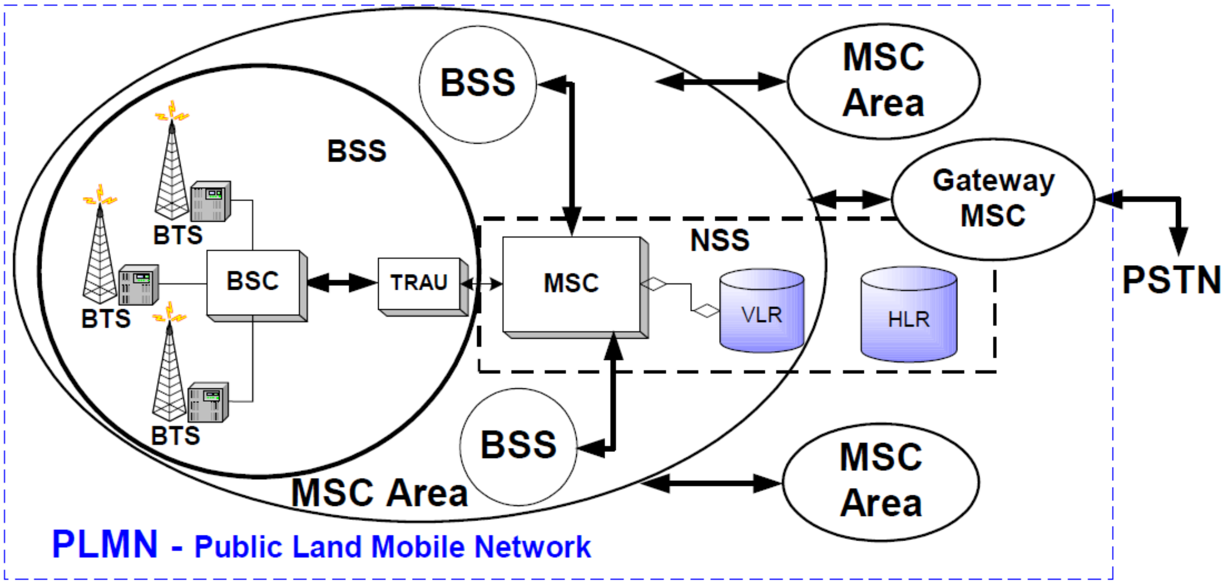
- GSM system layout is standardized
    - Standardization involves:
        - Elements of the network
        - Communication Interfaces
    - Standard layout allows for the use of equipment from different suppliers
    - Two functional parts
    - HW and SW specific for GSM radio interface
    - Subscriber Identity Module (SIM)
    - SIM – detaches user identity from the mobile
    - Stores user information
    - Without SIM – only emergency calls
- BSC plays a role of a small digital exchange.
- It can be connected to many BTSs and it offloads a great deal of processing from MSC
- One BSC connects to several tens to couple of hundred BTS
- Some of BSC responsibilities:
    - Handoff management
    - MAHO management
    - Power control
    - Clock distribution
    - Operation and maintenance
- TRAU is responsible for transcoding the user data from 16Kb/sec to standard ISDN rates of 64Kb/sec.
- It can physically reside on either BSC side or MSC side.
- If it resides on the MSC side, it provides substantial changes in the backhaul – 4 users over a single T-1/E-1 TDMA channel.
- TRAU, BSC and BTSs form Base Station Subsystem (BSS

- Responsible for connecting the mobile to the landline side
- GSM MSC is commonly designed as a regular ISDN switch with some added functionality for mobility support
- GSM Network can have more than one MSC
- One of the MSC has an added functionality for communication with public network – Gateway MSC (GMSC)
- All calls from the "outside networks" are routed through GMSC

TDMA Access Scheme



- Multiple users operate on the same frequency, but not at the same time.
- Advantages of TDMA:
  - Relatively low complexity
  - MAHO
  - Different user rates can be accommodated
  - Easier integration with the landline
- Disadvantages:
  - High sync overhead
  - Guard times
  - Heavily affected by the multipath propagation


BSS
MSC Area
BSS
BTS
BTS
BTS
BSC
TRAU
MSC
NSS
VLR
HLR
Gateway MSC
PSTN
BSS
MSC Area
MSC Area
MSC Area
PLMN - Public Land Mobile Network